

# International Workshop on Advanced Cyber-security and Low Power Design for IoT Systems

**Trusted Platform Module (*TPM*) and  
Trusted Execution Environment (*TEE*) based on  
RISC-V Computer System**

Trong-Thuc Hoang and Cong-Kha Pham

University of Electro-Communications (UEC), Tokyo, Japan

2023/11/10

# Outline

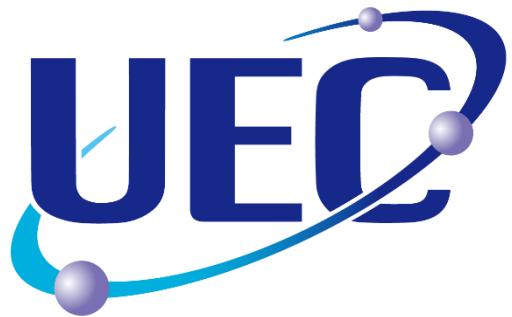
1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion



# Outline

1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion

# 1. Introduction (1/8) University



**The University of  
Electro-Communications**

国立大学法人 電気通信大学

# 1. Introduction (2/8) University



## History of UEC

---

- 1918** Established as “The Technical Institute for Wireless- Communications”
- 1949** Promoted to the National University status as “The **U**niversity of **E**lectro-**C**ommunications”
- 2004** Reformed as a National University Corporation
- 2013** Authorized as “The Enhancement of Research Universities”
- 2018** Observes its Centennial
-

# 1. Introduction (3/8) University

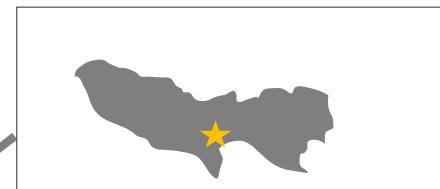


## Location of UEC Campus

JAPAN



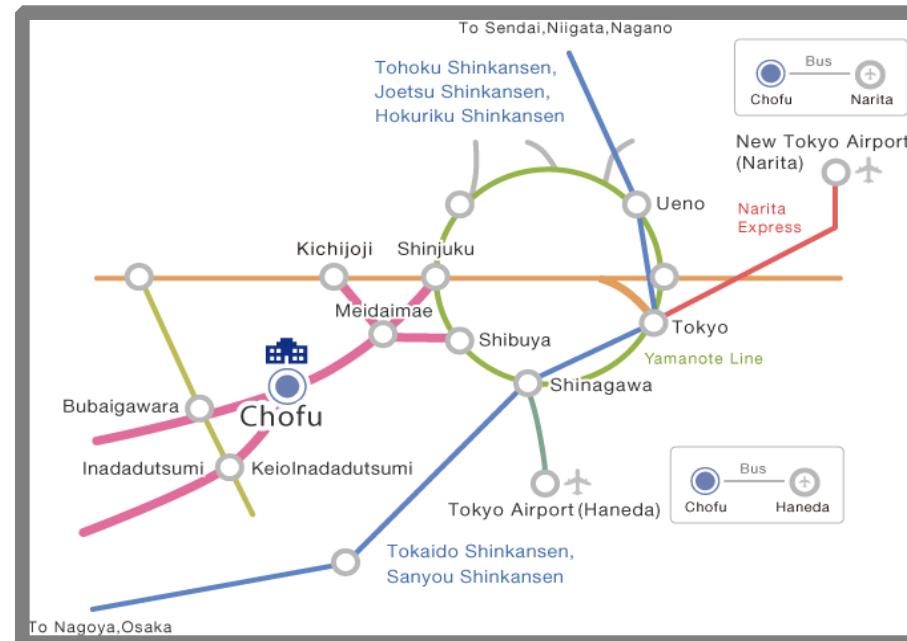
TOKYO



### A convenient location

- **15 minutes to Shinjuku**, a major business center
- **1 hour from Tokyo Airport** by Airport Shuttle bus.  
With beautiful suburban and historical surroundings

### Access



# 1. Introduction (4/8) University



## UEC Statistics

(as of May 1, 2023)

### 1. One Undergraduate and One Graduate Schools

- Undergraduate School of Informatics and Engineering
- Graduate School of Informatics and Engineering

### 2. Number of Students : **4,801 (305 international students )**

- Undergraduate: 3,371
- Graduate <Master>: 1,159
- <Doctor>: 271

### 3. Number of Faculty Members : **348**

- Professors: 135
- Associate Professors: 123
- Lecturers: 4
- Assistant Professors: 42
- Special Faculty Members: 44

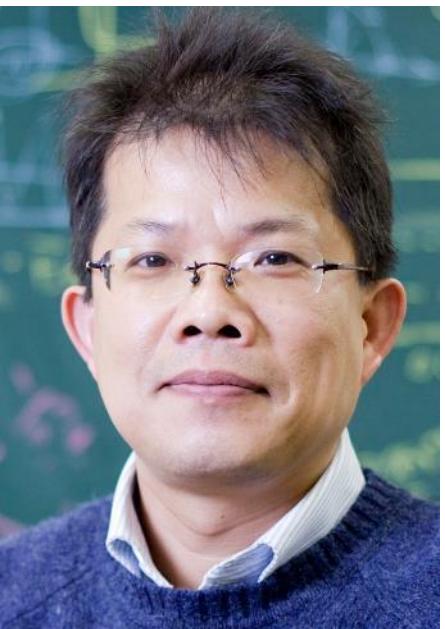
### 4. Number of Administration and Technical Staffs: **199**

# 1. Introduction (5/8) VLSI Lab



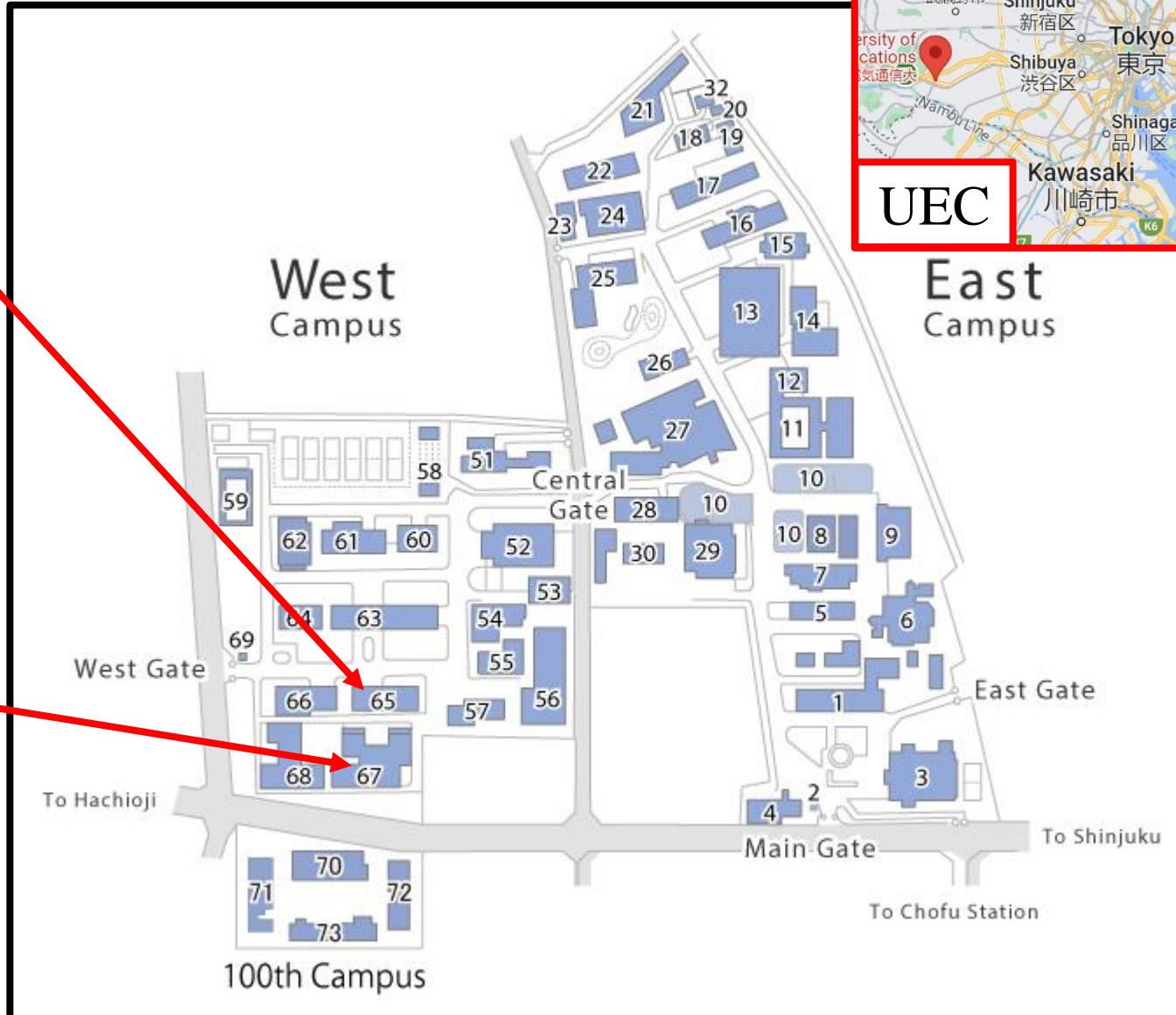
Trong-Thuc Hoang  
Assistant Professor  
[hoangtt@uec.ac.jp](mailto:hoangtt@uec.ac.jp)

W1-507

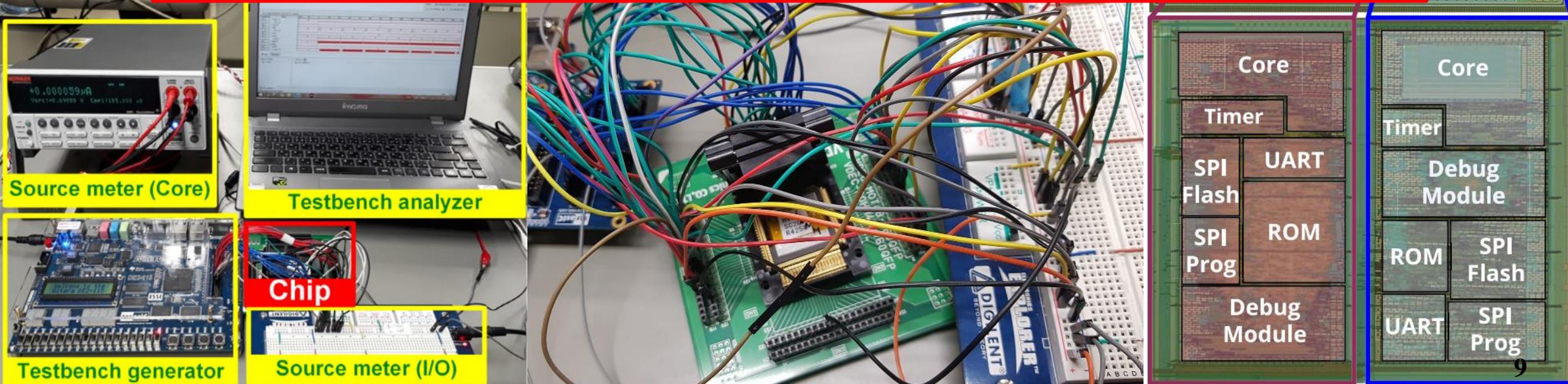
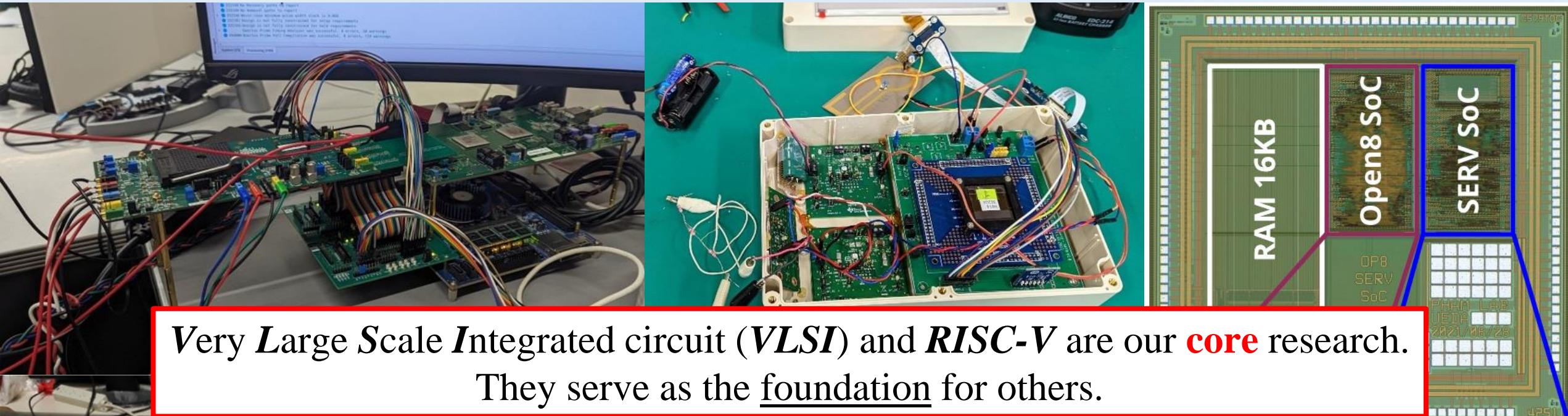


Cong-Kha Pham  
Professor  
[phamck@uec.ac.jp](mailto:phamck@uec.ac.jp)

W8-214



# 1. Introduction (6/8) VLSI Lab



# 1. Introduction (7/8) VLSI Lab



## Member (as in Oct. 2023)

- Ph.D. students: 6
- Master students: 4
- Bachelor students: 2
- Researcher: 1

---

Total: 13

## From

- Vietnam: 7
- Japan: 5
- China: 1

# 1. Introduction (8/8) VLSI Lab

Core research

Very-Large Scale Integrated circuit

RISC-V

## Cybersecurity

### Cryptosystem

- Trusted **P**latform **M**odule
- Trusted **E**xecution **E**nvironment

### Side-Channel Attack

- Power Analysis Attack
- Spectre attack

### New Family

- Post-Quantum Cryptography
- Light-Weight Cryptography

## Cryptography

### Security IP

- True **R**andom Number Generator
- Physical **U**nclonable Function
- **O**ne-Time Programmable

### New Standard

- **C**ipher: ChaCha20, Poly1305, AEAD, HMAC
- **H**ash: SHA3, SHAKE
- **P**air-key: ECDSA, EdDSA

## Internet of Things

Ultra-Low Power Micro-controller

## Others

### Big Data

- Frequent **I**tem Counter
- **T**ext Search **P**rocessor

### Digital Signal Processing

- COordinate Rotation DIgital Computer
- Discrete Cosine Transform
- Fast Fourier Transform

# Outline

1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion

## 2. TPM & TEE (1/8) Cybersecurity overview

Power and EM Analysis Attacks

Branch Prediction

Timing Channels

Intra-core Side-channel

Detection Techniques

### Side-channel Prevention

Lightweight Crypto

Symmetric/Asymmetric

SIKE

Elliptic Curves

TRNG

DICE

### Cryptographic Primitives

Reduce Attack Surface

SMPC

CFI

Cryptography

Side-channel Resist

### ISA Security Extensions

Tagged Memory

Memory Isolation

Memory Encryption and Authentication

### Memory Protection

Covert Channels

Physical Access

Logic-locking

EM Fault Injection

RTL Bugs

Hardware Trojans

### Hardware and Physical Security

Program Obfuscator and Churn Units

Memory Protection

Crypto Engines

### Hardware-assisted Security Units

Cybersecurity  
is a huge field  
of research.

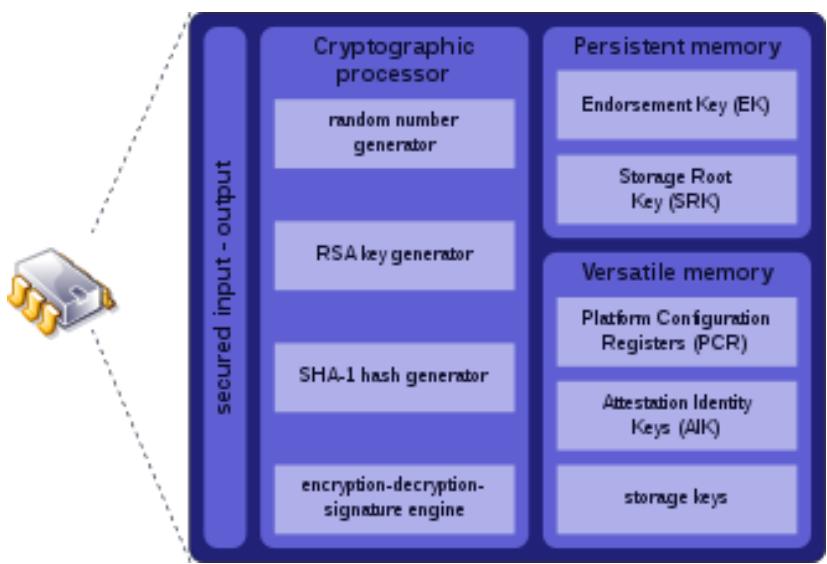
Today we  
focus on

*cryptosystem.*

## 2. TPM & TEE (2/8) TPM & TEE

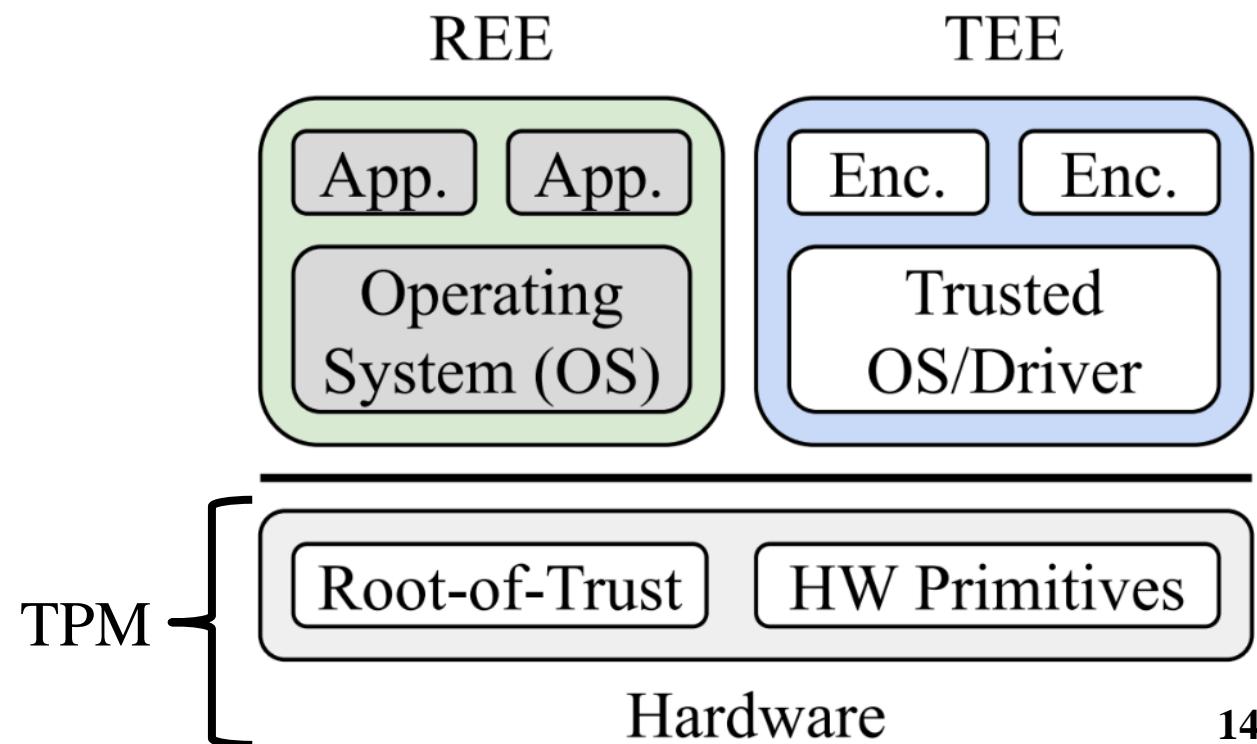
**TPM = Trusted Platform Module**

- TPM is for the authentication problem in a computer system.
- The main feature is remote attestation: a verifier can trust that the platform is “*clean*” (i.e., its vital data is safe and its critical software are not tampered).
- Based on TPM, other applications of *confidentiality, integrity, availability*, etc., can be developed.



**TEE = Trusted Execution Environment**

- TEE is the next step after TPM.
- TPM is for a trusted *hardware*; TEE is for a trusted *Operating System (OS)*
- TEE needs TPM for the *Root-of-Trust (RoT)*. Based on the RoT, the *Chain-of-Trust (CoT)* is developed, thus creating TEE.



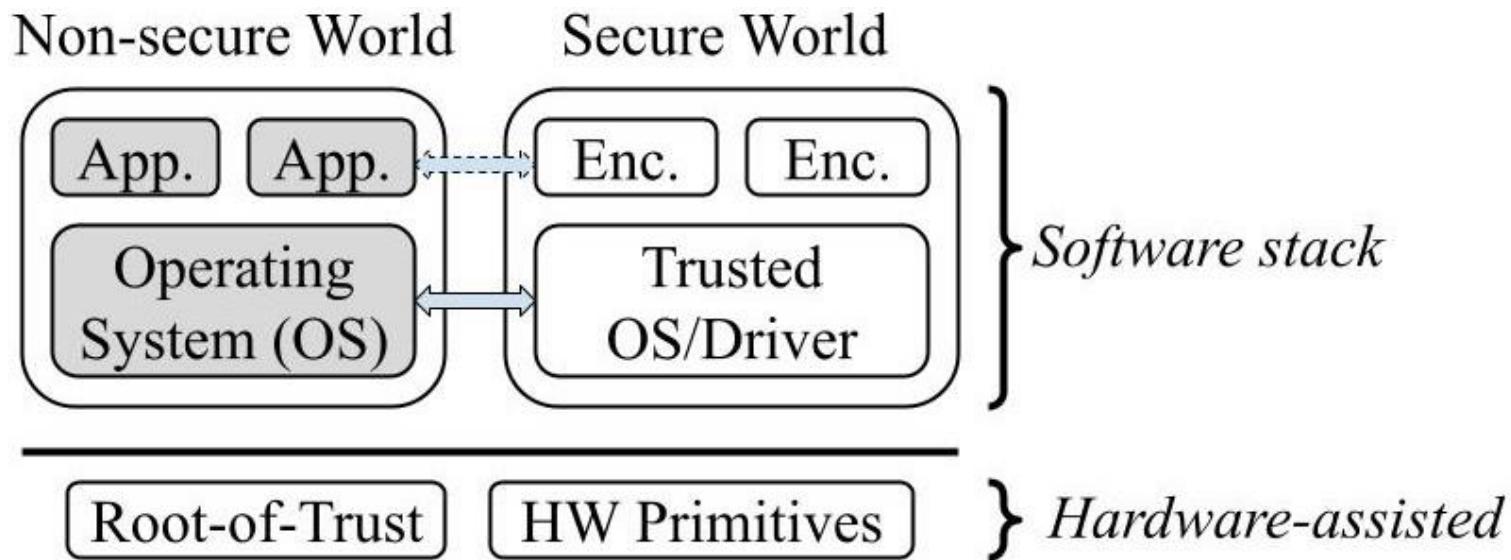
## 2. TPM & TEE (3/8) How TEE works?

### Trusted Execution Environment (TEE) provides:

1. *Integrity*: the code and data cannot be tampered.
2. *Confidentiality*: the application's content cannot be read.
3. *Attestation*: proof to a remote party that the system is safe.

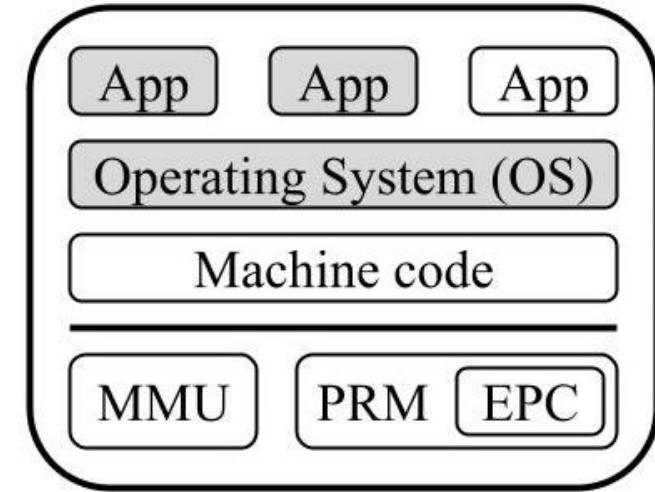
### A typical TEE setup:

- Secure (trusted) vs. non-secure (untrusted) worlds.
- Barrier enforcer by: software *AND* hardware.
- All TEEs need some sort of hardware-assisted modules: Root-of-Trust (RoT) and primitives.
- HW primitives (*examples*): cache flushing, cache partitioning, memory isolation, memory encryption, keys management, bus access controller, enclave encryption, and so on.



## 2. TPM & TEE (4/8) Several TEE examples

### Intel Core(s)



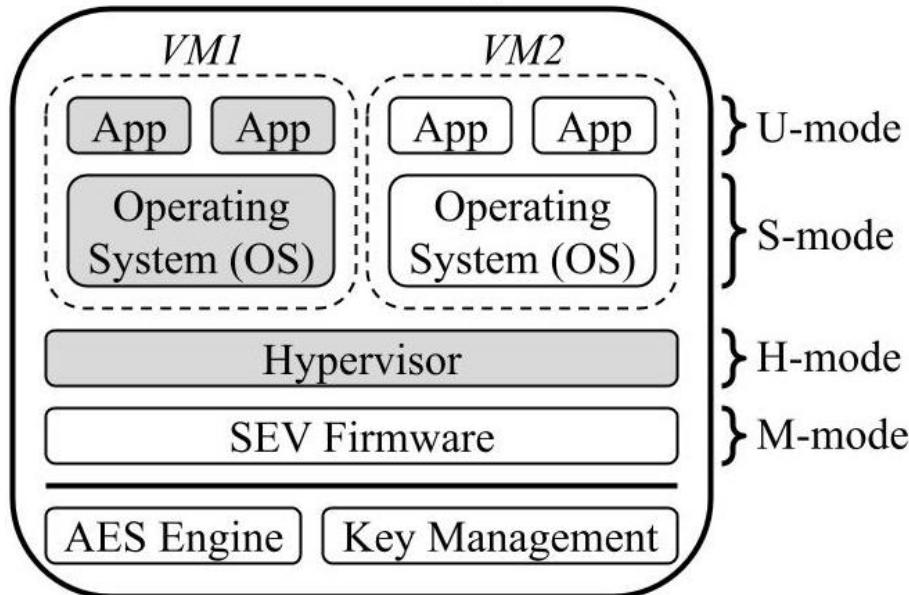
*Intel SGX*

**Intel SGX:** aiming for conventional PCs

- Most closed-source TEEs are fine-tuned for their specific processors.

- Many TEE models were proposed: different set goals, different resources, and different developing mindsets.

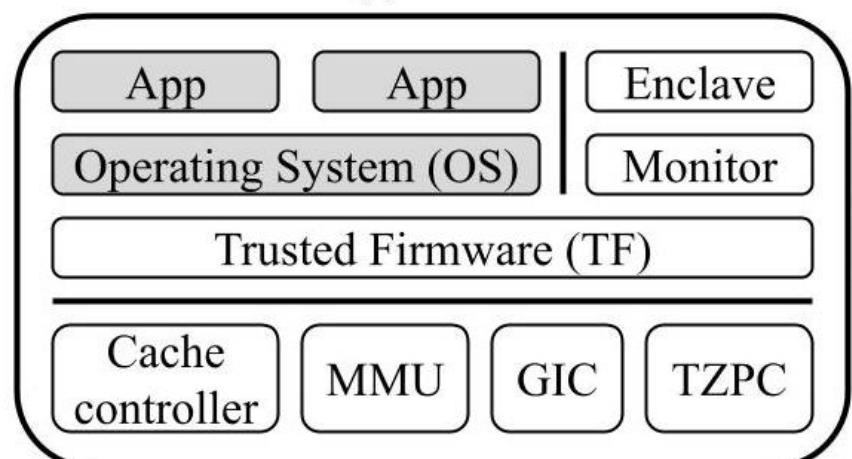
### AMD Secure Processor(s)



*AMD SEV*

**AMD SEV:** aiming for server's cloud computing

### ARM Processor(s)

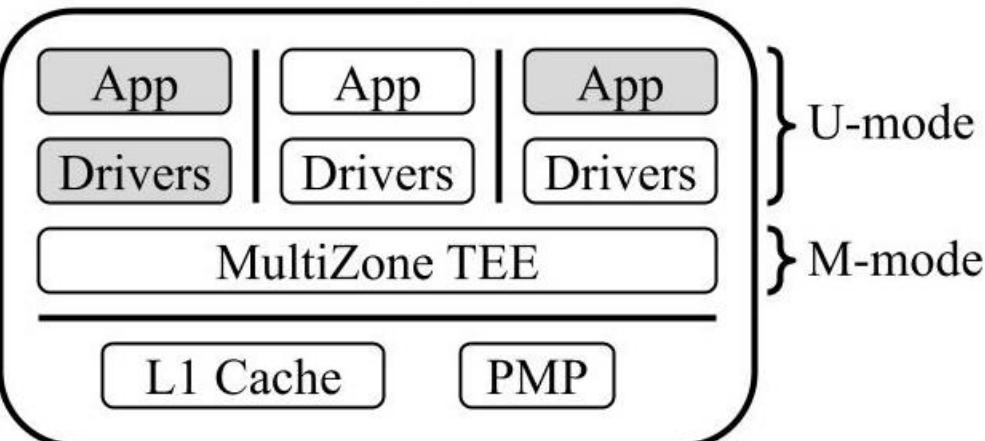


*ARM TrustZone*

**ARM TrustZone:** aiming for smartphones/embedded-systems

## 2. TPM & TEE (5/8) Several TEE examples

### RISC-V Processor(s)

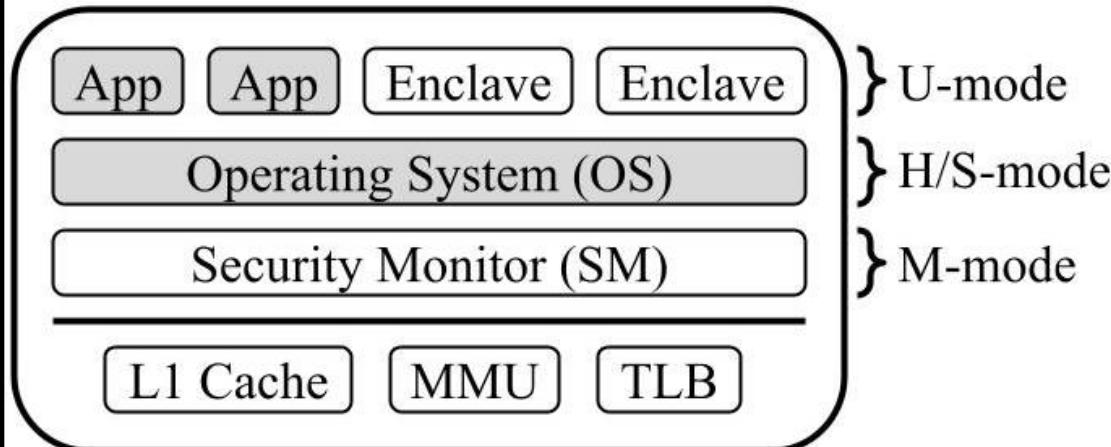


*Hex-Five MultiZone*

**MultiZone:**  
lightweight TEE,  
multi-purposes,  
aiming for  
embedded/IoT  
applications

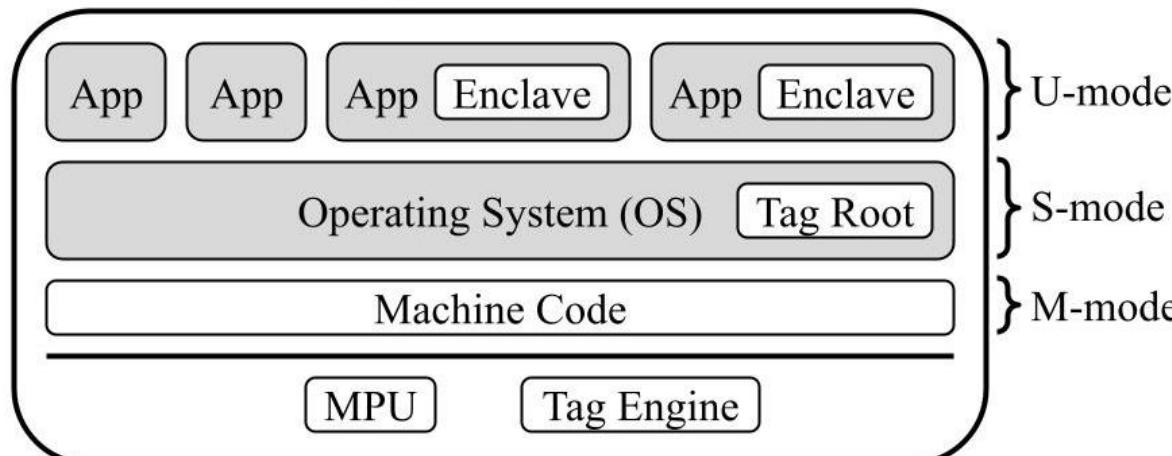
**Sanctum:**  
similar  
approach  
with Intel  
SGX, but for  
RISC-V  
processors

### RISC-V Processor(s)



*Sanctum*

### RISC-V Processor(s)

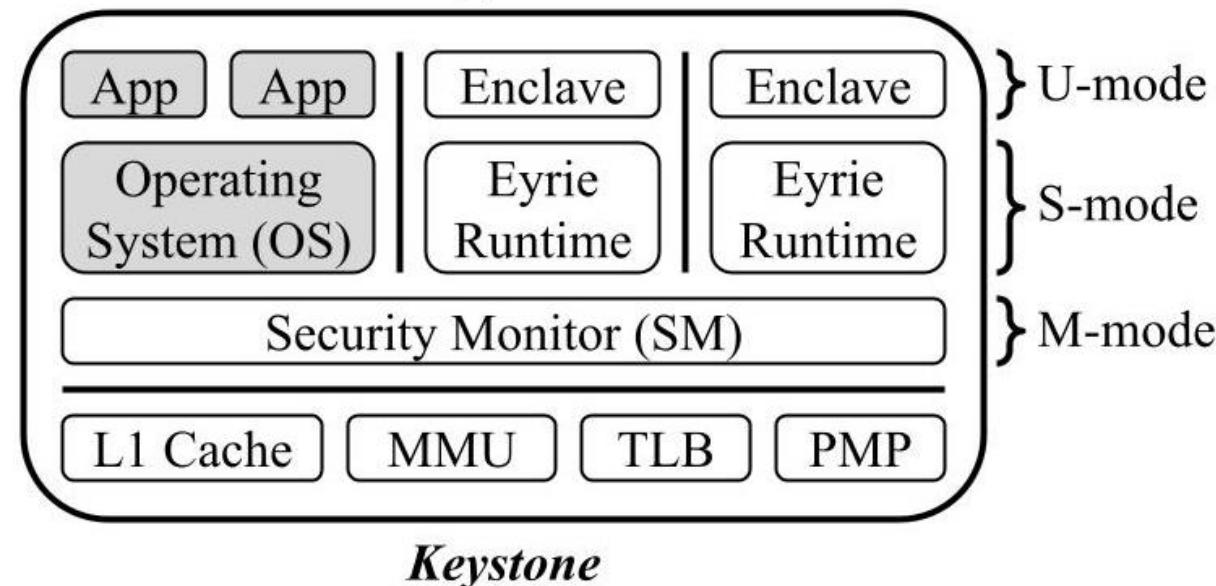


*TIMBER-V*

**TIMBER-V:** similar  
approach with Intel  
SGX, but uses strong  
hardware enforcers  
based on “Tag”-ID  
across the entire system

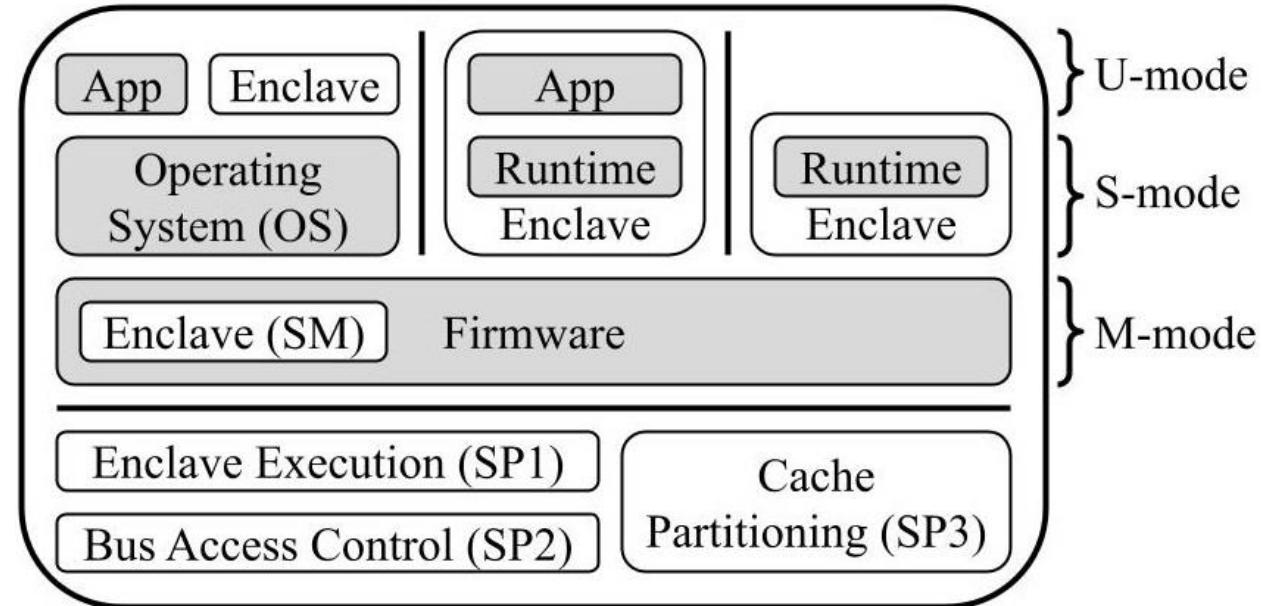
## 2. TPM & TEE (6/8) Several TEE examples

RISC-V Processor(s)



**Keystone:** is not a specific type of TEE, but a modular TEE framework (*try its best to be hardware-agnostic*)

RISC-V Processor(s)



**CURE**

**CURE:** a complete opposite with Keystone, this TEE model requires a total hardware modification across every architectural level (*but provides strong isolation with multiple types of enclaves*)

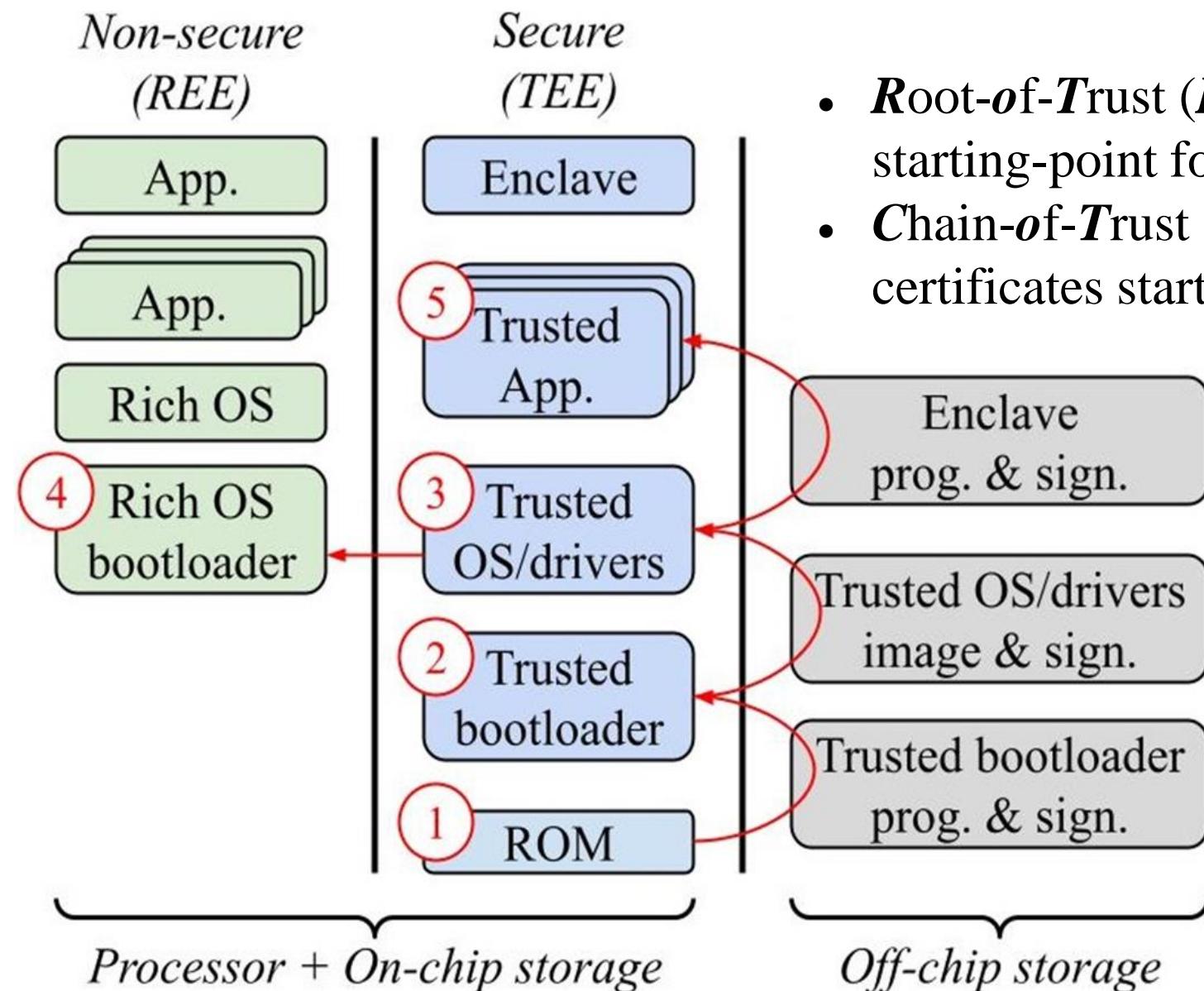
## 2. TPM & TEE (7/8) TEE comparison

TABLE 2.1: TEE implementations comparison regarding the security-related features; ●, ○, and ○ rank the performance from best/supported to worst/not-supported, respectively.

		<b>Intel</b>	<b>ARM</b>	<b>AMD</b>	<b>RISC-V</b>	<b>CURE [8]</b>
Open-source		○ ○ ● ○	○ ● ● ○	○ ○ ○ ○	○ ● ● ○	○ ○ ○ ○
Enclave type	User-space	● ● ● ●	○ ○ ○ ○	○ ○ ○ ○	○ ● ● ○	● ○ ○ ●
	Kernel-space	○ ○ ○ ○	● ● ● ●	● ● ● ●	● ○ ○ ○	● ○ ○ ○
Adversary	Software	● ● ● ●	● ● ● ●	○ ○ ○ ○	● ● ● ○	● ● ● ○
	Physical	● ● ● ●	○ ○ ○ ○	○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○
SCA resilience	Cache-based	○ ○ ○ ○	○ ○ ○ ○	○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○
	Ctrl-channel	○ ○ ○ ○	○ ○ ○ ○	○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○
	DMA-based	○ ○ ○ ○	● ● ● ●	○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○
Secure enclave-to-peripheral		○ ○ ○ ○	○ ○ ○ ○	○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○
Small trusted firmware		● ○ ○ ○	○ ○ ○ ○	● ○ ○ ○	○ ○ ○ ○	○ ○ ○ ○
Hardware modification		○ ○ ○ ○	● ○ ○ ○	○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○
Resource management		○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○	○ ○ ○ ○	● ○ ○ ○
Wide-range applications		○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○	○ ○ ○ ○	● ○ ○ ○
High expressiveness		○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○	○ ○ ○ ○	○ ○ ○ ○
Low porting efforts		○ ○ ○ ○	● ○ ○ ○	● ○ ○ ○	○ ○ ○ ○	● ○ ○ ○

- Various implementations for various purposes and applications:
  - **RISC-V:** with the advantage of open-source → fast to adapt and can be fine-tuned to any requirements.
  - **ARM:** aiming for SCA resilience, mostly for portable hand-held devices.
  - **Intel & AMD:** typical solution for generic PC and data center; aiming for heavy workload in those systems.

## 2. TPM & TEE (8/8) Secure boot in TEE



### Secure boot in TEE:

- **Root-of-Trust (*RoT*):** the first verification at reset, the starting-point for *CoT*. This should be provided by **TPM**.
- **Chain-of-Trust (*CoT*):** a series of signatures & certificates started from the **RoT** up to the Rich OS.

### Secure boot should guarantee:

- All sensitive assets (*code, trusted OS/drivers, hardware primitives*) are installed and at the initial states (*as expected by designers*).
- **EVERYTHING** is signature checked, and **EVERY** sensitive data are immutable or held in isolation.

# Outline

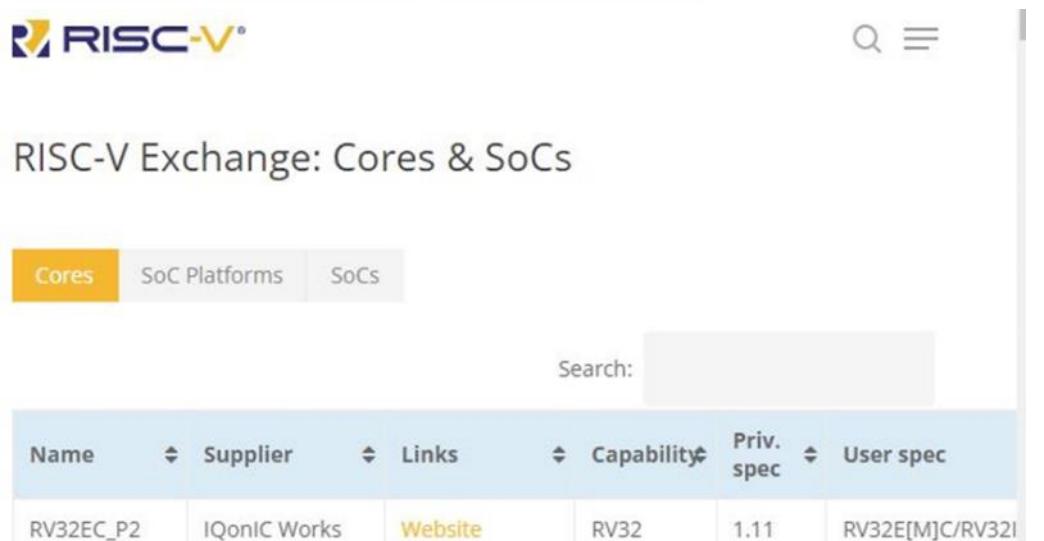
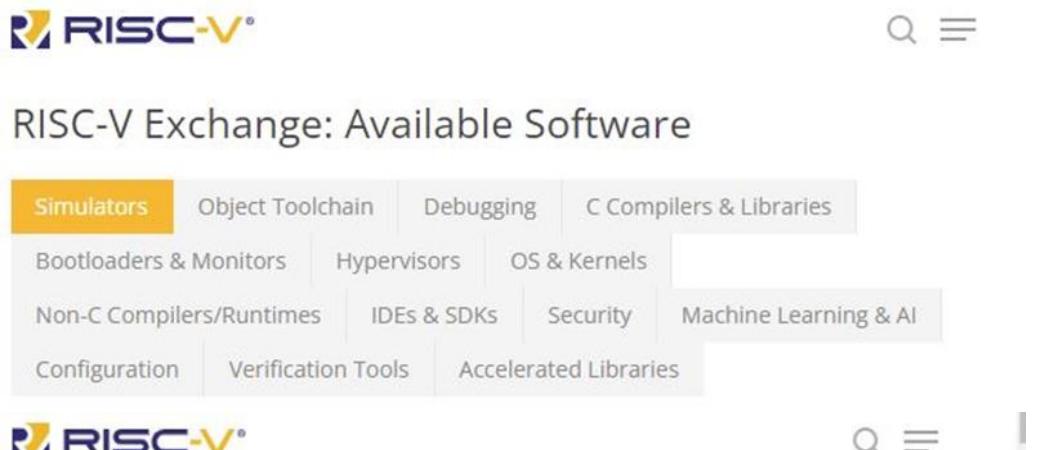
1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion

### 3. Why RISC-V? (1/12) RISC-V ISA

Open-source **RISC-V** means open-source **ISA**, no more, no less.

(*some other common ISAs: i386, amd64, ARM 32/64, AVR, MIPS, NiosII, etc.*)

**RISC-V Foundation:** <https://riscv.org/>



- Official released ISA specification
- Many cores, SoCs, & software are available for free
- Developers can reuse each other designs & tools  
→ significantly reducing R&D time and effort

- License free:**
- RISC-V ISA
  - RISC-V toolchain

**License depends on authors/developers:**

- RISC-V processors
- RISC-V software applications
- RISC-V-related products

### 3. Why RISC-V? (2/12) What is ISA?

ISA means Instruction Set Architecture.  
It is the layer between software and hardware developers.

**Software tools:** assembler, compilers, debugger, linker, etc.

---

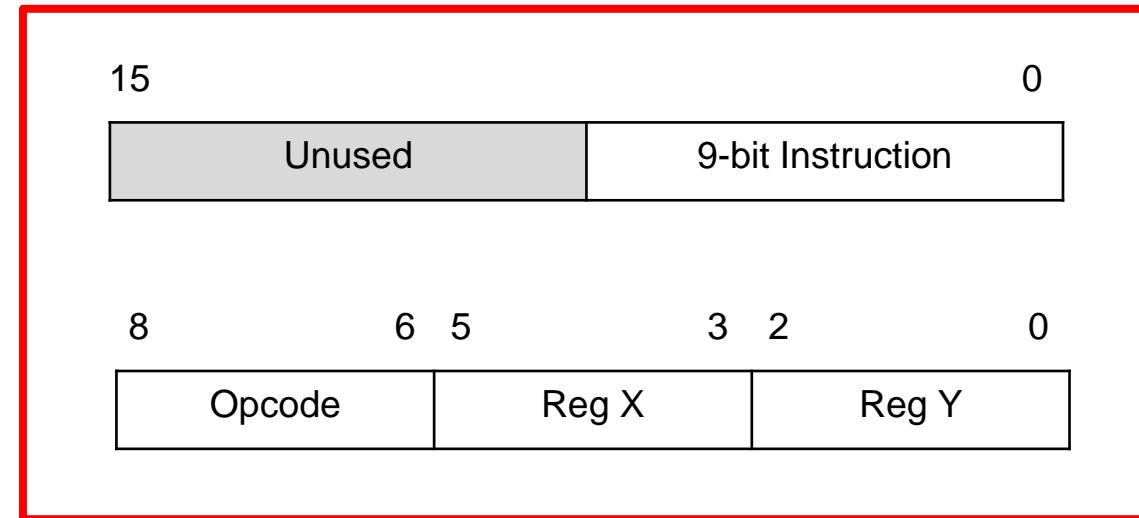
**ISA:** the interface between software & hardware architects

---

**Processor:** ALU, FPU, registers, CSRs, branch predictor, caches, etc.

**ISA has to define all these kinds of stuff:**

- 1) How many instructions, and which is which?
- 2) In an instruction, what field means what?
- 3) Addressing & data-path (8/16/32/64/128-bit)?
- 4) What is supported and what is not?
- 5) etc.



### 3. Why RISC-V? (3/12) CISC vs. RISC

CISC

## (Complex Instruction Set Computer)

- 1) Emphasis on *hardware*
  - 2) *Multi-clock* complex instructions
  - 3) *Memory-to-memory* mindset
  - 4) *Small* code size, *many* cycles per instruction
  - 5) *Low Fmax* due to complex design
  - 6) Most transistors are used for storing *instructions*
  - 7) *Less memory* for storing data & program

RISC

## (Reduced Instruction Set Computer)

- 1) Emphasis on *software*
  - 2) *Single-clock* simple instructions
  - 3) *Register-to-register* mindset
  - 4) *Large* code size, *few* cycles per instruction
  - 5) *High Fmax* due to simple design
  - 6) Most transistors are used for storing *data*
  - 7) *More memory* for storing data & program

$$\text{Performance} = \frac{\text{time}}{\text{program}} = \frac{\text{time}}{\text{cycle}} \times \frac{\text{cycle}}{\text{instruction}} \times \frac{\text{instruction}}{\text{program}}$$

RISC win      CISC win

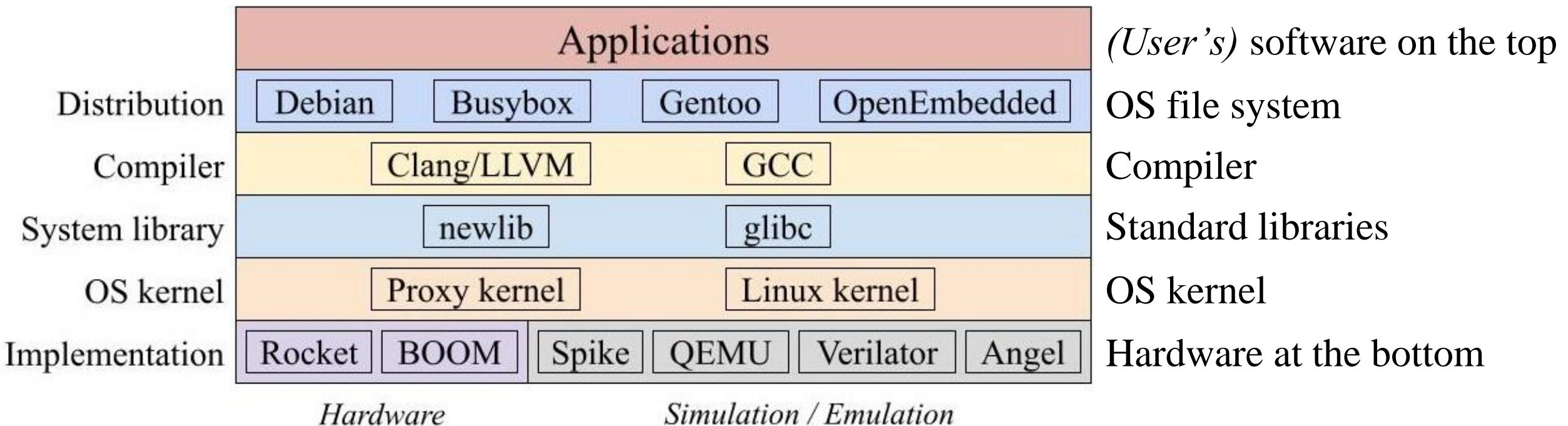
**RISC-V** simply means *RISC* architecture version *five*

Nowadays, almost all processors in the market are RISCs.

**Economic reason:** memory  
price is way down ↓ ↓ ↓

### 3. Why RISC-V? (4/12) RISC-V toolchain

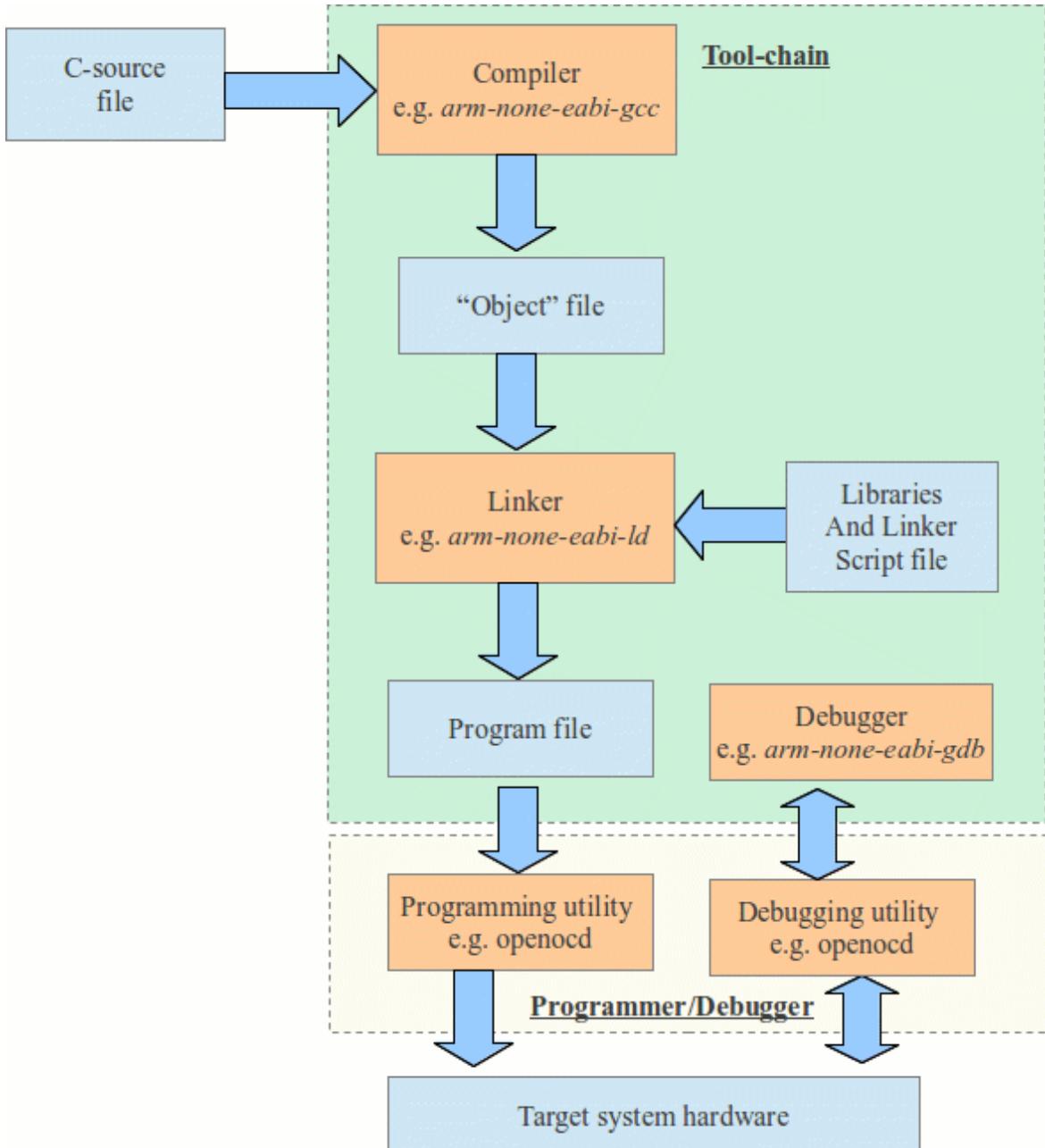
#### RISC-V toolchain and its ecosystem



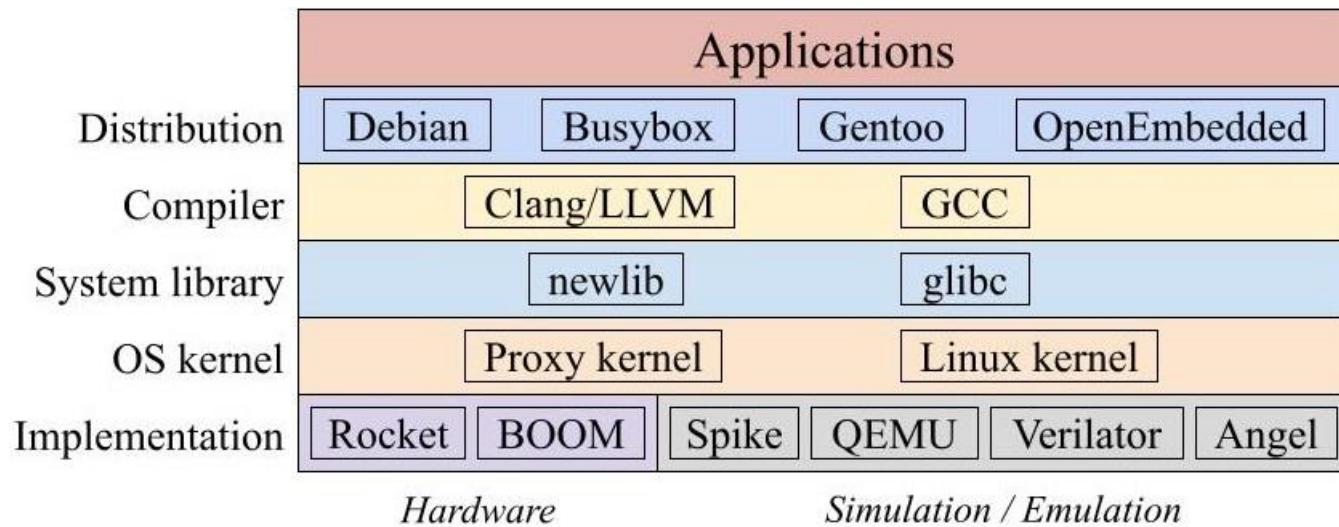
#### Top-down explanation:

User's applications on the top are operated in an OS file system, which then compiled by a compiler based on multiple standard libraries. After compiled, the execution file is run on the OS kernel that manages the hardware at the bottom.

### 3. Why RISC-V? (5/12) RISC-V toolchain



### RISC-V toolchain and its ecosystem



### Three most important tools

- **GCC:** (*cross C compiler*) makes a C code into assembly code
- **LD:** (*linker*) links standard libraries into the build; also links between multiple C files
- **GDB:** (*debugger*) debug the hardware/simulator/emulator

### 3. Why RISC-V? (6/12) RISC-V extension

What makes **RISC-V** different: its modular mindset

*(modular architecture helps fine-tune the performance based on the developer's needs)*

Base instruction set: **Integer**

Extended instruction set: *the rest*

Extension	Description
I	Integer
M	Integer Multiplication and Division
A	Atomics
F	Single-Precision Floating Point
D	Double-Precision Floating Point
G	General Purpose = IMAFD
C	16-bit Compressed Instructions
Non-Standard User-Level Extensions	
Xext	Non-standard extension "ext"

The most common extensions: **IMAFDC**  
*(also known as GC)*

There are also a lot more than just **IMAFDC**:

Base	Version	Status
RVWMO	2.0	Ratified
RV32I	2.1	Ratified
RV64I	2.1	Ratified
RV32E	1.9	Draft
RV128I	1.7	Draft
Extension	Version	Status
M	2.0	Ratified
A	2.1	Ratified
F	2.2	Ratified
D	2.2	Ratified
Q	2.2	Ratified
C	2.0	Ratified
Counters	2.0	Draft
L	0.0	Draft
B	0.0	Draft
J	0.0	Draft
T	0.0	Draft
P	0.2	Draft
V	0.7	Draft
Zicsr	2.0	Ratified
Zifencei	2.0	Ratified
Zam	0.1	Draft
Ztso	0.1	Frozen

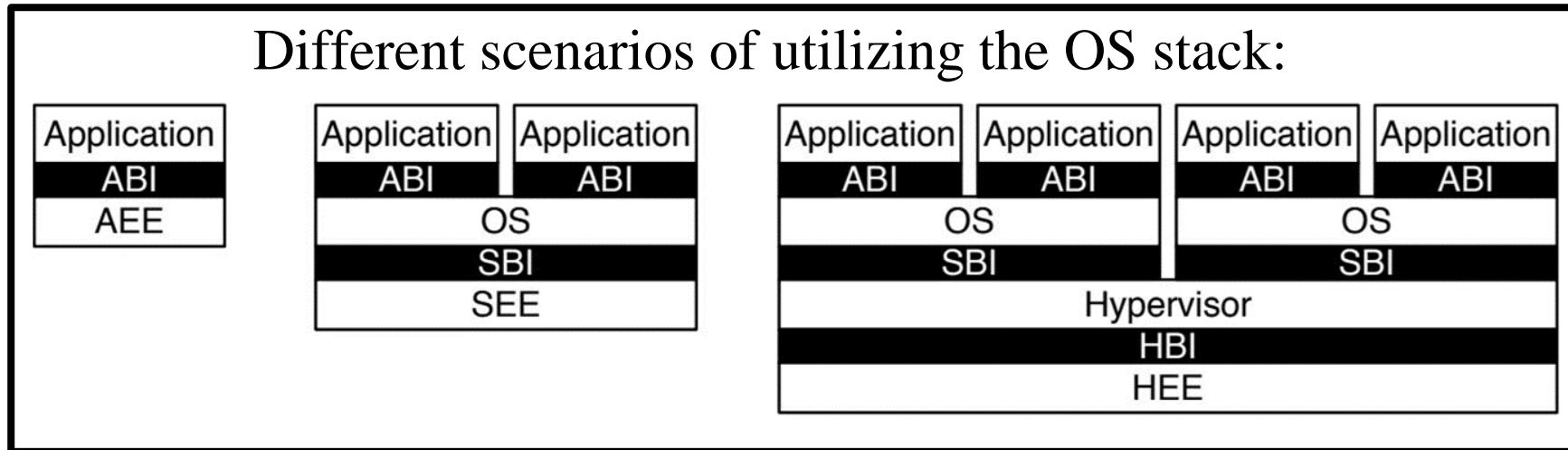
### 3. Why RISC-V? (7/12) OS stack

To support an Operating System (OS), the ISA has to support the OS stack or the *M-/S-/U-mode*.

RISC-V privileged architecture:

RISC-V Modes		
Level	Name	Abbr.
0	User/Application	U
1	Supervisor	S
	Reserved	
3	Machine	M

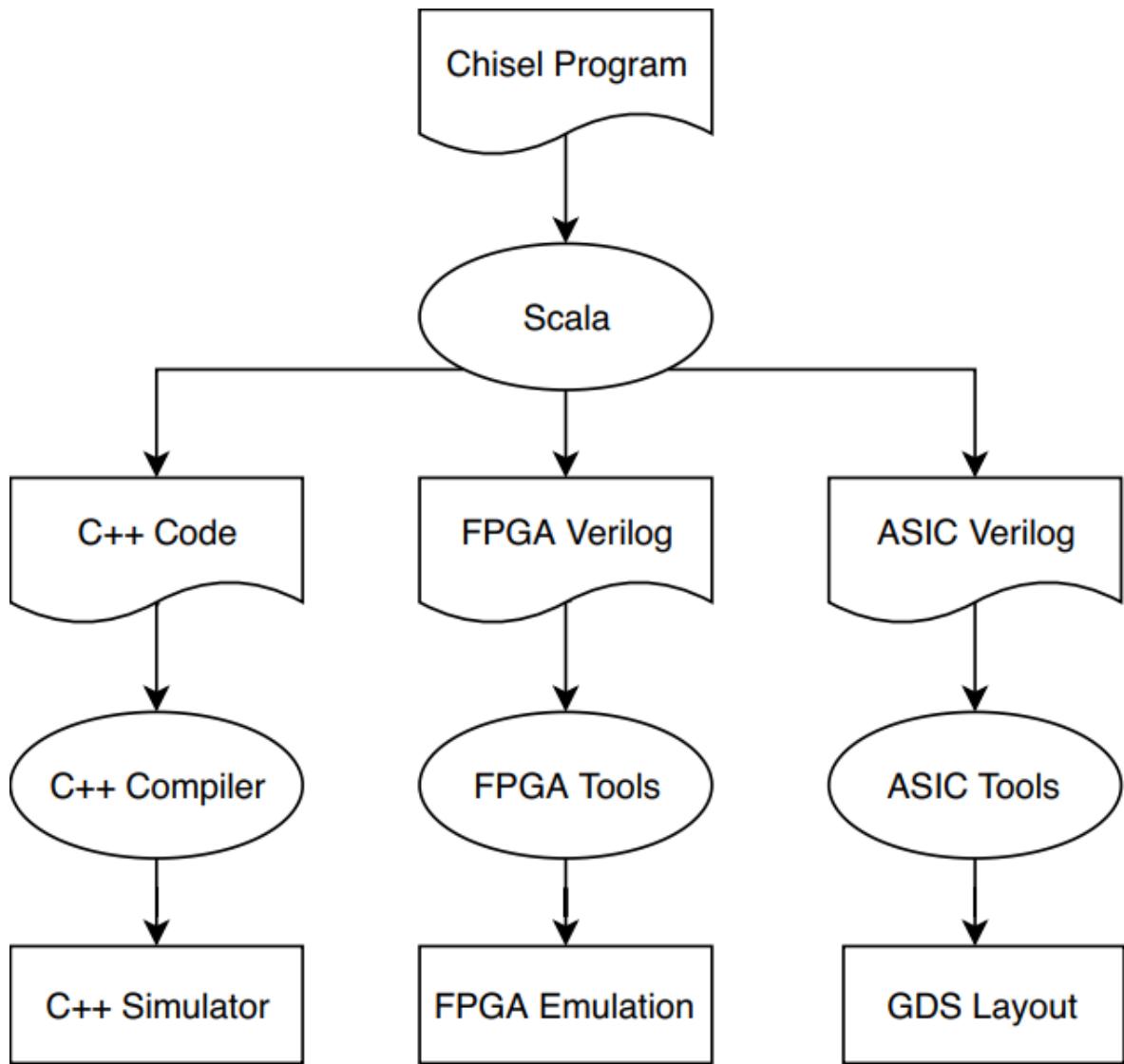
Supported Combinations of Modes	
Supported Levels	Modes
1	M
2	M, U
3	M, S, U



**RISC-V ISA** not only supports the OS stack, but also provides a **privileged architecture**.

→ Better security scheme by having the hardware recognize each code's mode level. (read more at: [Link](#))

### 3. Why RISC-V? (8/12) CHISEL



Chisel is a library.  
Scala is a language.

- **Scala** itself is a *high-level object-oriented programming language*  
→ It is not designed for “hardware coding.”
- **Chisel** is a library attached to Scala to define a set of coding rules.  
→ It is designed for “hardware coding.”
- From **Scala** to **Verilog**:  
    Scala → Java → FIRRTL → Verilog  
1<sup>st</sup> arrow: Scala compiler named SBT  
2<sup>nd</sup> arrow: executing Java  
3<sup>rd</sup> arrow: FIRRTL compiler

### 3. Why RISC-V? (9/12) Summary

RISC-V revolutionizes *computer system* design

#### 1. Modular at heart:

customizable ISA and customizable hardware  
→ fine-tune the system to your specific needs.

#### 2. Open-source community:

license-free ISA, open cores and SoCs, open-source libraries, open-source software, etc. → reuse other developers' designs → save time and effort for R&D

#### 3. CHISEL (*Constructing Hardware In Scala Embedded Language*):

a new way to “coding” hardware circuits. When compiled, it will generate a true RTL Verilog code.

→ a “meta-programming” language for hardware developers with parameters and sub-designs that can be overridden or extended.  
→ easy to develop “object-oriented” hardware library for reuse purpose.

### 3. Why RISC-V? (10/12) Common libraries

The common open RISC-V libraries that you can use

**Chipyard** (*contains many common and frequently used open IPs, including RISC-V processors and other peripherals such as uart, spi, sd-card, etc.):*

<https://github.com/ucb-bar/chipyard>

README.md

**CHIPIYARD**

Chipyard Framework chipyard-ci-process passing

Quick Links

- Stable Documentation: <https://chipyard.readthedocs.io/>
- User Question Forum: <https://groups.google.com/forum/#!forum/chipyard>
- Bugs and Feature Requests: <https://github.com/ucb-bar/chipyard/issues>

Using Chipyard

To get started using Chipyard, see the stable documentation on the Chipyard documentation site: <https://chipyard.readthedocs.io/>

What is Chipyard

sifive / fpga-shells Public

Code Issues 6 Pull requests 16 Actions Projects Security

master 106 branches 0 tags Go to file Add file Code

erikdanie Merge pull request #158 from a... f9fb9fd on Dec 29, 2020 473 commits

File	Description	Time
.github/workflows	CI: add a scala compilation check	2 years ago
microsemi	newshells checkpoint	3 years ago
src/main/scala	Add utility function for IBUF_LOW_POWER	2 years ago
vsrc/nfmac10g	nfmac10g: fix a power-0 bug	4 years ago
xilinx	refactor tcl code that wasn't executing correctly	2 years ago
.gitignore	Initial commit for fpga-shells	5 years ago
README.md	improved clarity of documentation	3 years ago
build.wake	wake: use variable for package location	2 years ago
wit-manifest.json	bump sifive-blocks (#157)	2 years ago

README.md

fpga-shells

An FPGA shell is a Chisel module designed to wrap any SiFive core configuration. The goal of the fpga-shell system is to reduce the number of wrappers to have only one for each physical device rather than one for every combination of physical device and core configuration.

**fpga-shells** (*contains many common FPGA configurations*):  
<https://github.com/sifive/fpga-shells>

# 3. Why RISC-V? (11/12) Common processors

## Some famous RISC-V processors

**Rocket** is the most popular among RISC-V processors:

<https://github.com/chipsalliance/rocket-chip>

(it is an in-of-order processor)

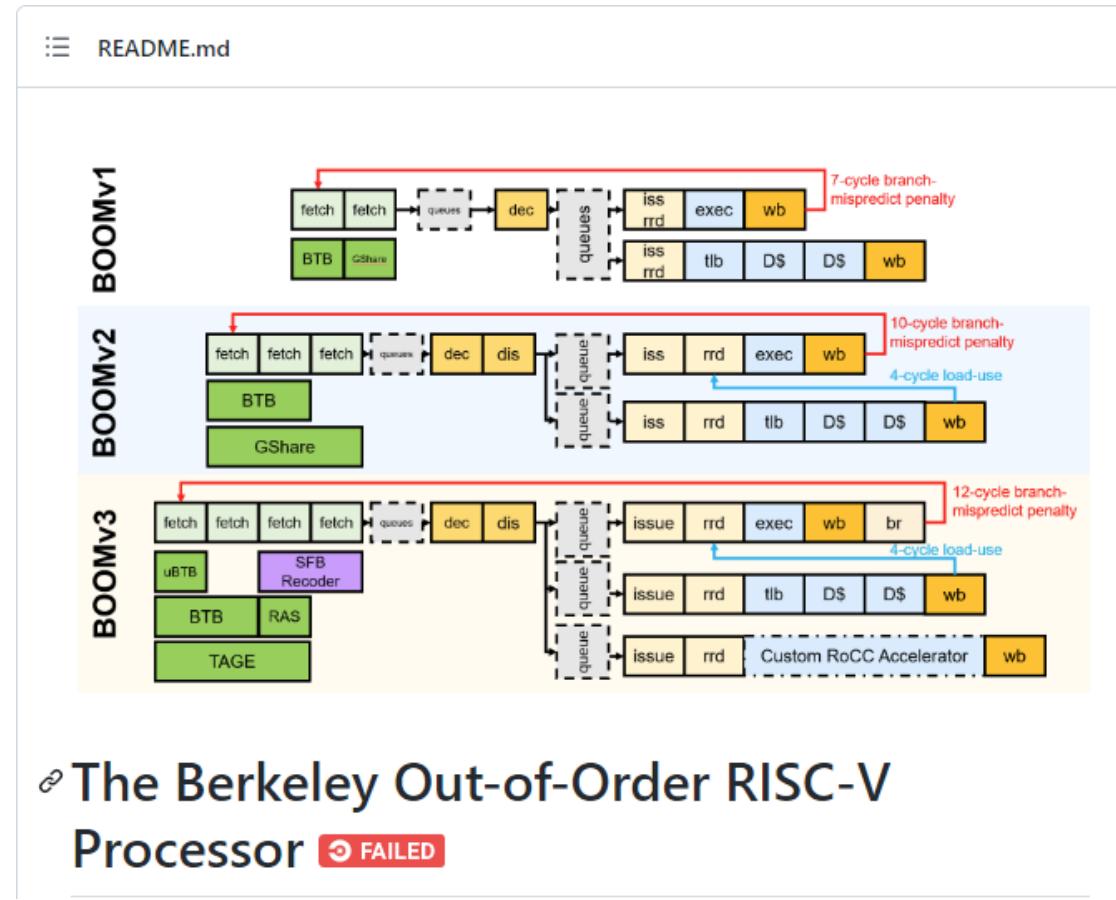
The screenshot shows the README.md page of the Rocket Chip Generator repository. It features a header with a logo and a 'Continuous Integration' status badge. Below the header, there's a brief description of the repository's purpose and a 'Table of Contents' section with several links to various documentation and resources.

**Table of Contents**

- Quick instructions for those who want to dive directly into the details without knowing exactly what's in the repository.
- What's in the Rocket chip generator repository?
- How should I use the Rocket chip generator?
  - Using the cycle-accurate Verilator simulation
  - Mapping a Rocket core down to an FPGA
  - Pushing a Rocket core through the VLSI tools
- How can I parameterize my Rocket chip?
- Debugging with GDB
- Building Rocket Chip with an IDE
- Contributors

**BOOM** is an out-of-order processor that can rival ARM:

<https://github.com/riscv-boom/riscv-boom>



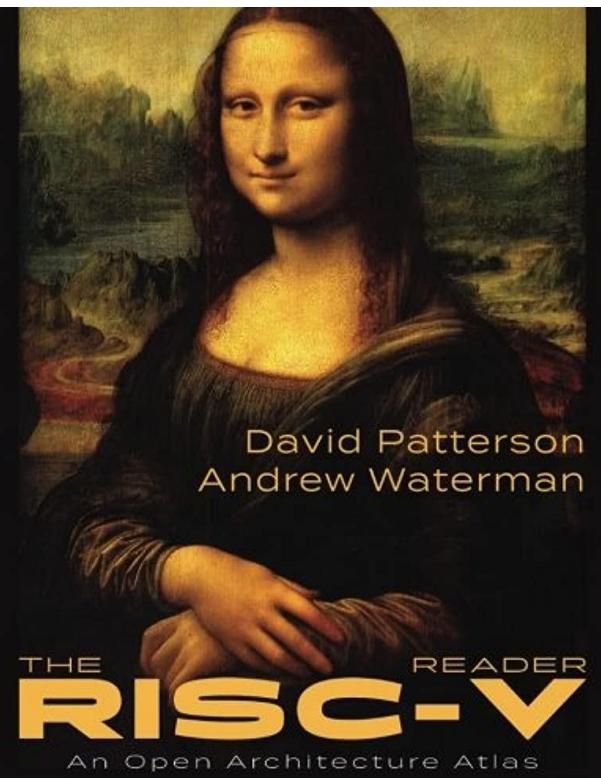
### 3. Why RISC-V? (12/12) Common books

Two “must-have” books for RISC-V developers, from beginners to experts

RISC-V books that often used in universities for teaching

Digital Design  
with Chisel

Martin Schoeberl



Digital Design and  
Computer Architecture  
RISC-V Edition



Sarah L. Harris  
David Harris

COMPUTER  
ORGANIZATION  
AND DESIGN  
THE HARDWARE/SOFTWARE INTERFACE  
RISC-V EDITION

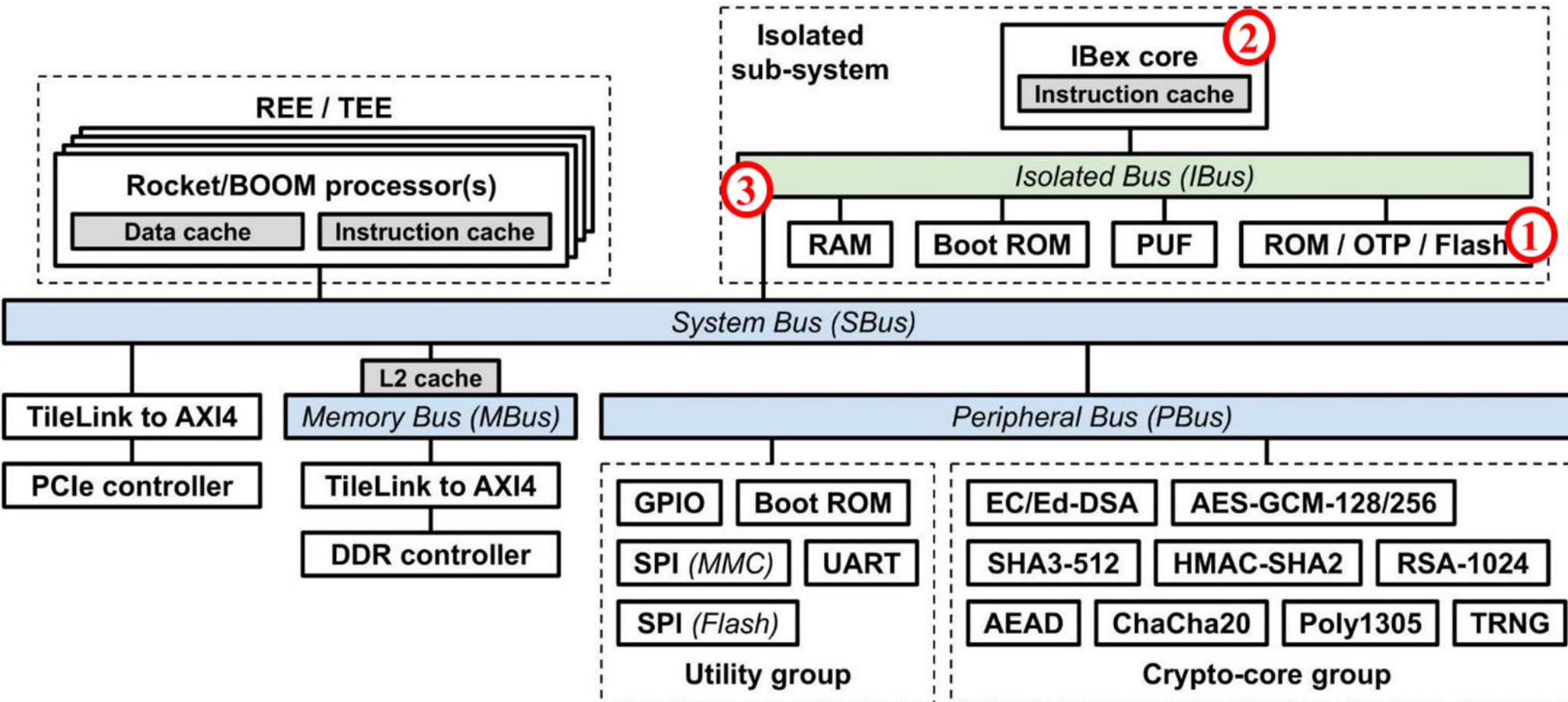


# Outline

1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion

# 4. Proposed System (1/8) Hardware modification

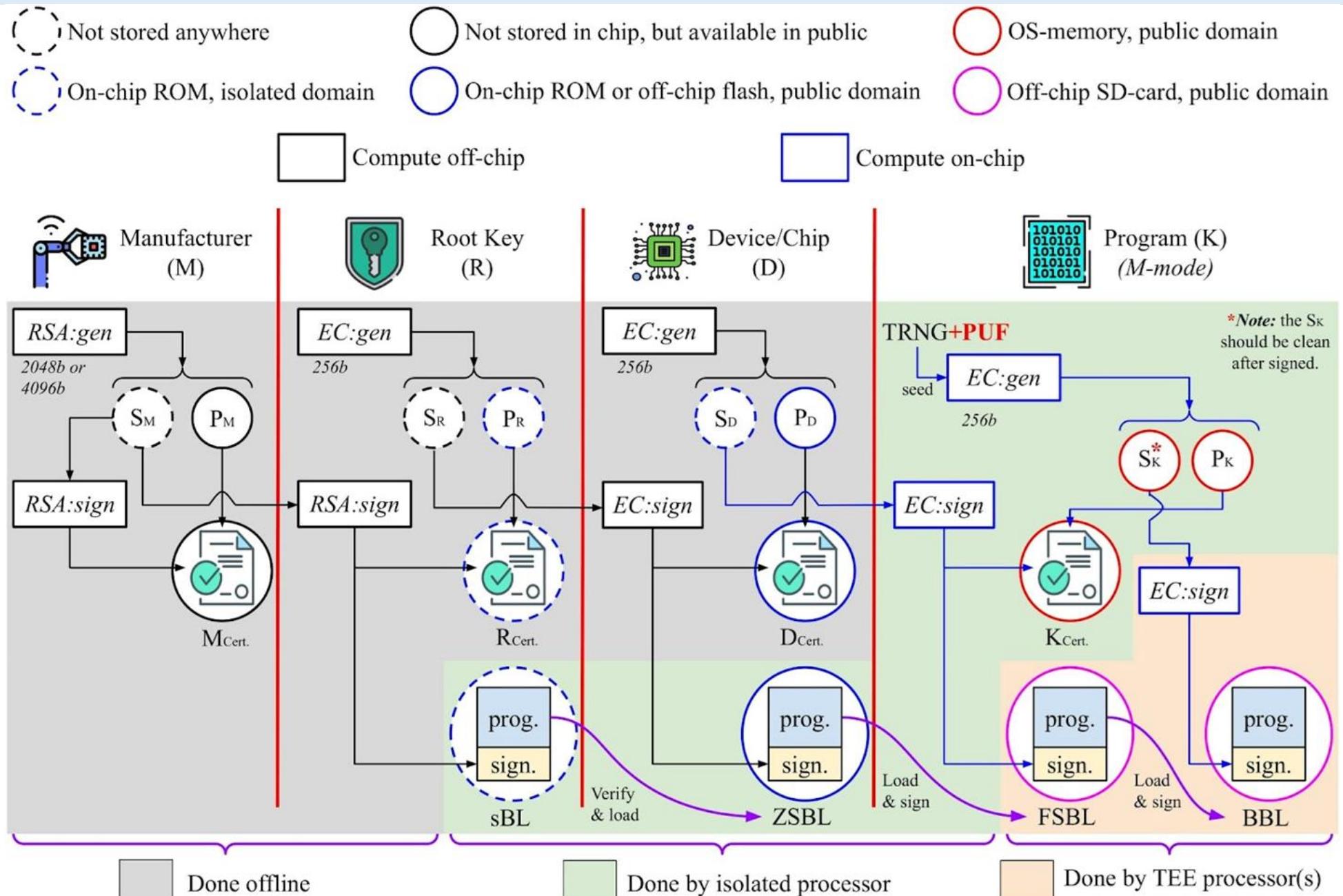
## Proposed secure boot process with Root-of-Trust for TEE



1. Root key installed at the time manufactured.
2. Hidden MCU for the flexible boot program
3. Hierarchy-bus: TEE processors cannot access RAM/ROMs in the isolated domain (*BUT the isolated core can access ALL*)

# 4. Proposed System (2/8) Key scheme

The proposed keys scheduling scheme



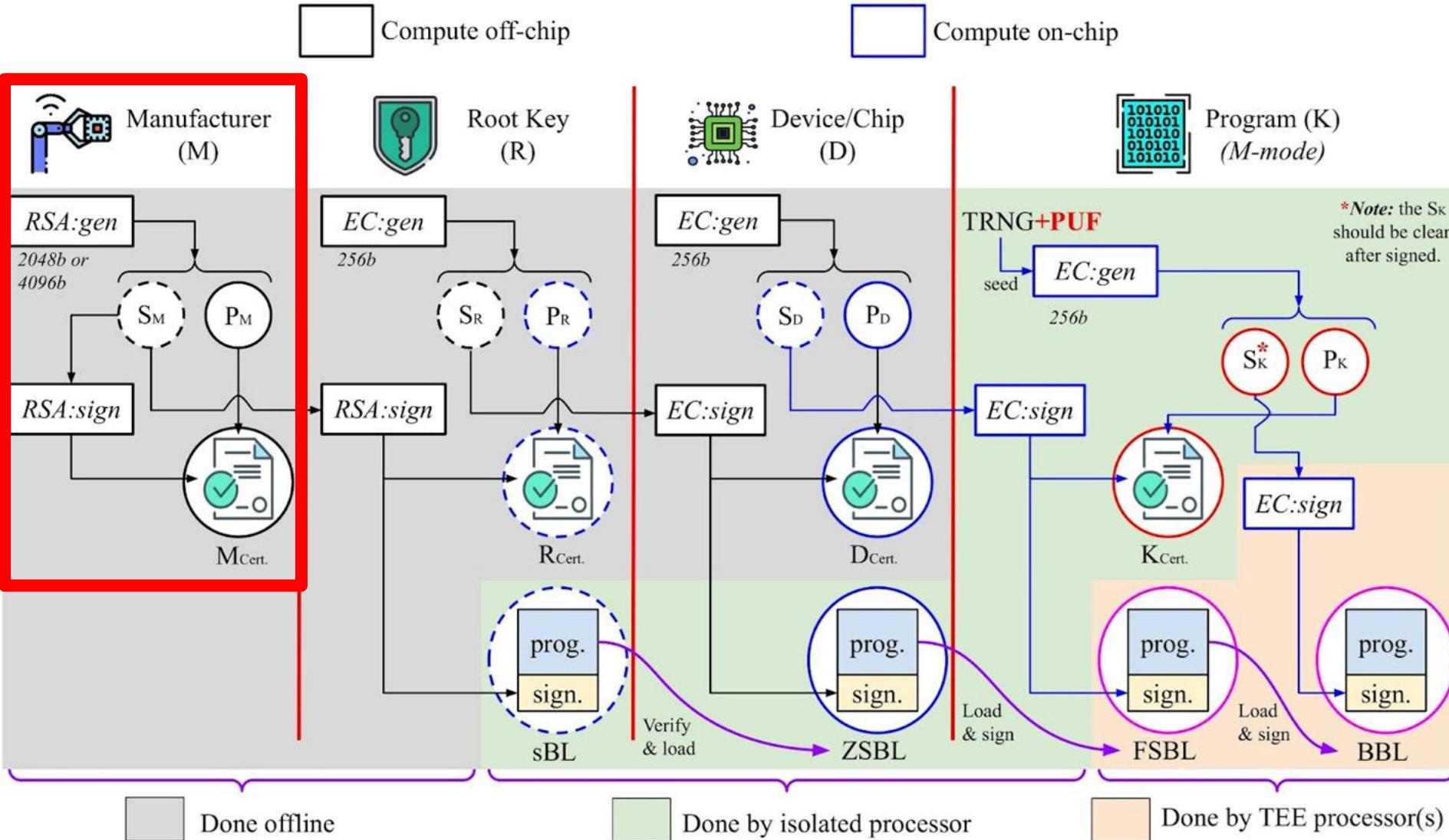
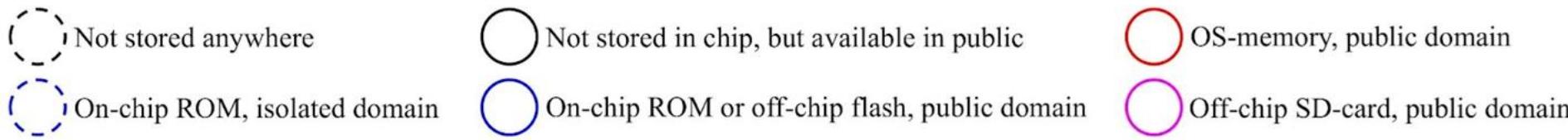
[Link](#)

Done offline

Done by isolated processor

Done by TEE processor(s)

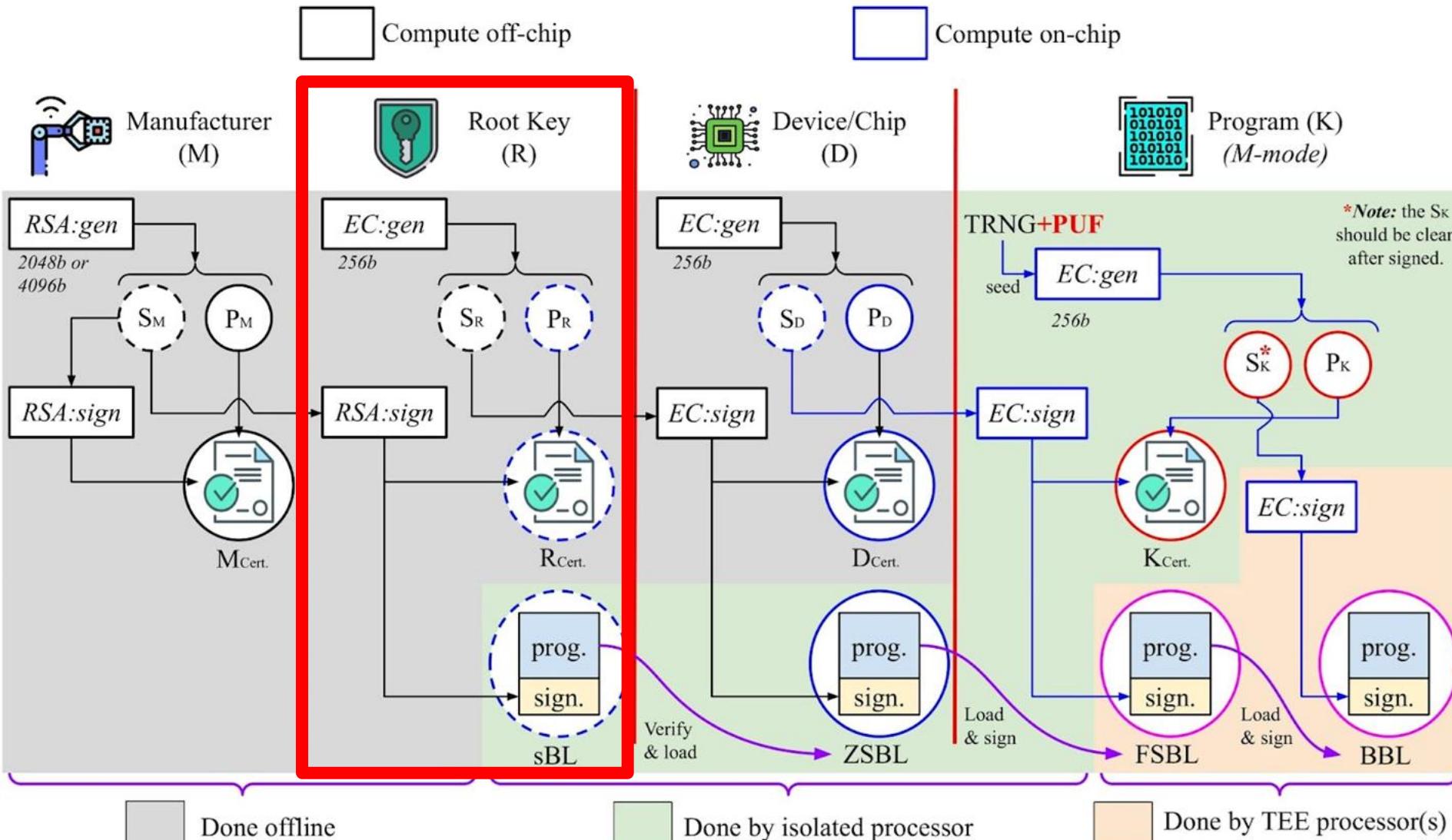
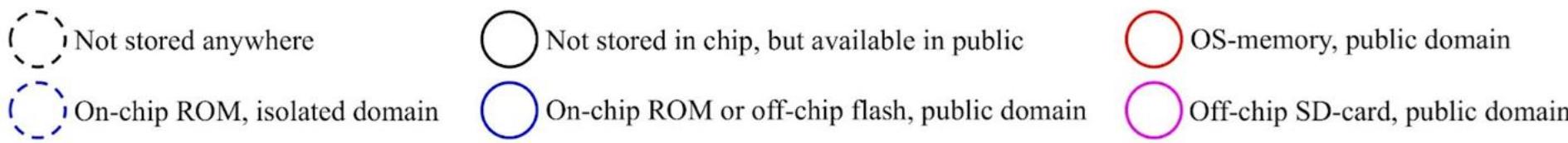
# 4. Proposed System (3/8) Key scheme: root CA



## Step-by-step

- **Step 1:** The manufacturer plays the role of root CA (*public key is well-known & certificate is self-signed*)

# 4. Proposed System (4/8) Key scheme: developer cert.

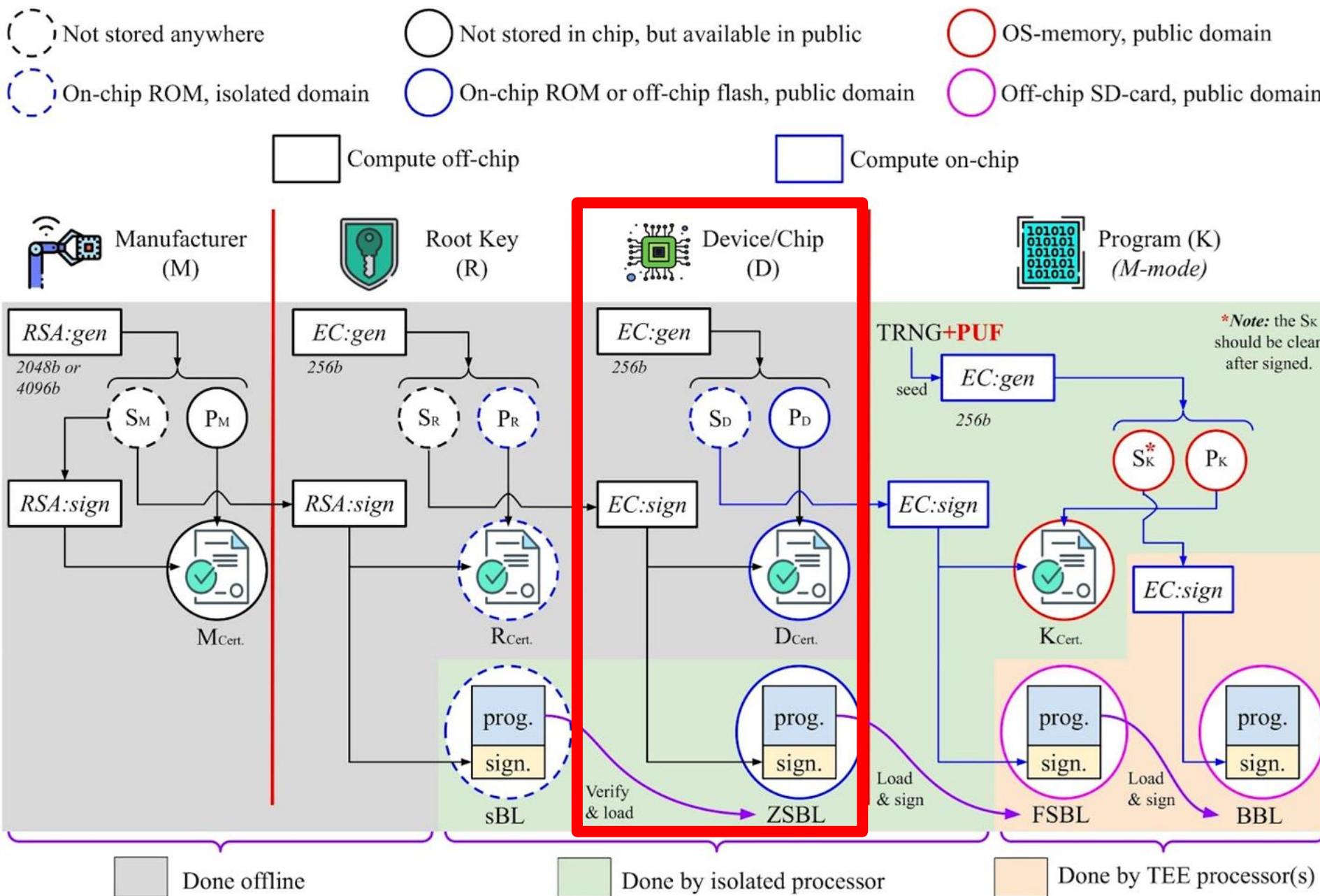


## Step-by-step

- **Step 2:** manufacturer generate root SR & PR also offline, and then uses SM to sign on the PR and secure BootLoader (sBL)

sBL is stored in the same place with PR, the isolated ROM.

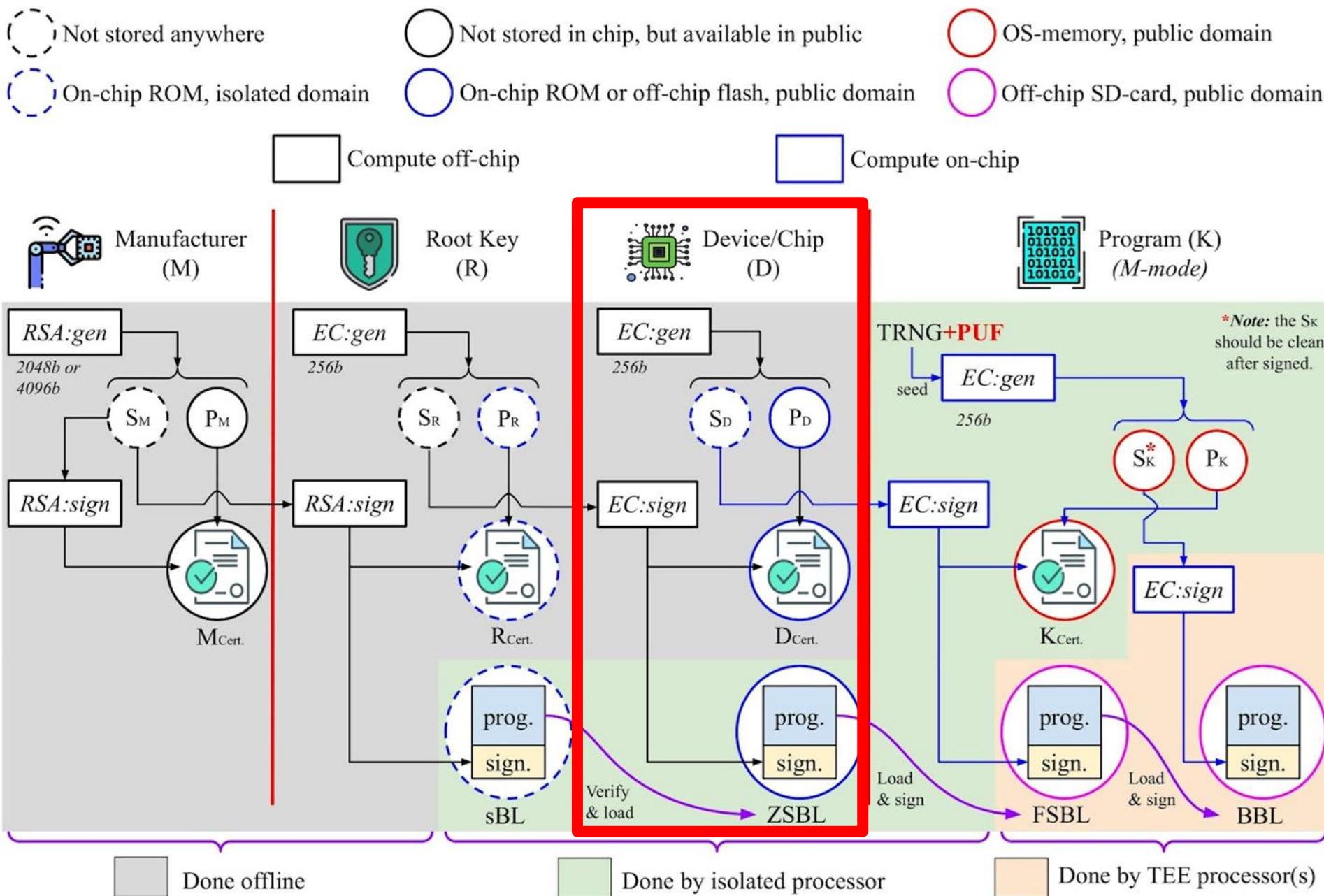
# 4. Proposed System (5/8) Key scheme: product cert.



## Step-by-step

- **Step 3: (still offline)**  
the manufacturer (*or the provider*) generates the pair SD & PD.  
Then have the root secret key generates the DCert. and sign the ZSBL.

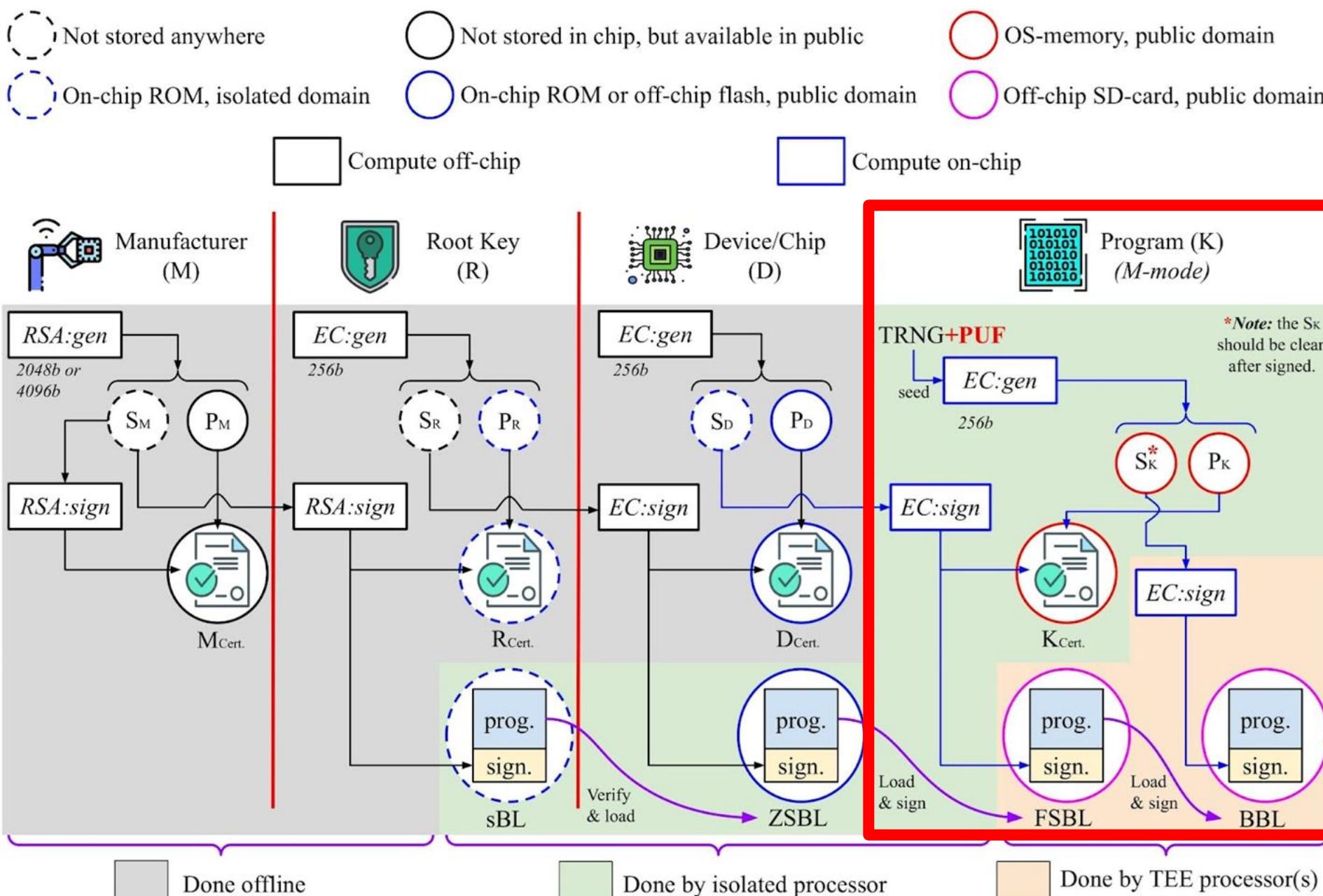
# 4. Proposed System (6/8) Key scheme: updatable ZSBL



Here is the RoT

- SD is stored in the isolated ROM.
- ZSBL & PD could be in a flash outside.
- The very first task of the isolated processor is:
  - Verify the ZSBL signature by using the PR → this allows future updates on the ZSBL.

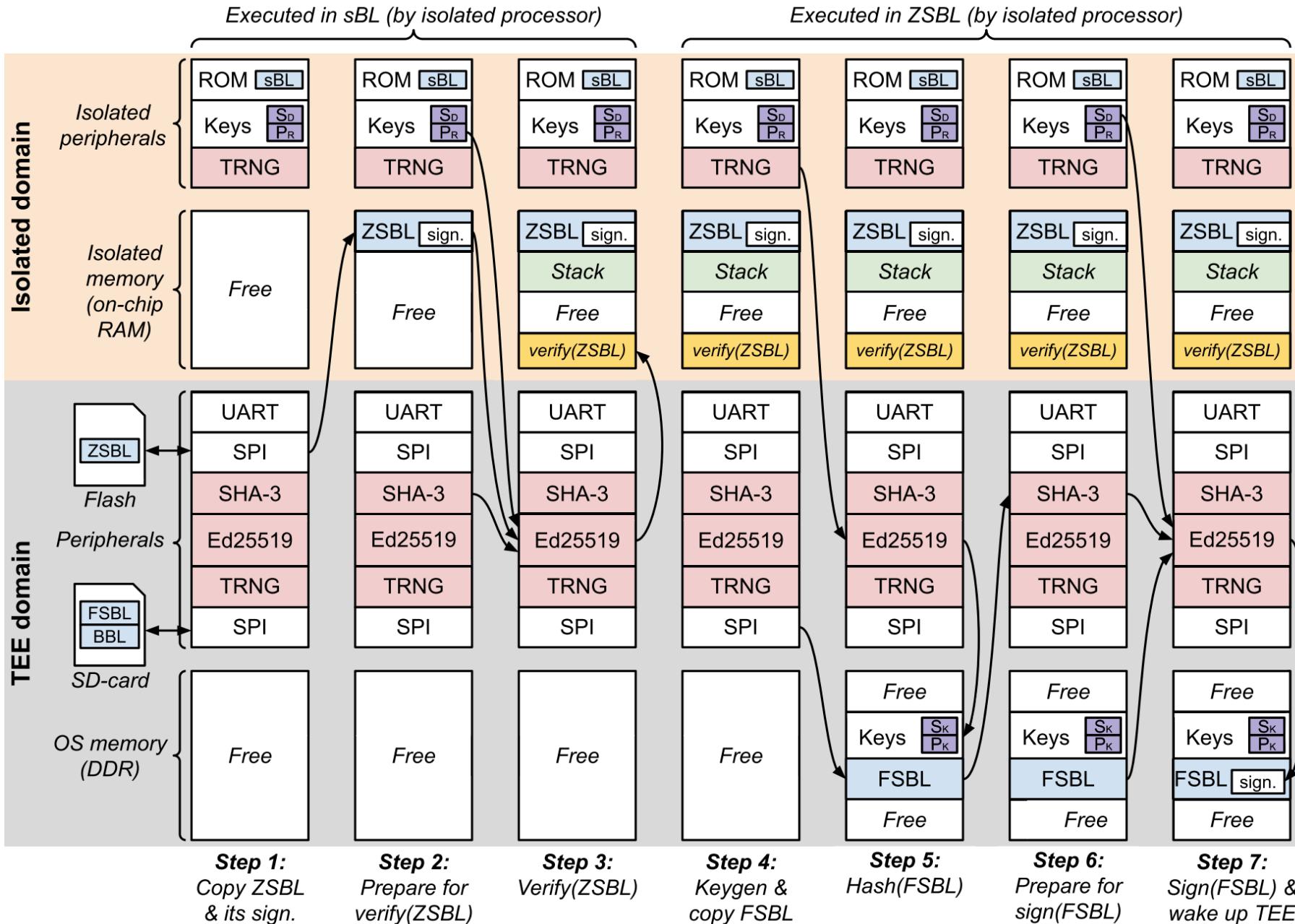
# 4. Proposed System (7/8) Key scheme: program cert.



## Step-by-step

- **Step 4: (now on-chip)**  
the isolated processor executes the ZSBL and:
  - Use TRNG to seed EC-genkey & create the pair of SK & PK
  - Load the FSBL (*hash & sign*) to the public RAM.
  - Wakes up the TEE processors

# 4. Proposed System (8/8) Detail boot flow

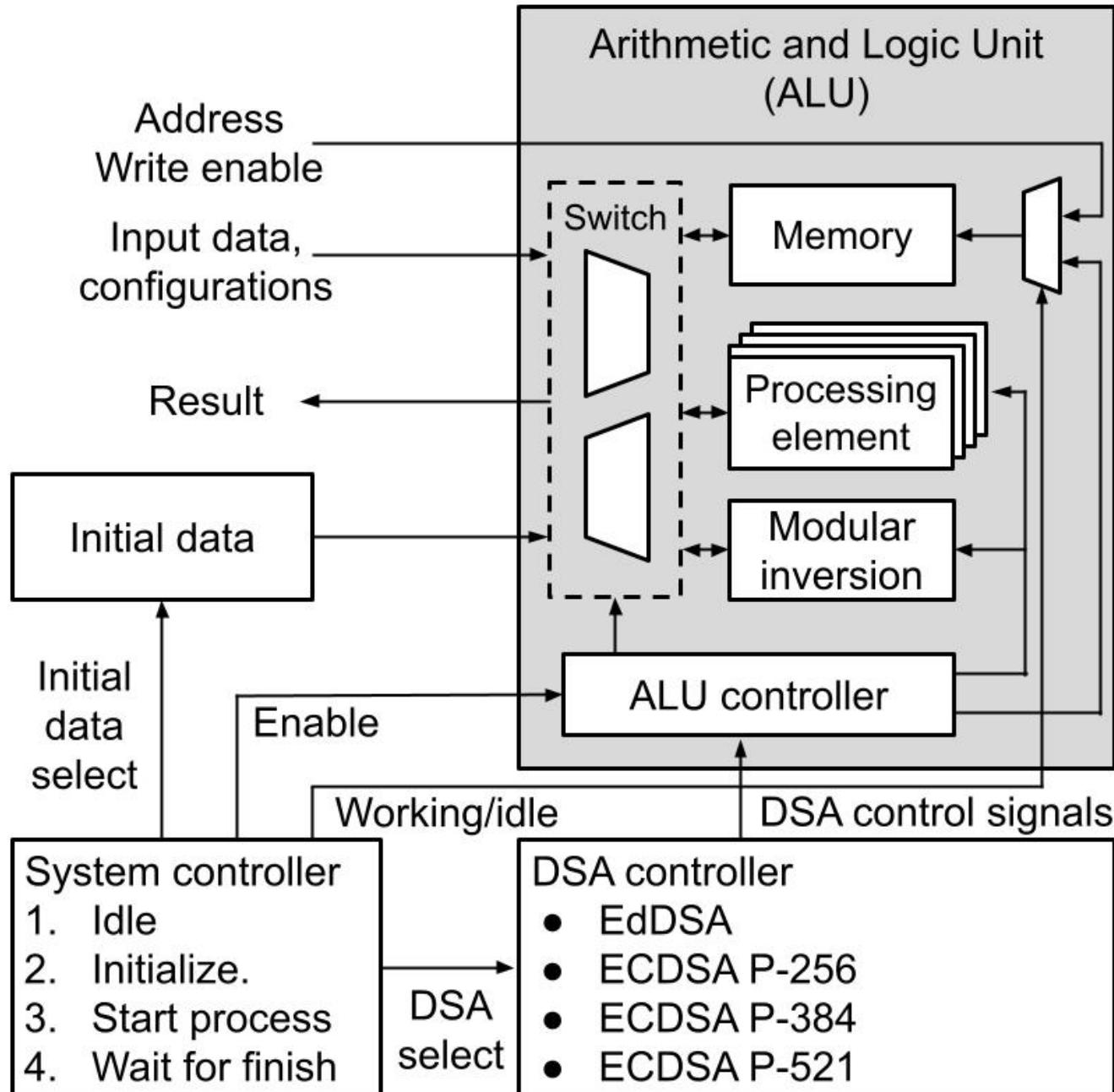


The detail boot flow based on the proposed key scheduling.

# Outline

1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion

# 5. Peripherals (1/14) EC/Ed-DSA

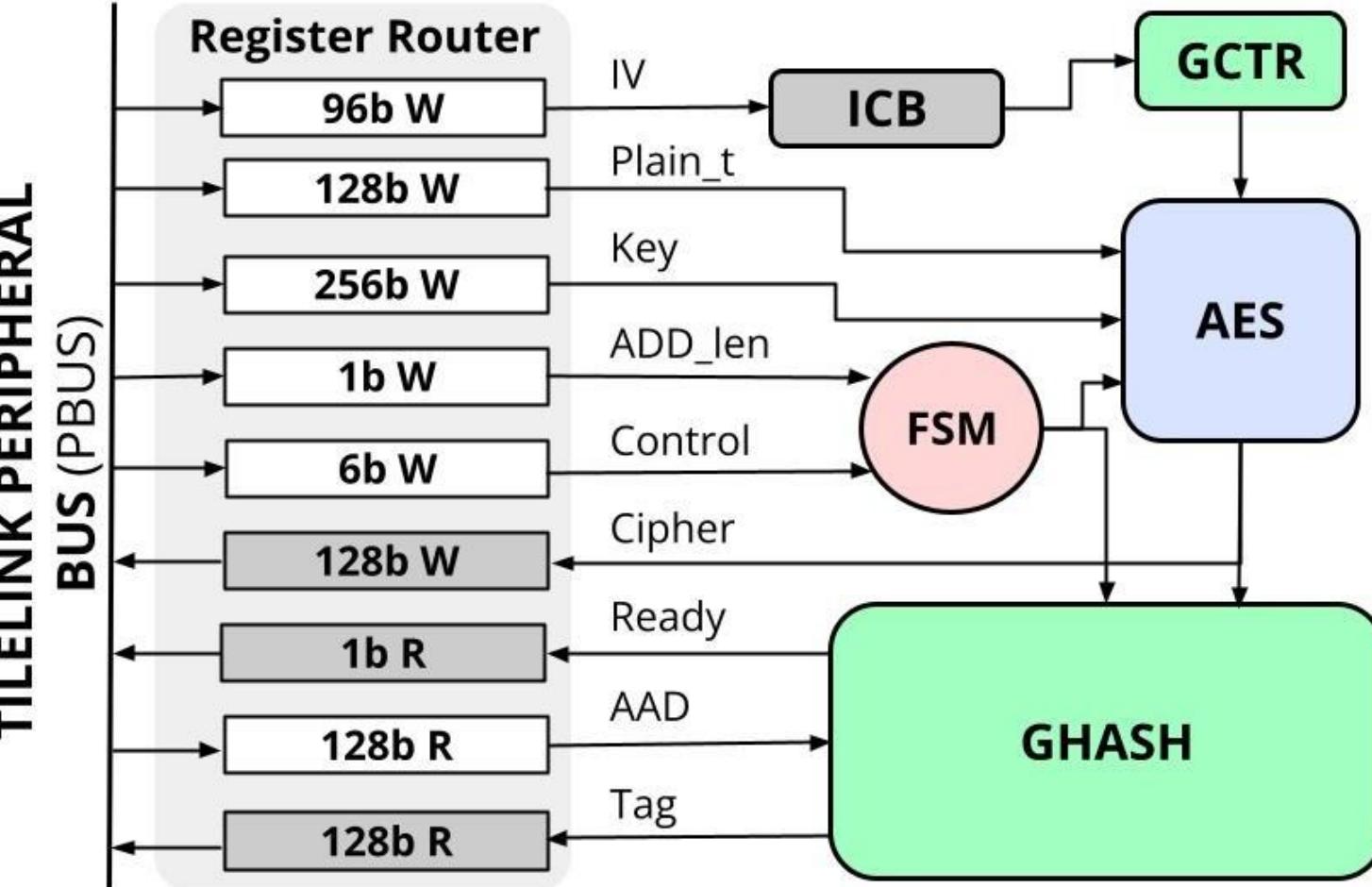


*Ecliptic Curve (EC) and  
Edwards-curve (Ed)  
Digital Signature Algorithm (DSA)*

- Support four curves: three of ECDSA and one of EdDSA
- Support 256-bit, 384-bit, and 512-bit
- Support functions: gen-key, sign, and verify

[Link](#)

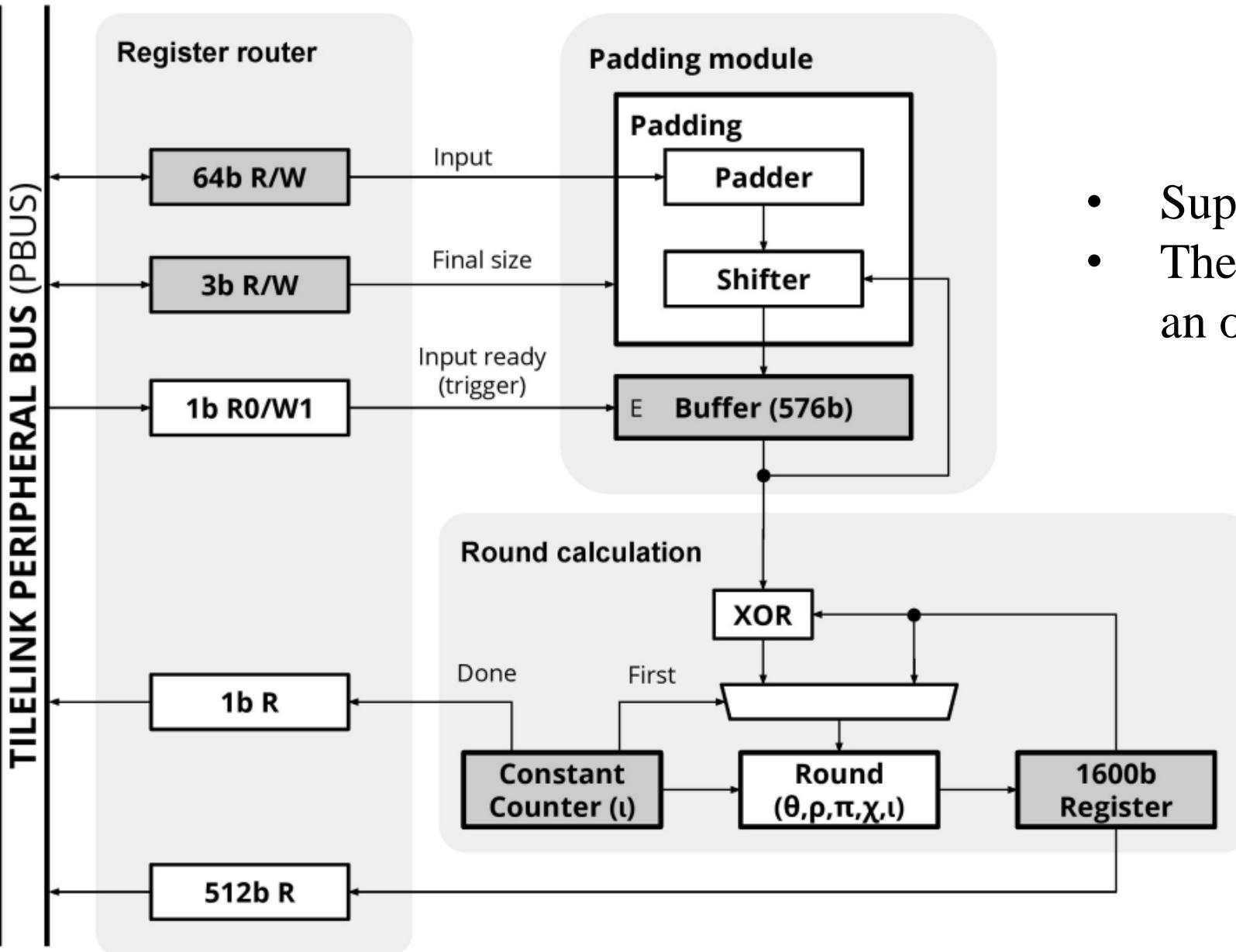
## 5. Peripherals (2/14) AES-GCM



Advanced *Encryption Standard* (*AES*) with *Galois/Counter Mode* (*GCM*)

- Support encryption and decryption.
- Support 128-bit and 256-bit.

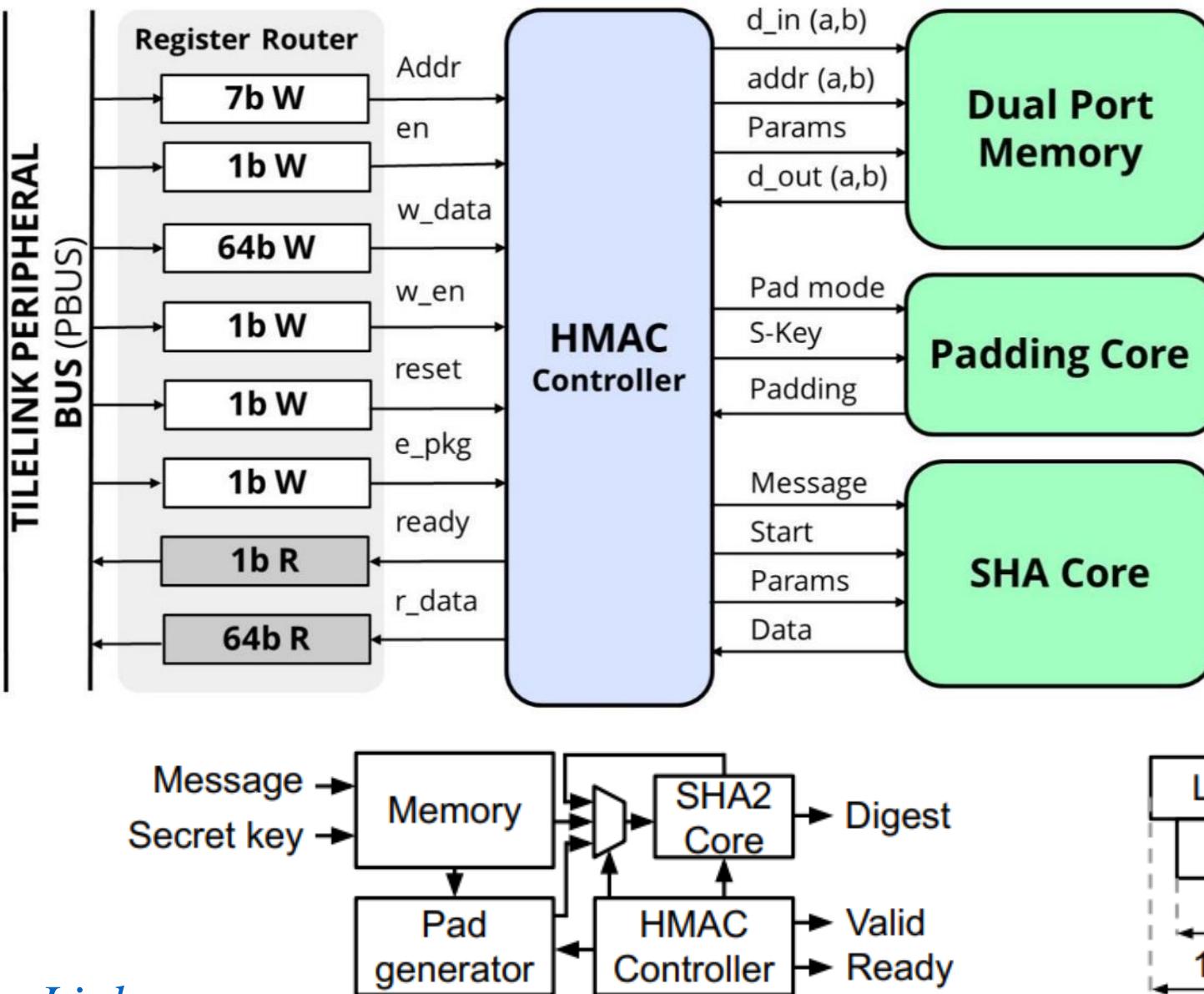
# 5. Peripherals (3/14) SHA3



## SHA3-512

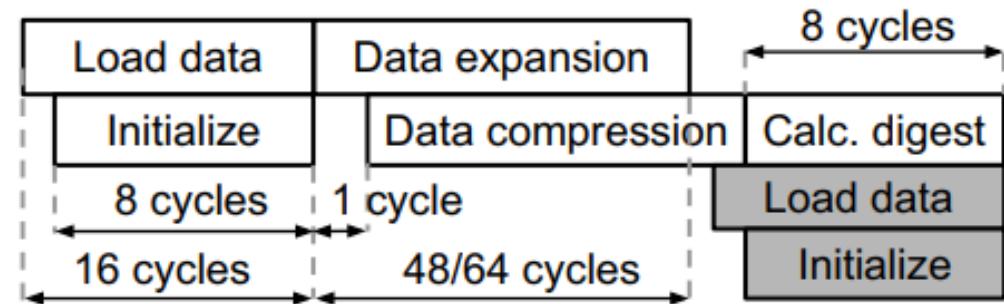
- Support 512-bit.
- The core was developed based on an open-source project ([link](#)).

# 5. Peripherals (4/14) HMAC-SHA2

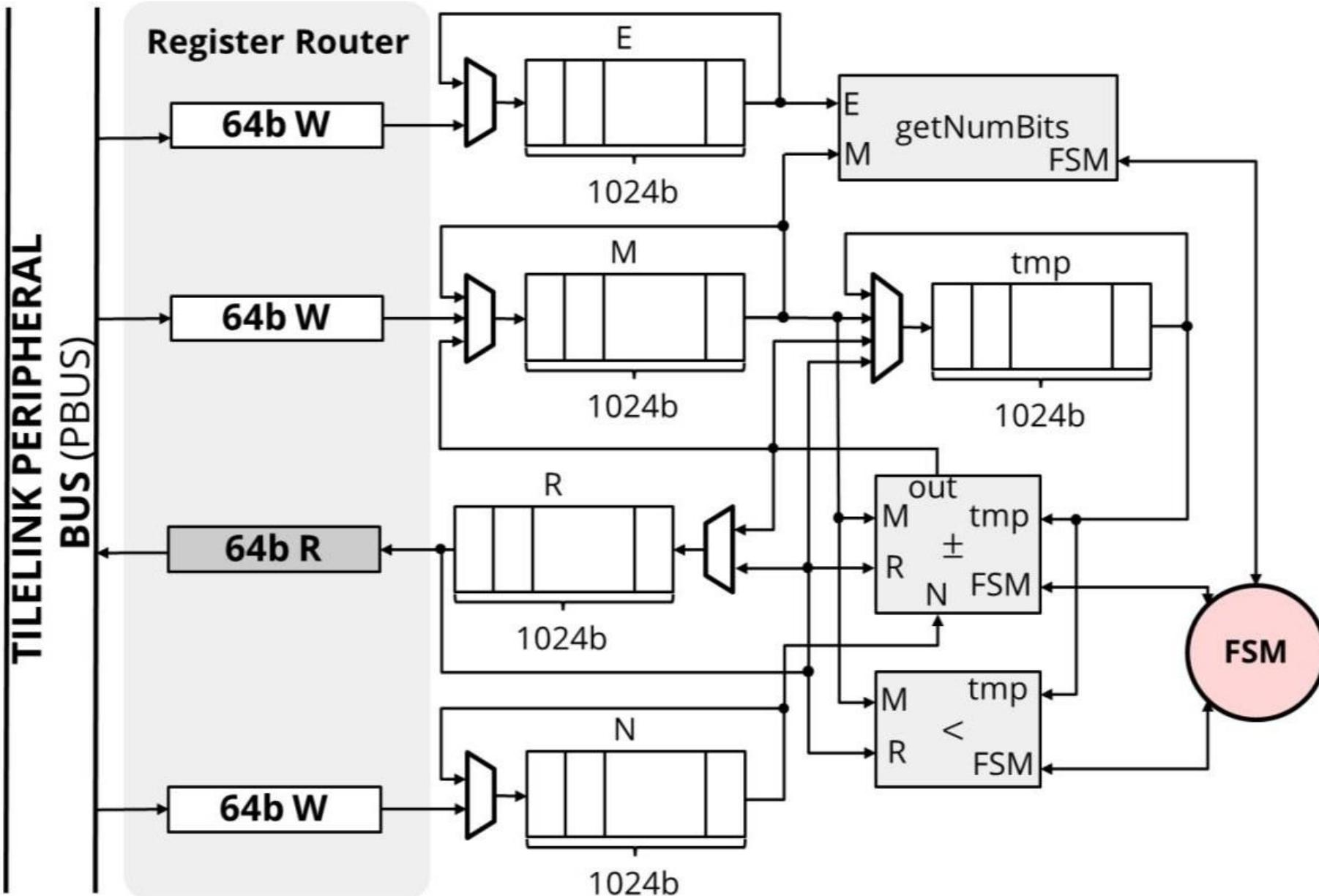


**Hash-based Message Authentication Code (HMAC) with SHA2**

- Two modes: HMAC-SHA2 or SHA2 only.
- Support: 256-bit, 384-bit, and 512-bit.



# 5. Peripherals (5/14) RSA



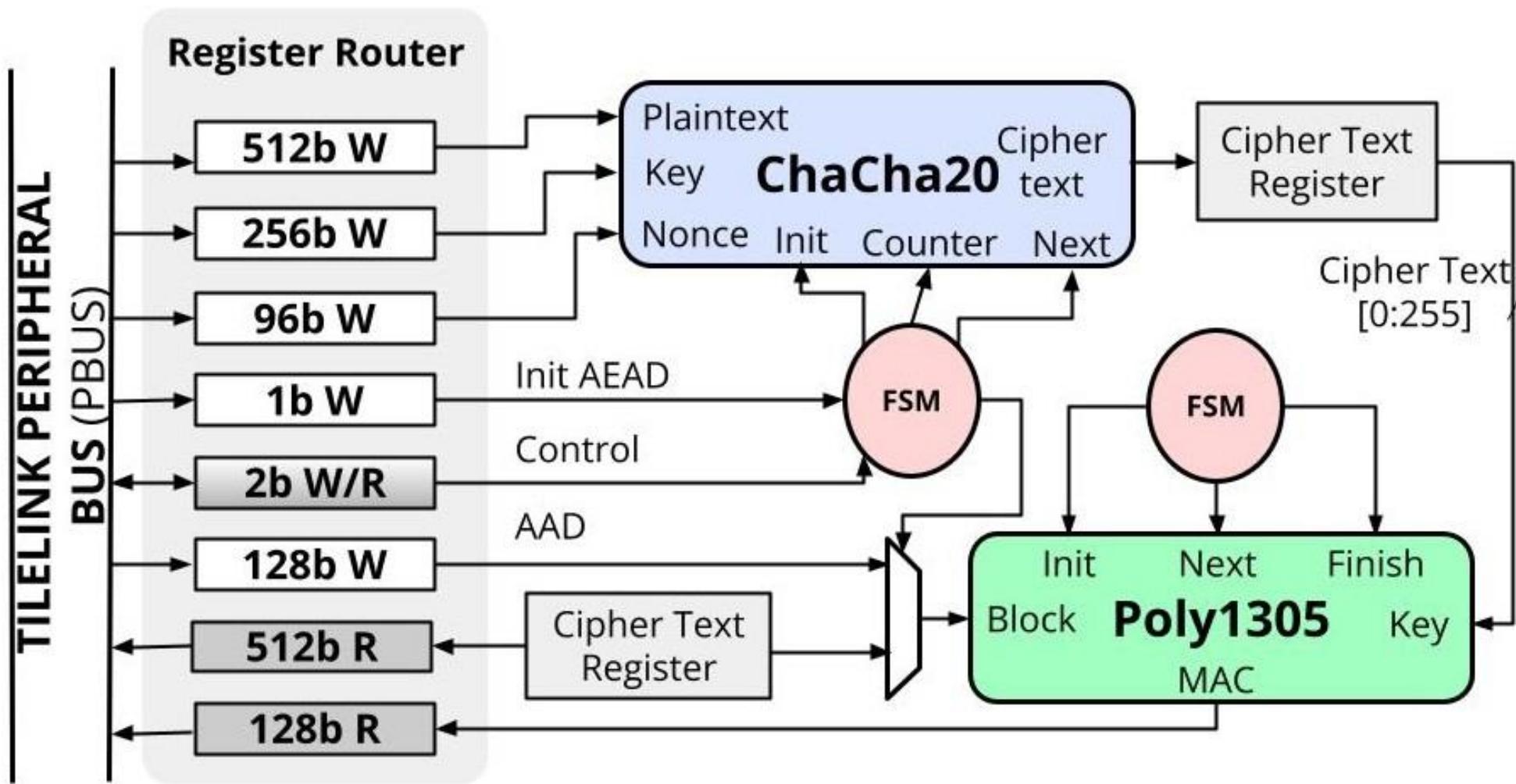
## RSA-1024

- Minimize the area by using less “big”- registers as much possible
- Small tasks are done by primitives such as *getNumBits* (number of meaning LSBs),  $\pm$ , and  $<$
- Primitive functions execute 32-bit at a time

# 5. Peripherals (6/14) AEAD

**Authenticated Encryption with Associated Data (AEAD)** ([link](#))

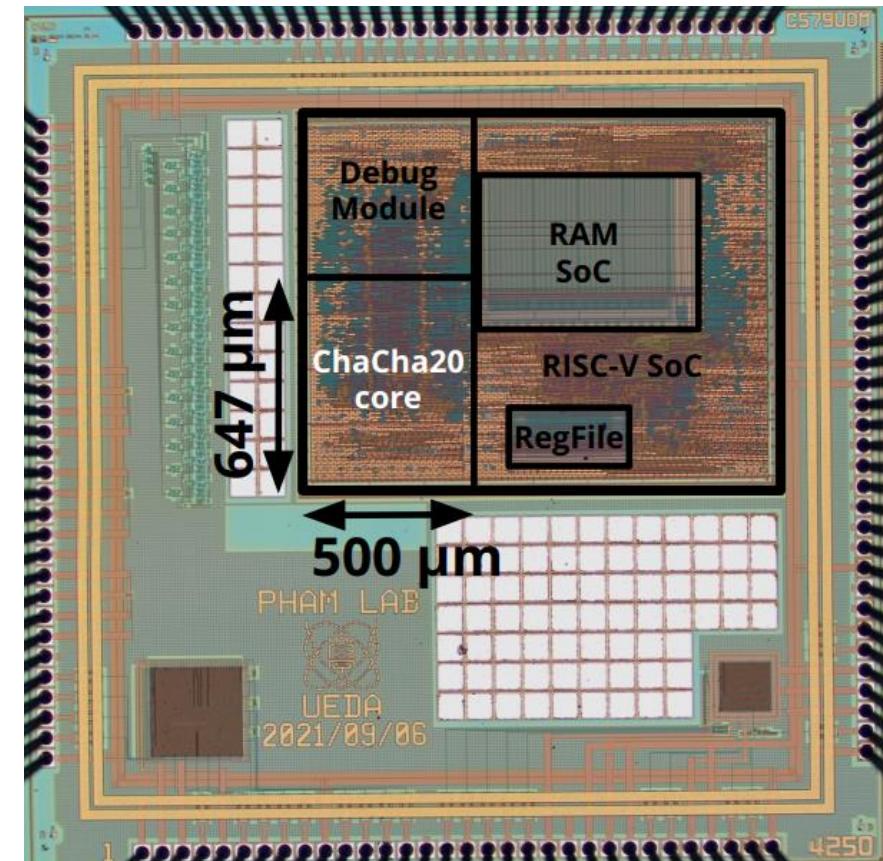
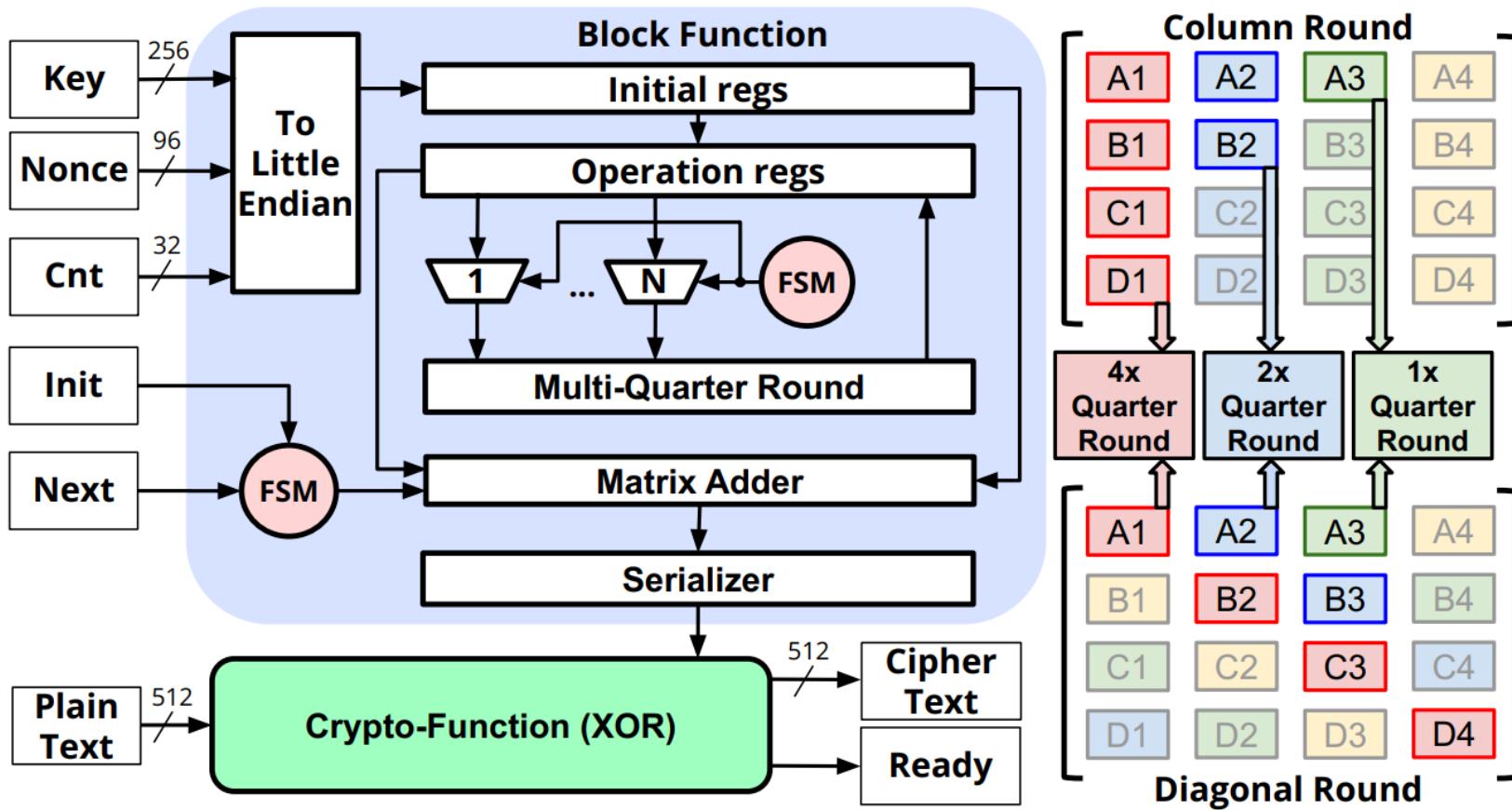
- Use *ChaCha20* as a stream cipher and *Poly1305* as a MAC.



# 5. Peripherals (7/14) ChaCha20

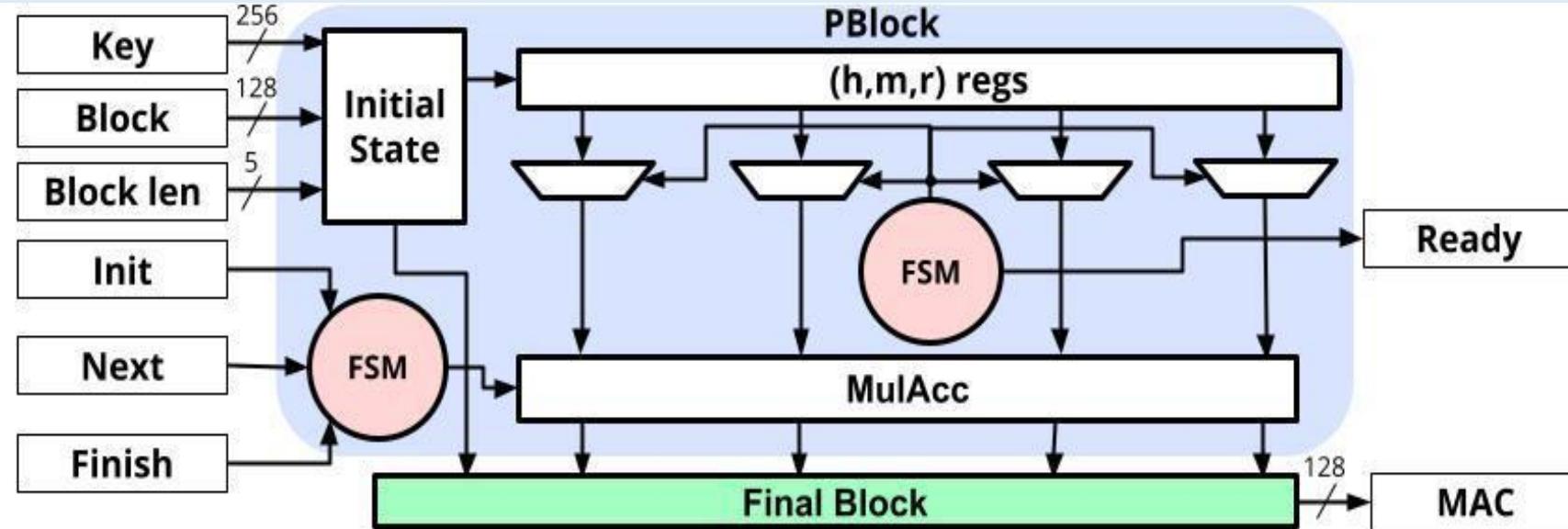
## ChaCha20

- A stream cipher that was standardized recently ([link](#)).
- Can work alone or team-up with *Poly1305* to perform Authenticated *Encryption* with Additional *Data (AEAD)*.



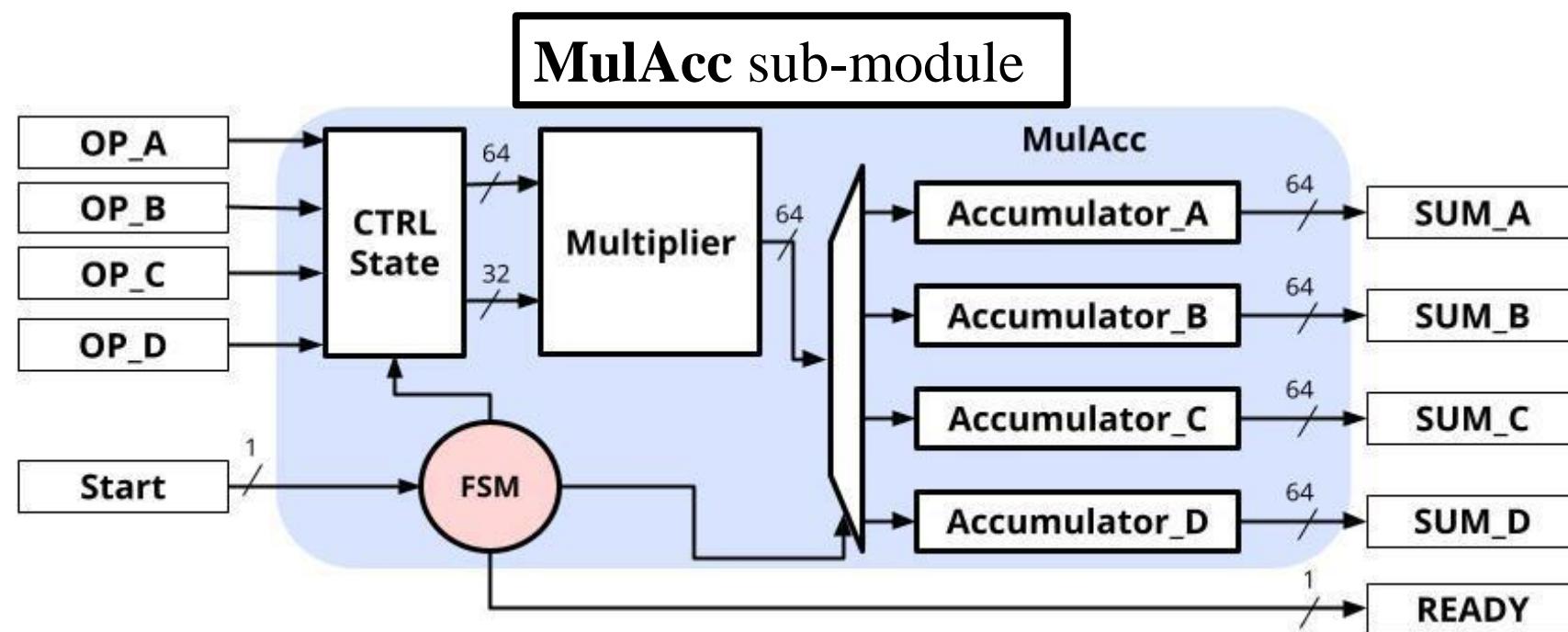
[Link](#)

# 5. Peripherals (8/14) Poly1305



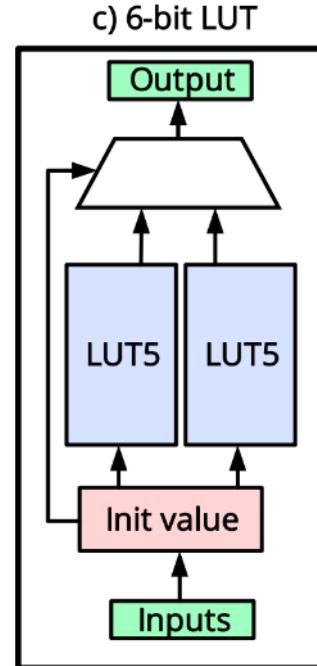
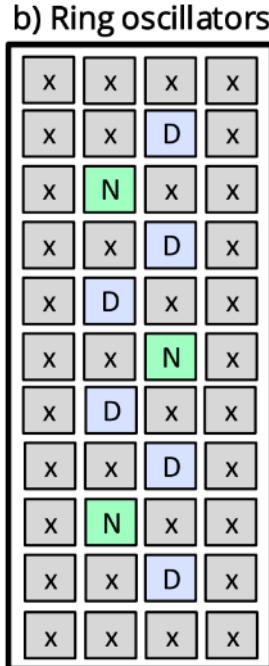
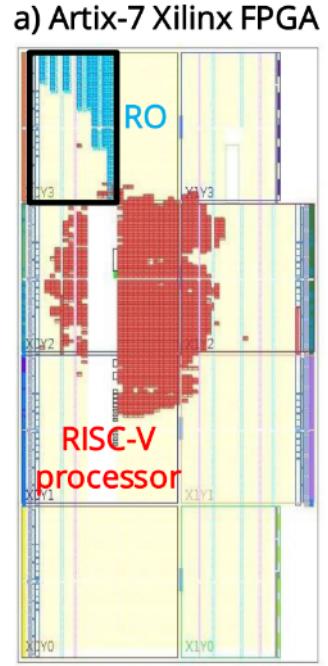
## Poly1305

- A *Message Authentication Code (MAC)* that was standardized recently ([link](#)).
- Can work alone or team-up with *ChaCha20* to perform *Authenticated Encryption with Additional Data (AEAD)*.



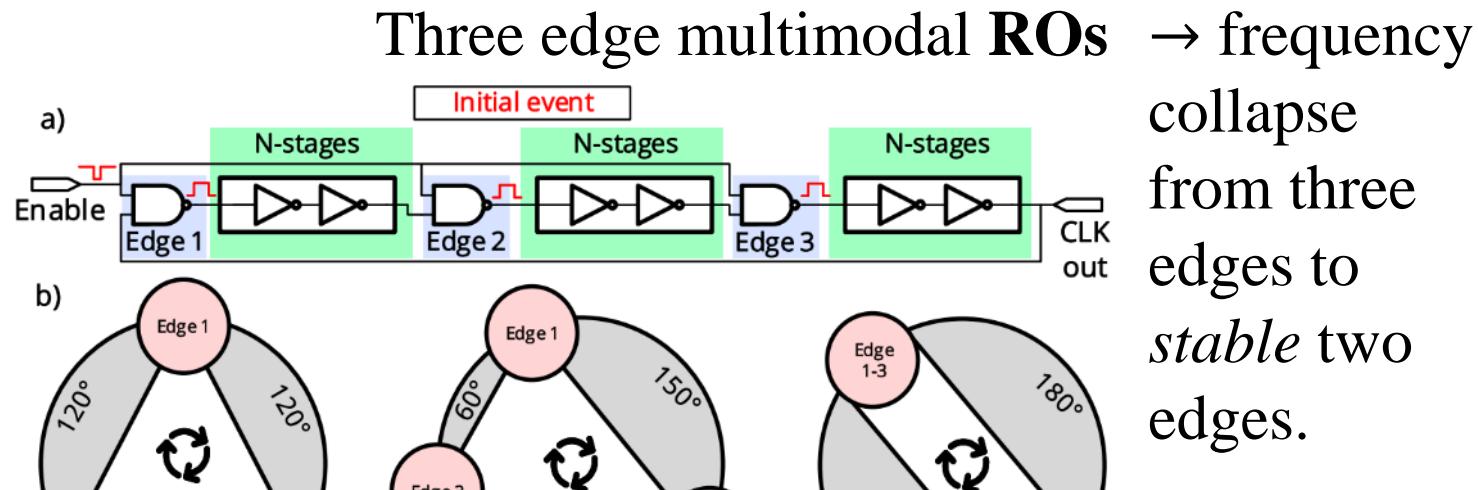
# 5. Peripherals (9/14) TRNG

Our **True Random Number Generator (TRNG)** is based on the frequency collapse phenomenon of **Ring Oscillators (ROs)**.

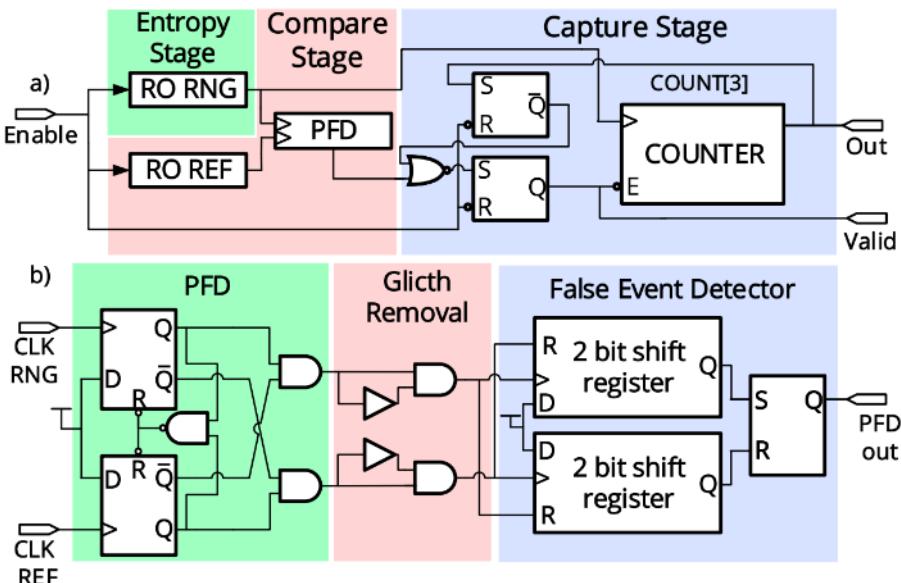


The idea can be implemented in FPGA.

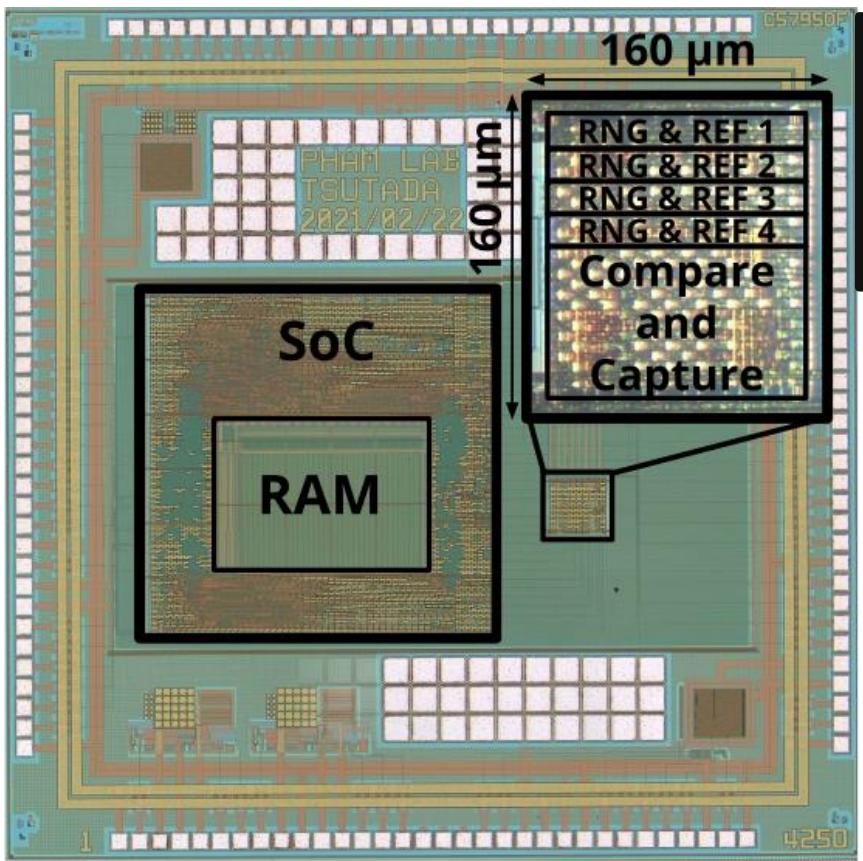
[Link](#)



The proposed **TRNG** system based on multimodal ROs.

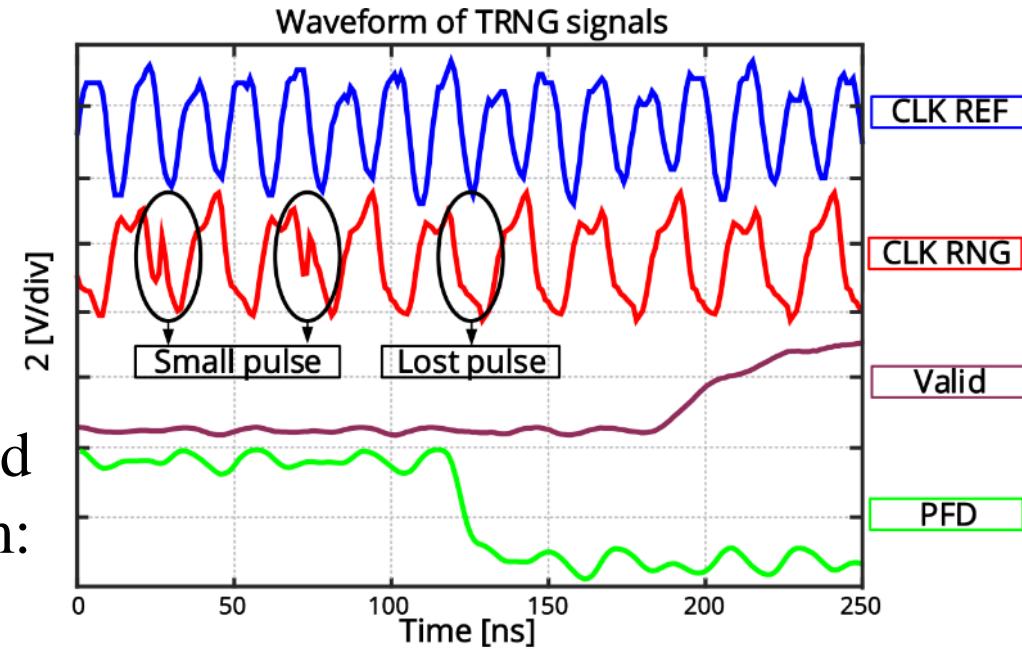


# 5. Peripherals (10/14) TRNG

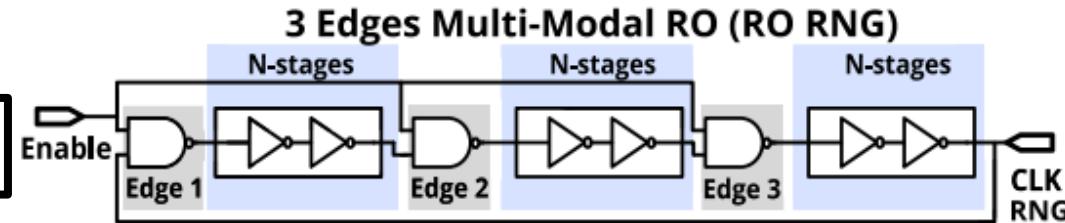


2.5×2.5-mm<sup>2</sup>  
ROHM180nm  
on 2021/02

The wanted  
waveform:

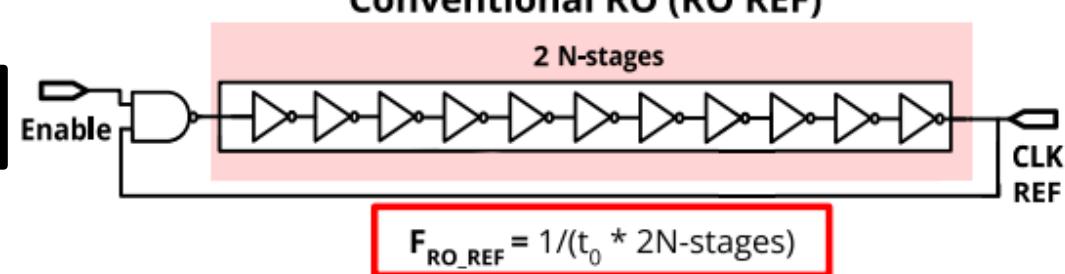


Proposed:



$$F_{RO\_RNG} = 1/(t_0 * N\text{-stages})$$

Conventional:



$$F_{RO\_REF} = 1/(t_0 * 2N\text{-stages})$$

The proposed design passed ([link](#)):

- NIST SP800-90B & SP800-22
- AIS31 & AIS20
- PVT healthy test

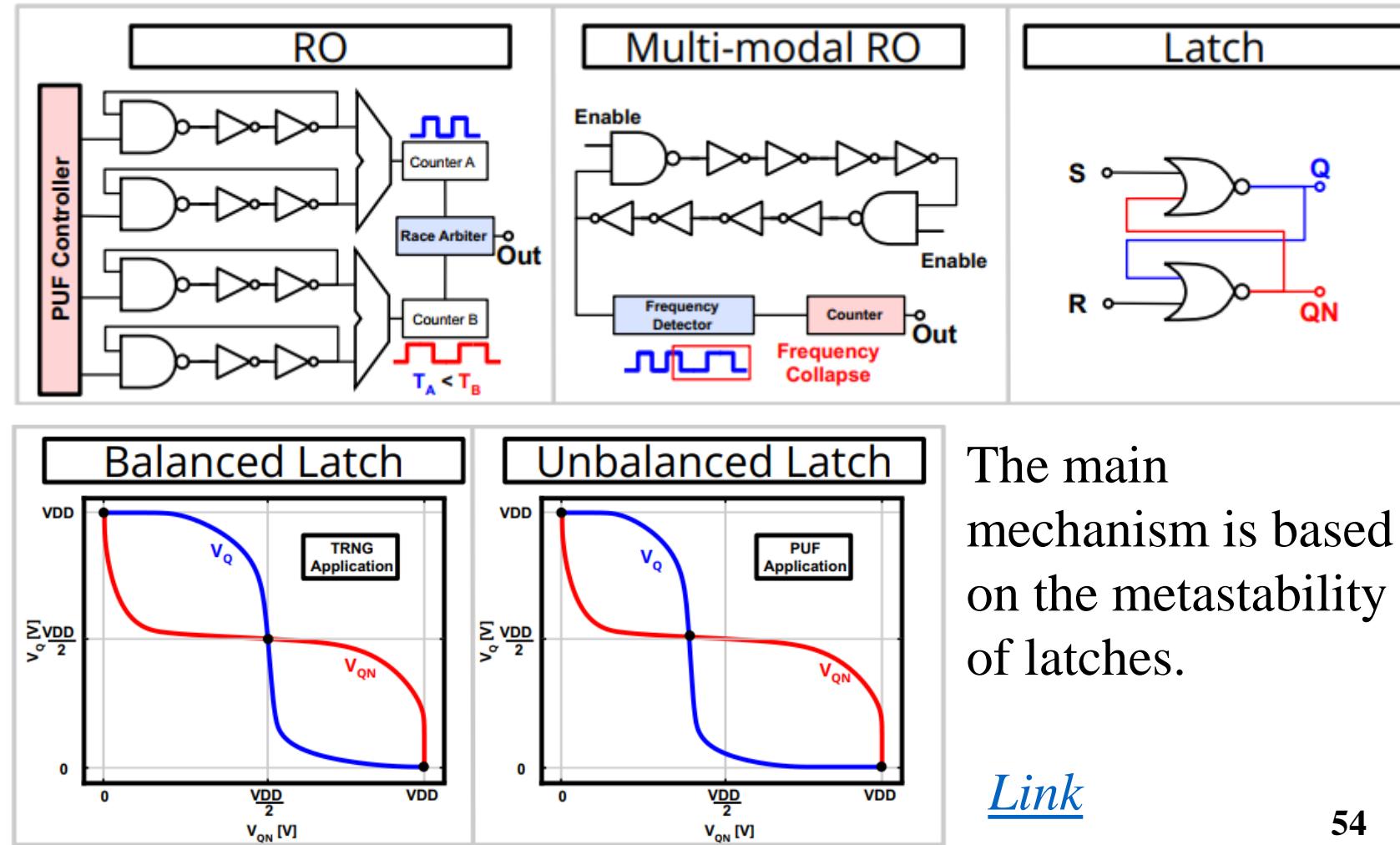
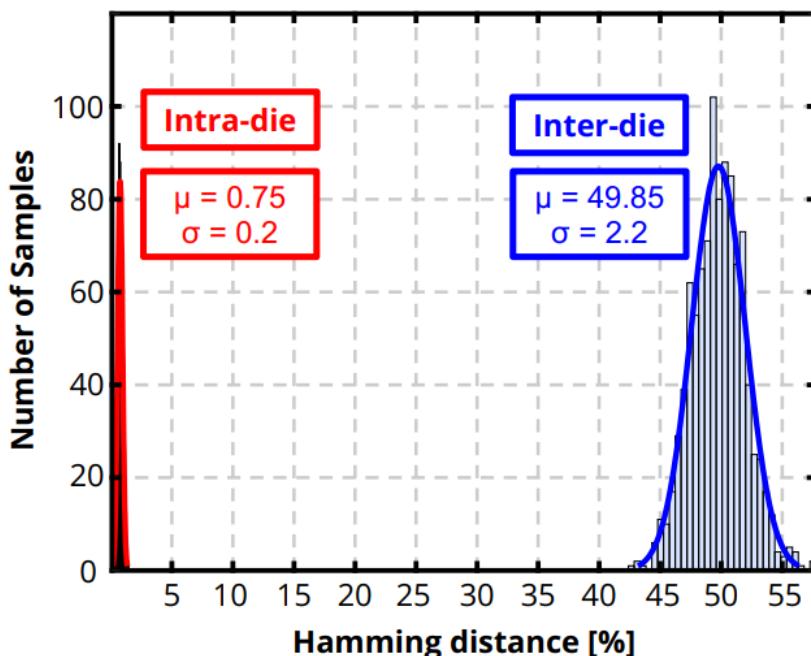
# 5. Peripherals (11/14) PUF in VLSI

Physical Unclonable Function (**PUF**) is a physical “*object*” that serves as a unique identifier for *each* device, although the implementation is the same for *all* devices.

*Example:* fingerprints.  
Everybody has a fingerprint, but no two fingerprints are alike.

PUF architecture based on *RO*, *multimodal RO*, and *latches*:

Passed the intra/inter-die tests:

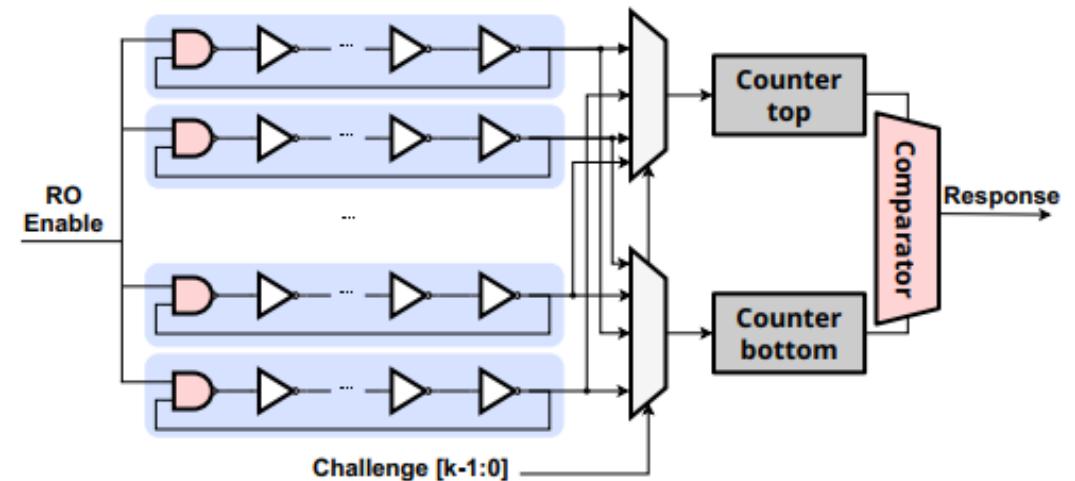


The main mechanism is based on the metastability of latches.

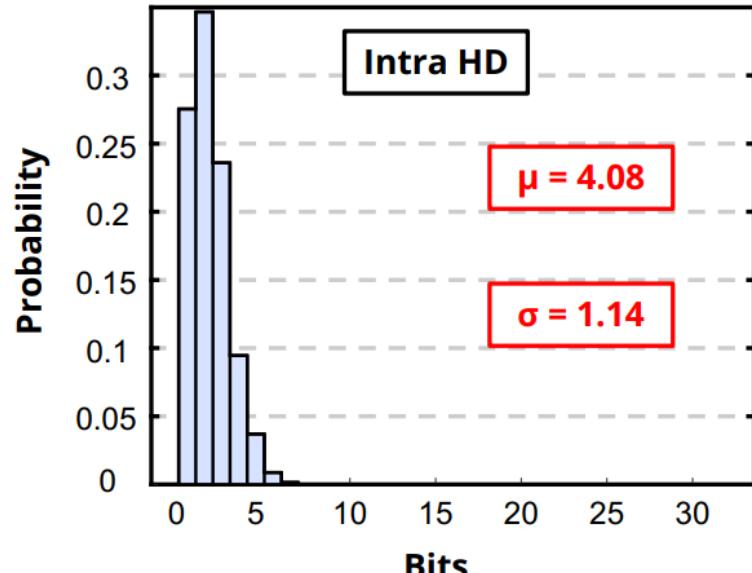
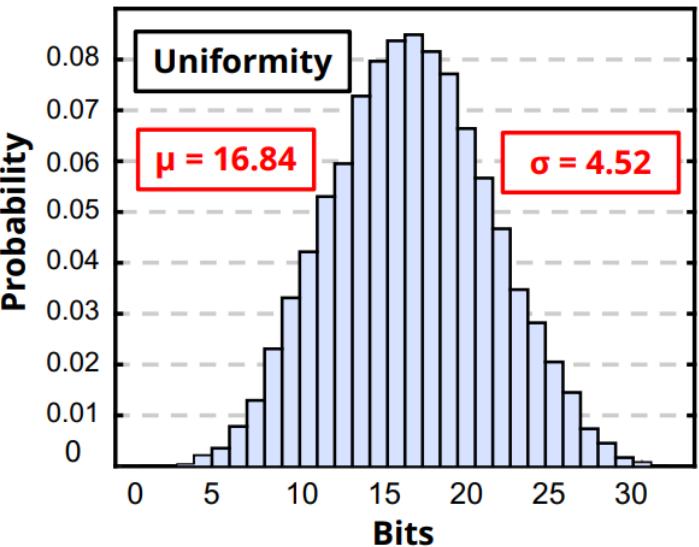
[Link](#)

# 5. Peripherals (12/14) PUF in FPGA

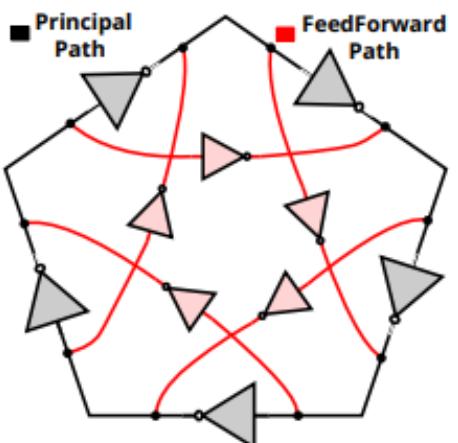
Conventional RO-based PUF:



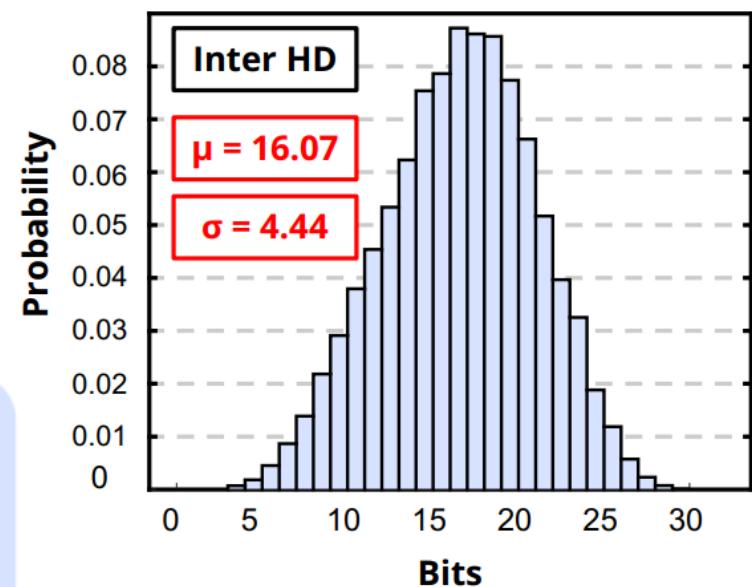
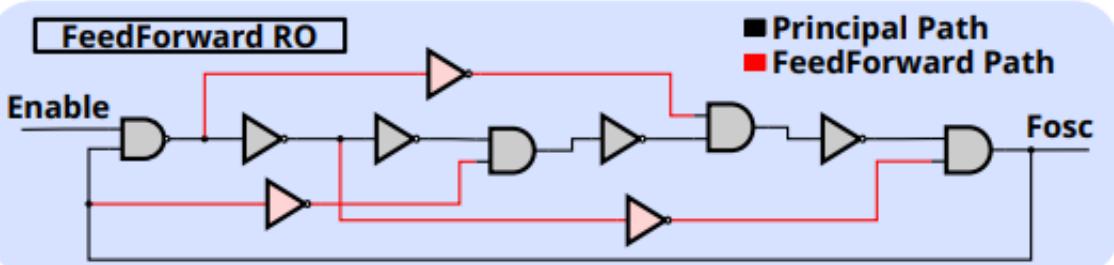
Passed the  
intra/inter-die tests:



5-stage Feedforward *RO* (*FRO*):

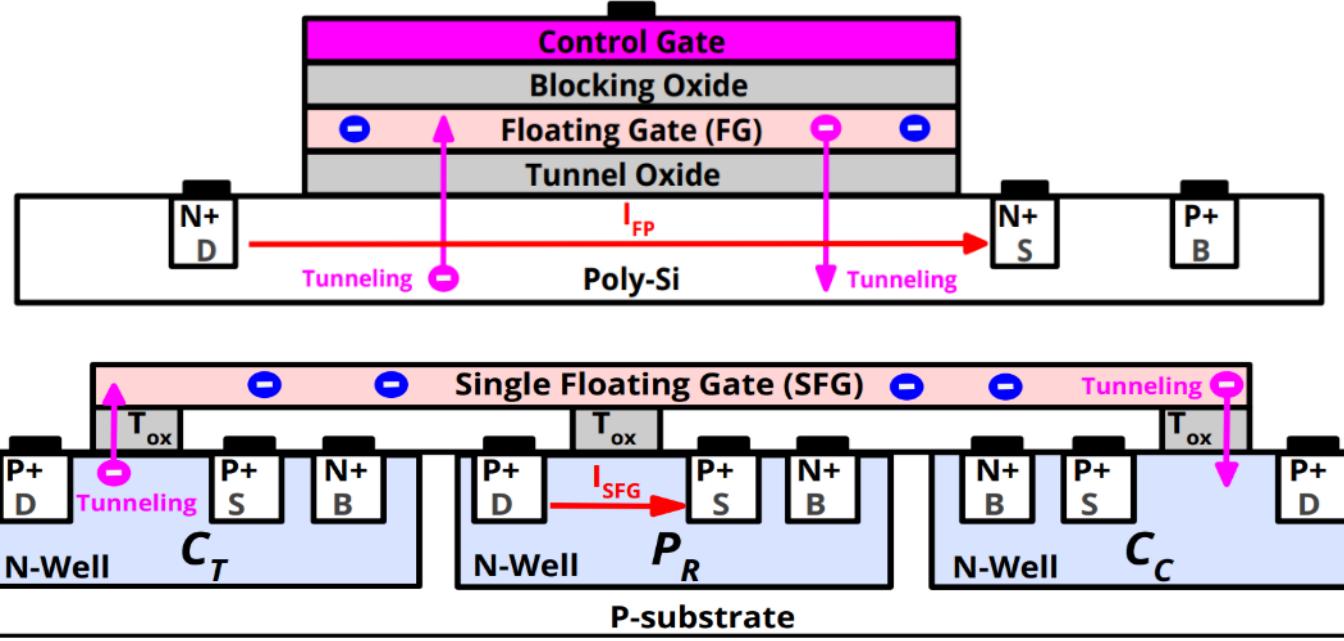


Proposed FRO-based PUF in FPGA:

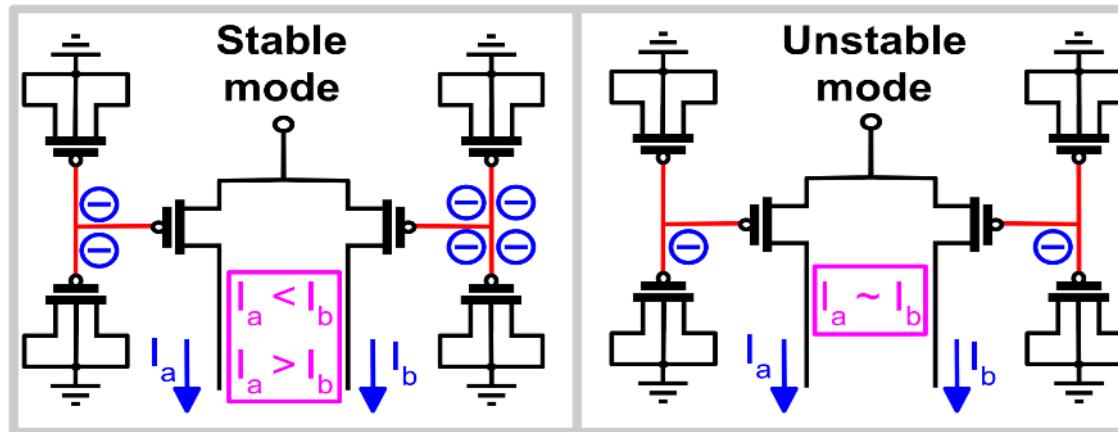


# 5. Peripherals (13/14) NVRAM

Typical NVRAM design in standard CMOS technology

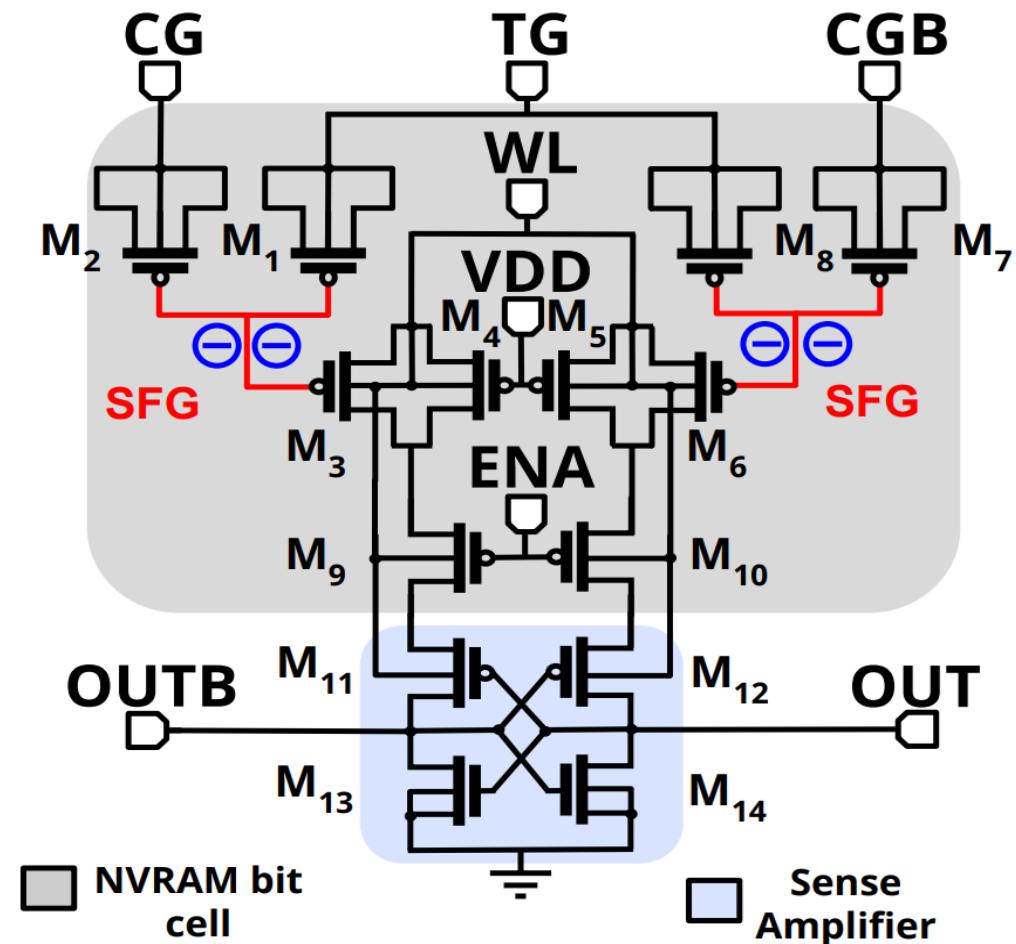


Simplified operating modes:



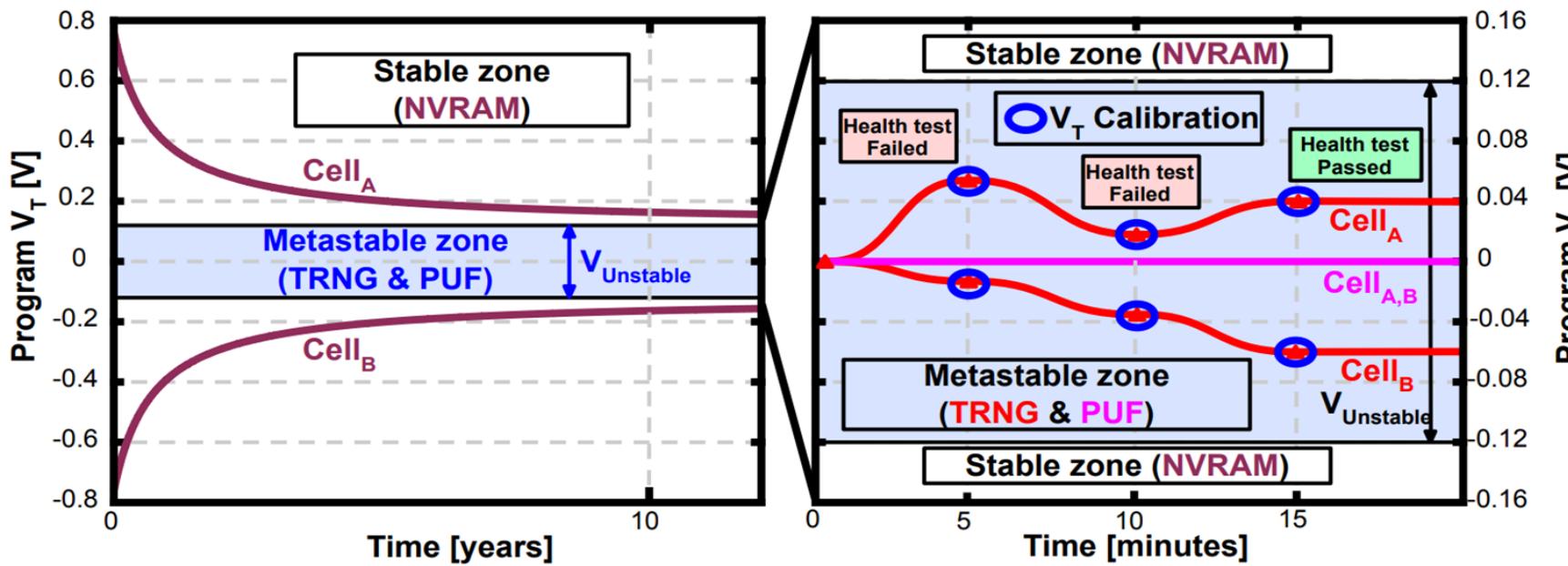
[Link](#)

Proposed NVRAM design  
without using special layer(s)

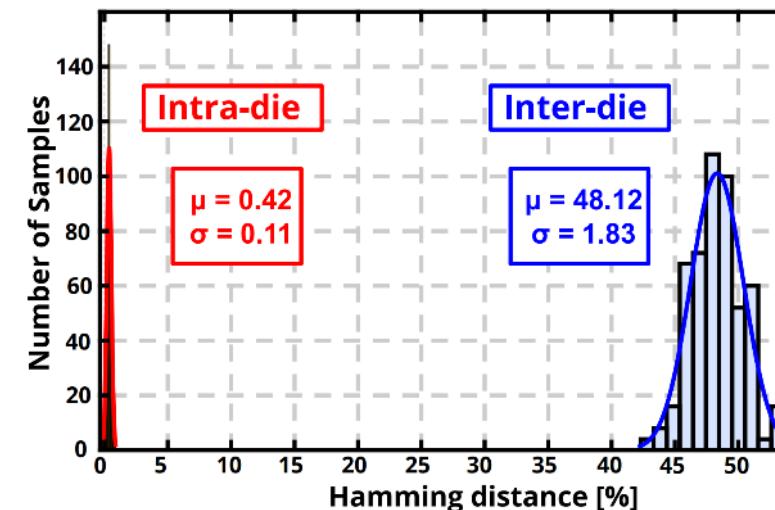
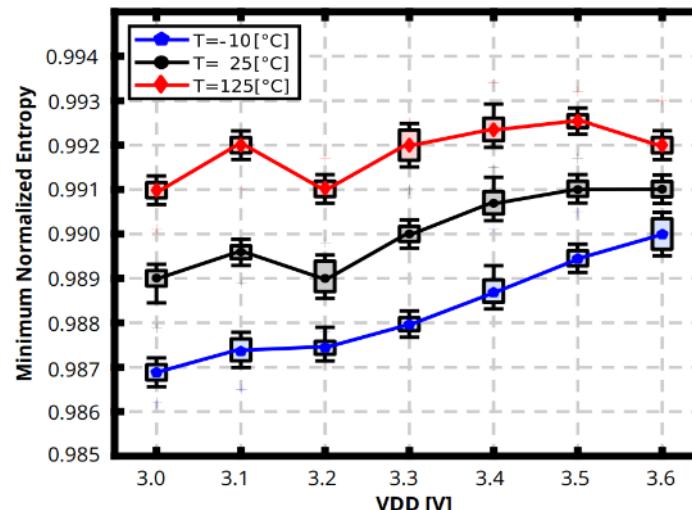


# 5. Peripherals (14/14) NVRAM

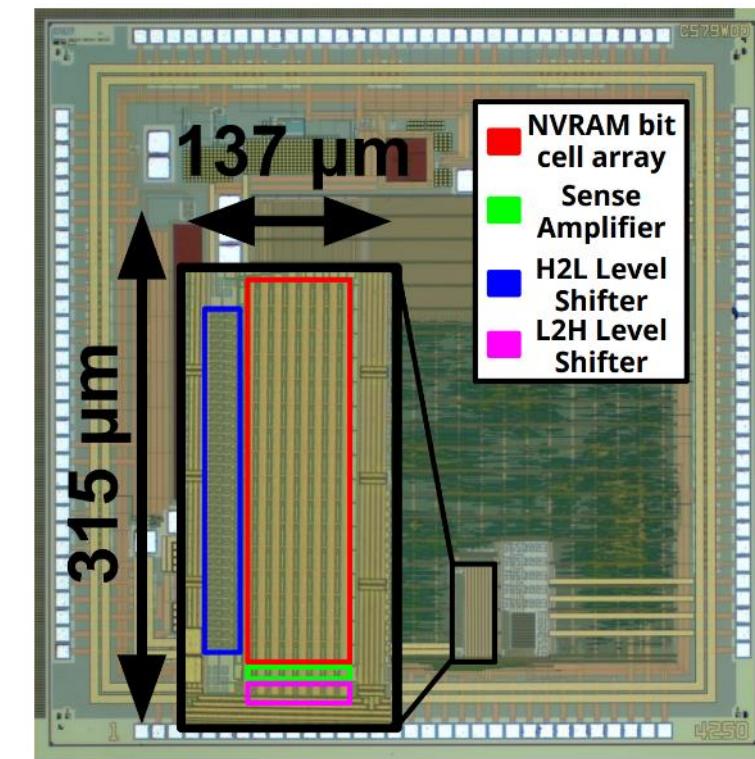
The physical phenomenon of the proposed NVRAM cell



PVT tests:



The chip passed intra/inter-die tests with PVT variations.



Die tests at typical condition of 3.3V@25°C

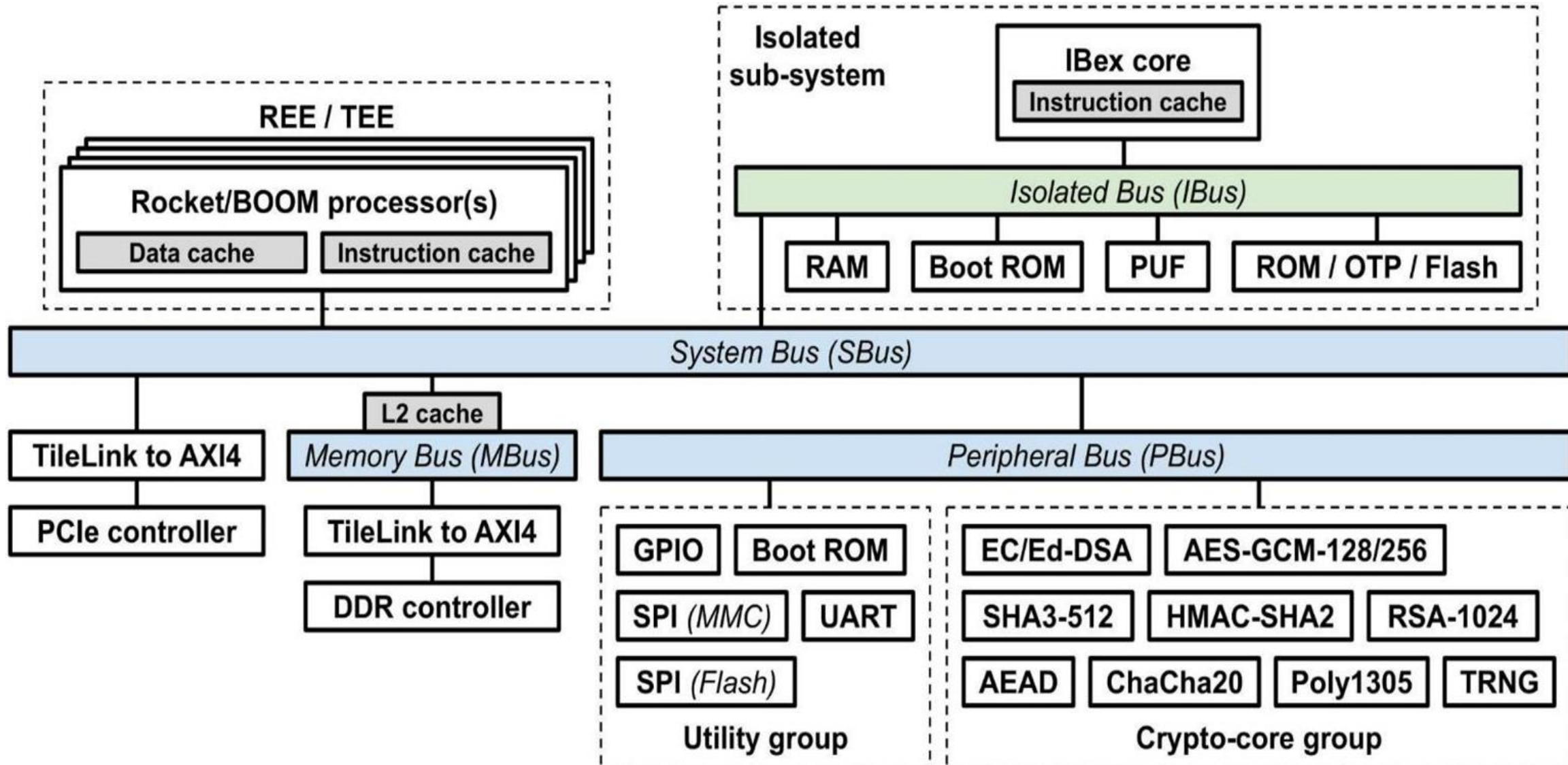
[Link](#)

# Outline

1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion

# 6. Result (1/10) FPGA implementation

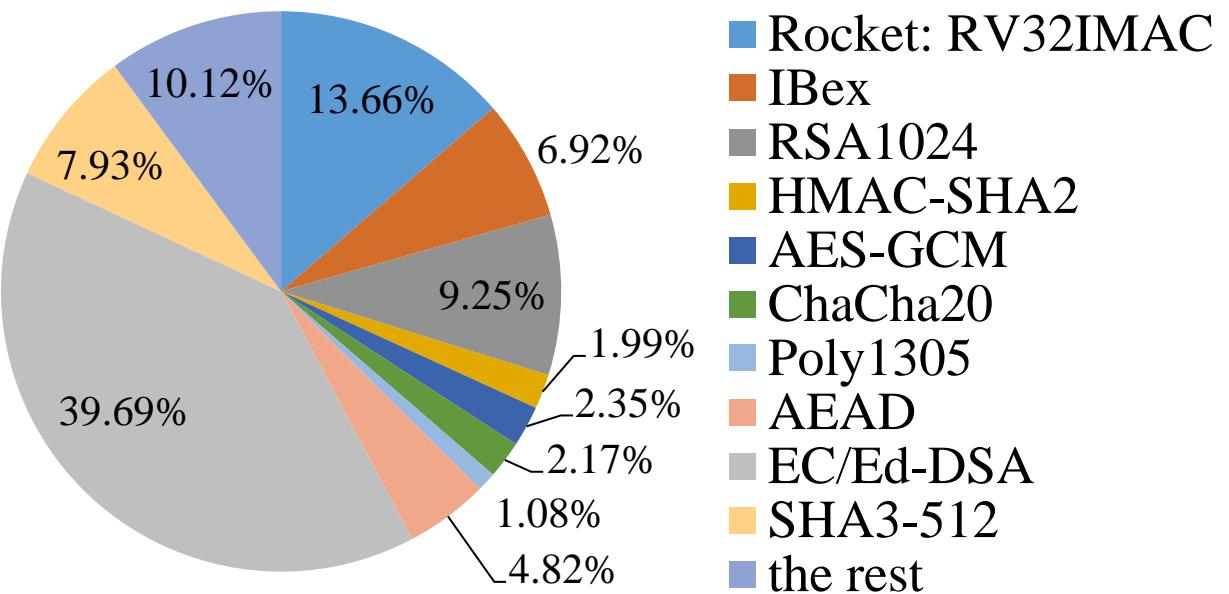
The proposed design was tested with the VC707 FPGA board.



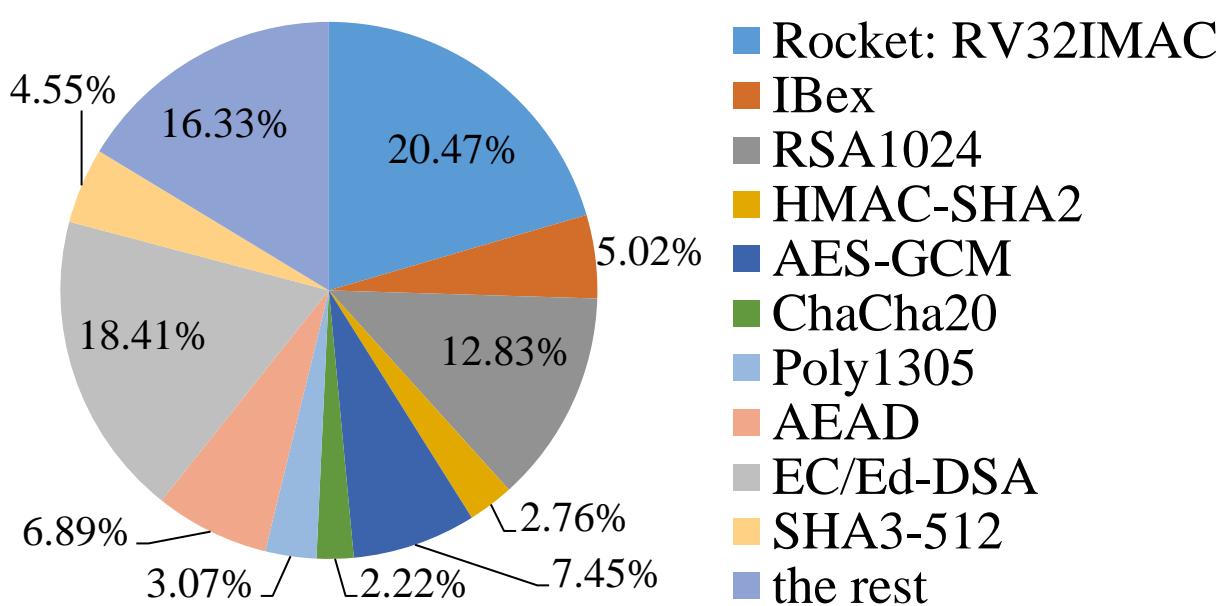
# 6. Result (2/10) FPGA implementation

SoC resources utilization pie chart: implementation on VC707 FPGA

LUT Utilization



Register Utilization



**\*Note:** “*the rest*” means all the buses, TRNG, and utility-group peripherals such as GPIO, SPI, boot ROM, etc.

# 6. Result (3/10) Self-test software

Initial test and drivers for using crypto-cores were developed

```
TEE-HW FSBL: 2022-04- 8-13:55:24-aa000a4
Using ZSBL DTB
Got TL_CLK: 50000000
Got NUM_CORES: 1
Got TIMEBASE: 1000000
```

Welcome to TEE-HW Bootloader

```
Press 'z' to run ALL hardware tests
Press '1' to run SHA-3 hardware test
Press '2' to run ED25519 hardware test
Press '3' to run AES hardware test
Press '4' to run RNG hardware test
Press '6' to run CHACHA hardware test
Press '7' to run POLY hardware test
Press '8' to run CP_AEAD hardware test
Press '9' to run AES GCM hardware test
Press 'a' to run HMAC SHA hardware test
Press 'b' to run RSA hardware test
Press 'd' to run DHRYSTONE test
Press 'e' to run AES GCM 1MB hardware test
Press 'f' to run HMACSHA512 1MB hardware test
Press 'h' to run ED\EC hardware test
Press ENTER to boot Linux 1
```

Tests at FSBL (*M-mode*)  
before boot into Linux

Drivers and tests (*U-mode*) after boot into Linux

```
# ls
aes_gcm_driver.ko      edec_test_384
aes_gcm_test           edec_test_521
chacha_driver.ko       edec_test_full
chacha_poly_driver.ko edec_test_sign
chacha_poly_test       hmac_sha_driver.ko
chacha_test            hmac_sha_test
edec_driver.ko         keystone-driver.ko
edec_test              poly_driver.ko
edec_test_256          poly_test
#
```

## 6. Result (4/10) Self-test software

# Some examples of self-test software

## HMAC-SHA2

f1bd938f54b2f392f7b4e811544c65e9  
65c0885d54ed4b2c50732032abd953a4  
df89de58ee61514ed075f8e590ac3d2e  
38d7489e28742abcae67242212a4b33d

Time: 0s 0ms 92us

## Hardware 384:

9d72af3c8cf178c12e6069bdf645b09  
e2a2245e3850d3c595def9f13670511b  
7c3472789dfa890c52c3d4d88891148

Time: 0s 0ms 86us

## Hardware 256:

61cc4af0e0e6c428fdc1b4e890777c7c  
e2fa0dacf7a21ce31028721aebdcbc2d

Time: 0s 0ms 83us

6.16× to 7.62 × faster

AES-GCM

Begin AES GSM hardware test:

## Software:

e2006eb4f5277022d9b19925bc419d7  
a592666c925fe2ef718eb4e308efaa7  
c5273b394118860a5be2a97f56ab7836

5ca597cdbb3edb8d1a1151ea0af7b436

Time: 0s 0ms 397us

## **Hardware:**

e2006eb42f5277022d9b19925bc419d7  
a592666c925fe2ef718eb4e308efeaa7  
c5273b394118860a5be2a97f56ab7836

5ca597cdbb3edb8d1a1151ea0af7b436

Time: 0s 0ms 53us

7.49× faster

AEAD (*ChaCha+Poly*)

#### **Hardware:**

## Cipher:

MACR

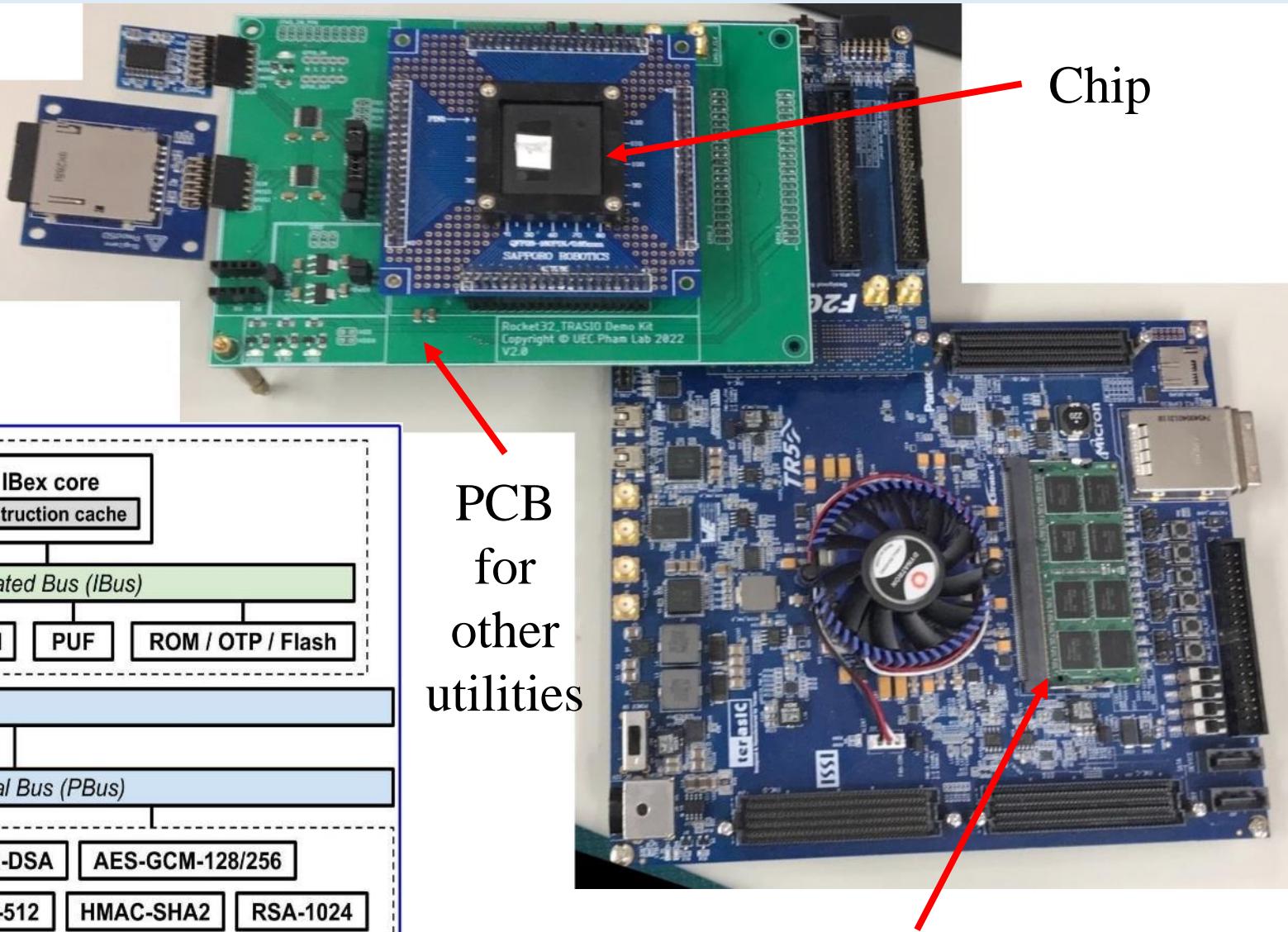
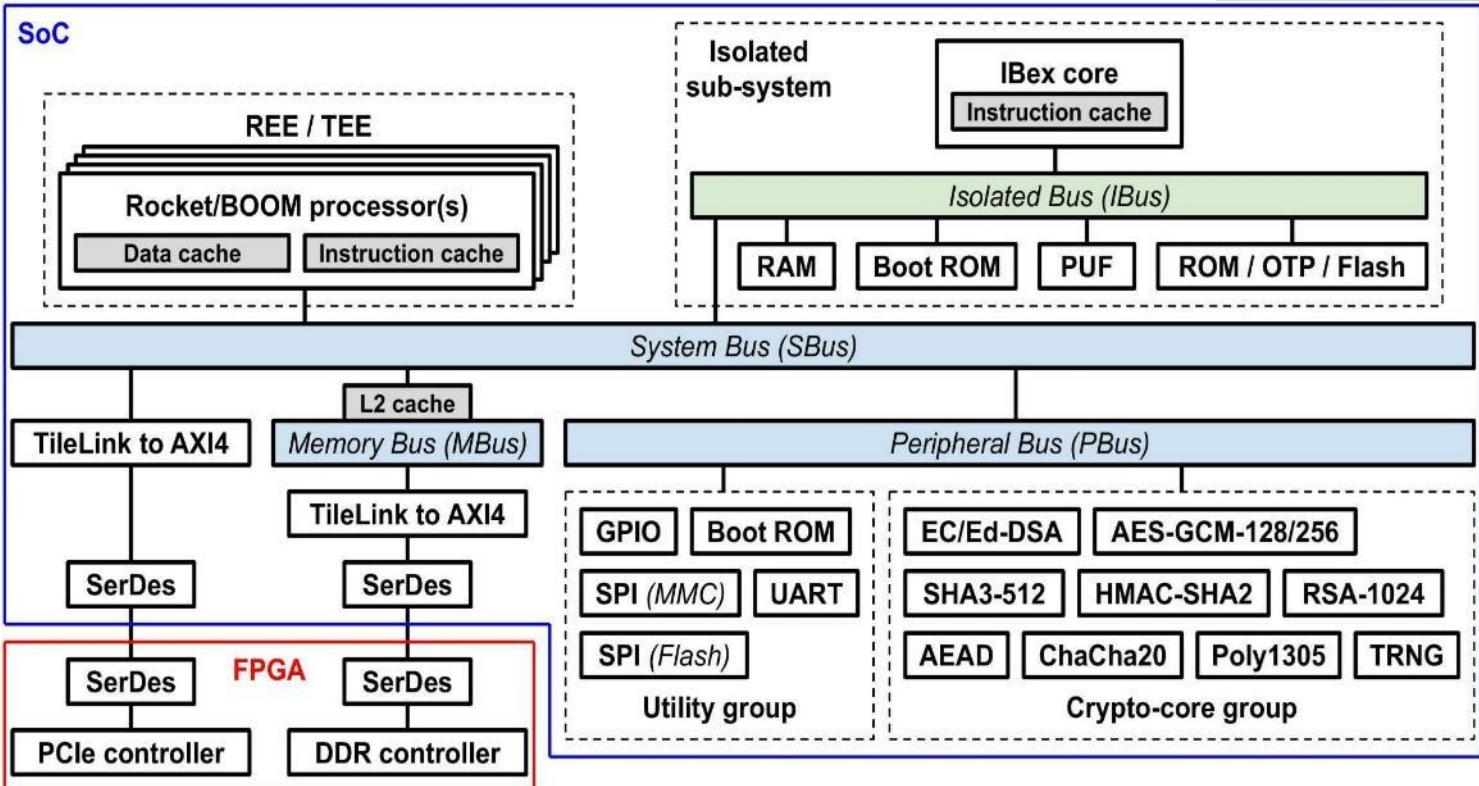
1ae10b594f09e26a7e902ecbd0600691

Time: 0s 0ms 43us

12.1x faster

# 6. Result (5/10) VLSI implementation

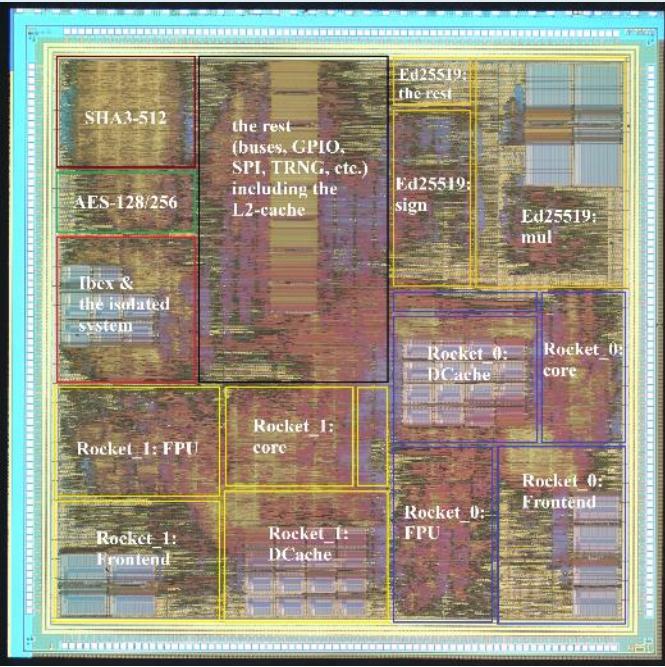
To boot rich OS (*such as Linux*),  
a big memory space is required.  
→ Off-chip DDR is needed.  
→ An FPGA will be used for  
DDR and PCIe hard IPs.



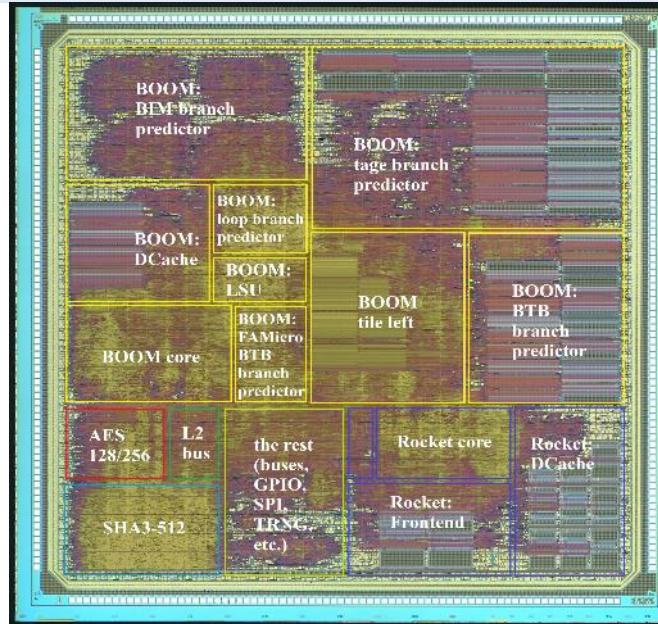
PCB  
for  
other  
utilities

FPGA for using DDR memory

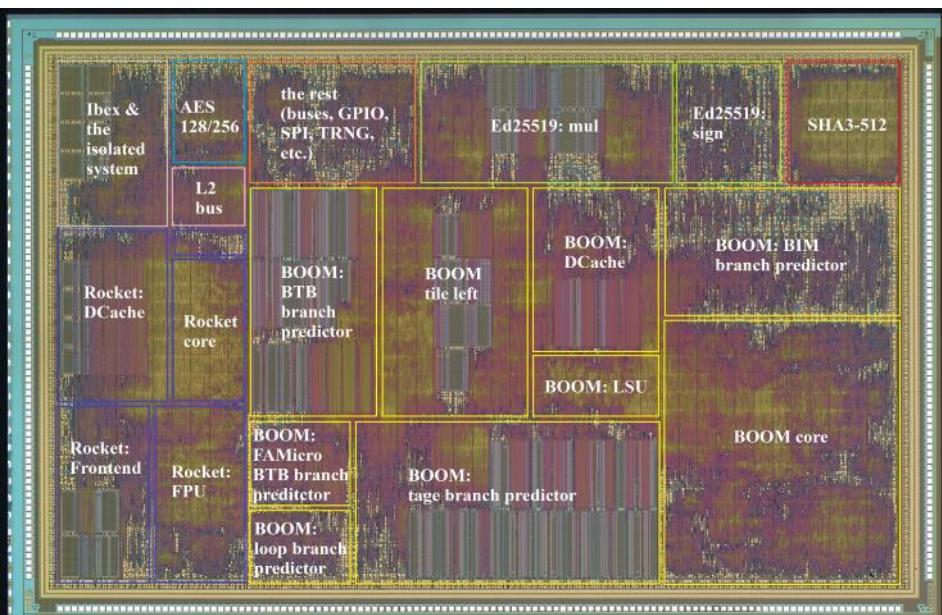
# 6. Result (6/10) VLSI implementation



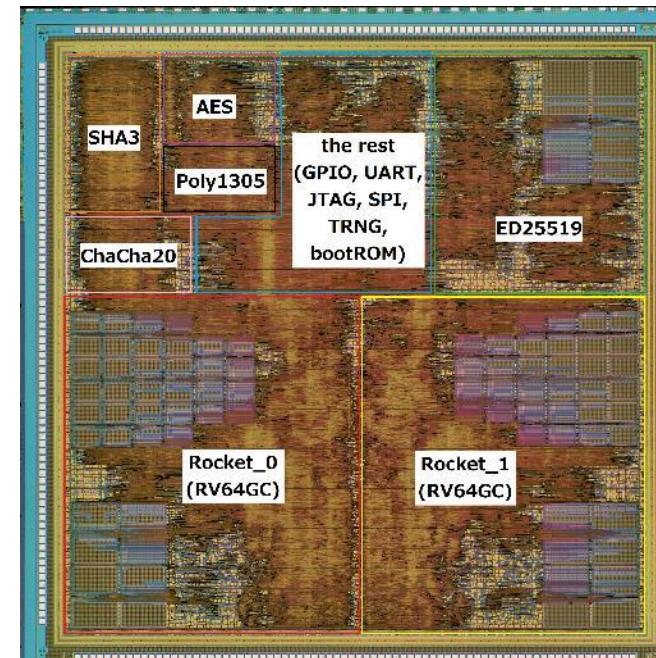
64-bit dual Rocket with crypto-cores and secure boot  
 $5.0 \times 5.0\text{-mm}^2$   
ROHM180nm on 2021/02



32-bit Rocket-Boom with crypto-cores and secure boot  
 $5.0 \times 5.0\text{-mm}^2$   
ROHM-180nm on 2021/06

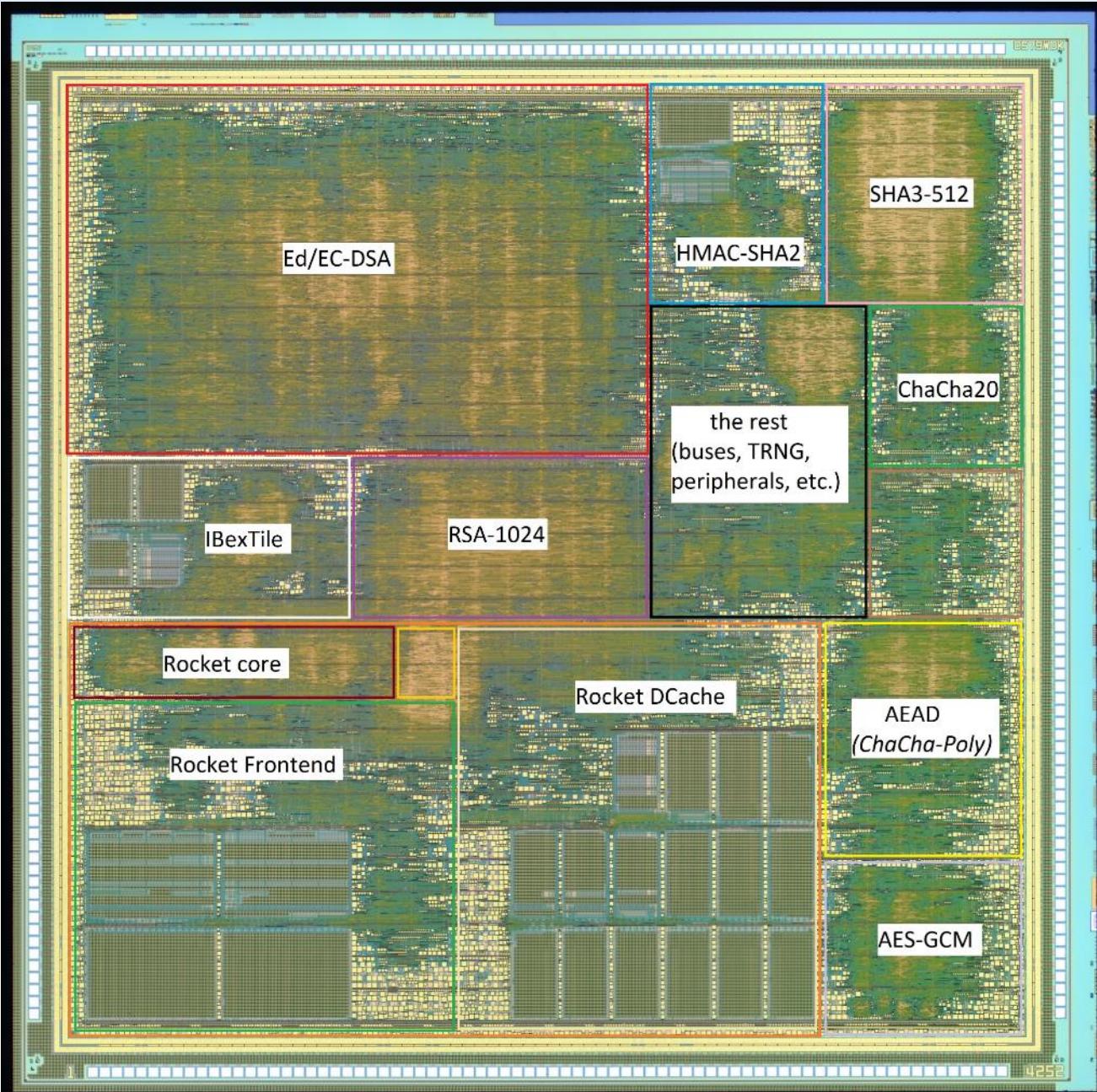


64-bit Rocket-Boom with crypto-cores & secure boot  
 $5.0 \times 7.5\text{-mm}^2$   
ROHM180nm on 2021/06



64-bit dual Rocket with crypto-cores  
 $5.0 \times 5.0\text{-mm}^2$   
ROHM-180nm on 2021/09

# 6. Result (7/10) VLSI implementation



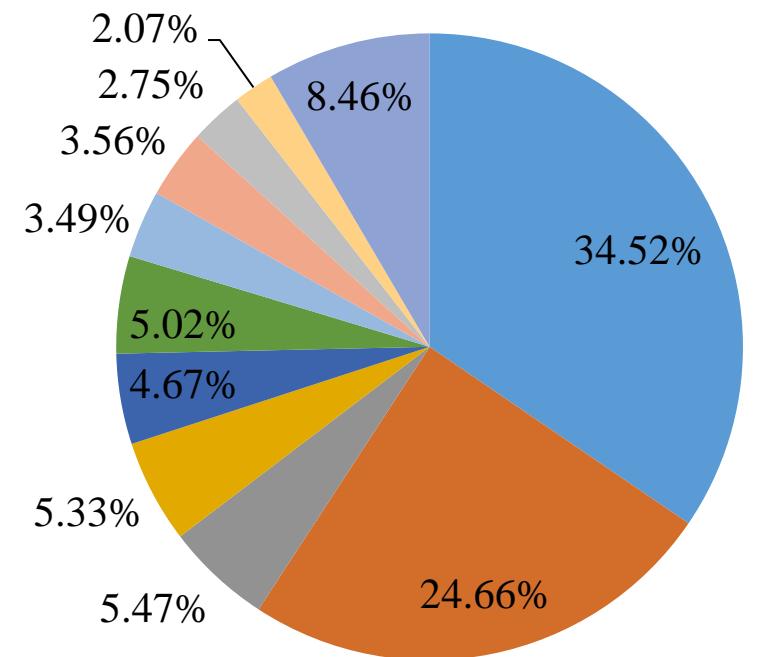
5.0×5.0-mm <sup>2</sup> ROHM-180nm on 2022/02	
<b>Core</b>	Rocket (x1)
<b>ISA</b>	RV32IMAC
<b>Cache</b>	\$I = 16KB and \$D = 16KB
<b>Crypto-cores:</b> TRNG, RSA, AES-GCM, SHA3, HMAC-SHA2, ChaCha20, Poly1305, AEAD, and EC/Ed-DSA	
<b>#Gate</b>	1,535,403
<b>#Cell</b>	466,882
<b>Area (μm<sup>2</sup>)</b>	20,799,437
<b>Density</b>	71.43%
<b>Power (mW)</b>	1,992
<b>Fmax (MHz)</b>	71
<b>#MOSFET</b>	7,982,582

32-bit Rocket with TLS-1.3  
crypto-cores and secure boot

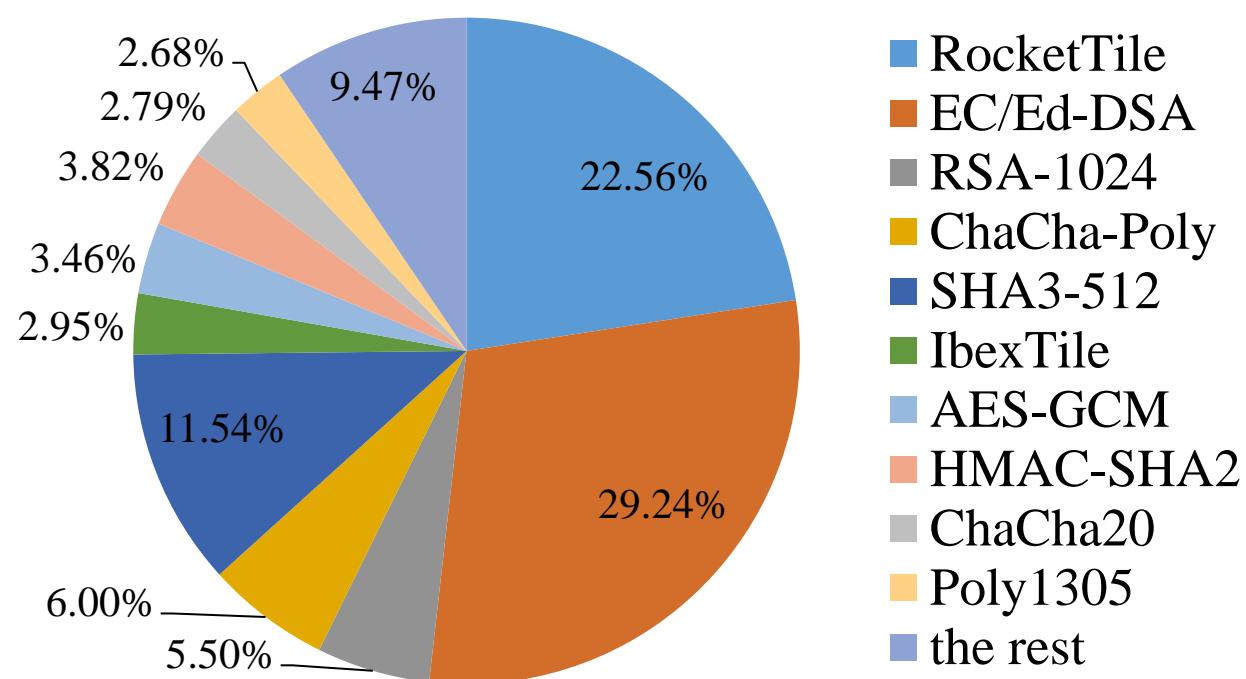
# 6. Result (8/10) VLSI implementation

SoC resources utilization pie chart: implementation on ROHM180nm

**Area Utilization**



**Power Utilization**



**\*Note:** “*the rest*” means all the buses, TRNG, and utility-group peripherals such as GPIO, SPI, boot ROM, etc.

# 6. Result (9/10) Comparison

## Comparison with other secure-boot RISC-V-based TEE SoCs.

Design		Registers Overhead (+%)	LUTs Overhead (+%)
This work (2021)	Baseline: Dual-Rocket + IBex <sup>1</sup> + crypto-cores <sup>2</sup> + IBex <sup>1</sup> + crypto-cores <sup>2</sup>	24,624 +3,253 (13.21%) +14,103 (52.27%) +17,356 (70.48%)	74,258 +9,793 (13.19%) +19,883 (26.78%) +29,676 (39.96%)
ITUS [11, 12] (2019)	Baseline: Dual-Rocket + CAU + KMU + CAU + KMU	24,624 +6,722 (27.30%) +3,344 (13.58%) +10,066 (40.88%)	74,258 +27,170 (36.59%) +29,529 (39.77%) +56,699 (76.35%)
HECTOR-V [9] (2021)	Baseline: Single-lowRISC with RI5CY with Remus with Frankenstein	N/A	55,443 +8,205 (14.80%) +11,581 (20.89%) +13,303 (23.99%)

<sup>1</sup> Including the isolated sub-system.

<sup>2</sup> Including SHA-3, AES, Ed25519, and TRNG.

# 6. Result (10/10) Comparison

TABLE 5.13: Comparison with recent security-driven RISC-V-based SoCs, regarding the security and flexibility features; ●, ○, and ○ rank the performance from best to worst, respectively.

	CURE [8]	HECTOR-V [9]	WorldGuard [10]	ITUS [11, 12]	This work
Open-source	○	○	○	○	●
Secure boot	●	●	○	●	●
Flexible boot process	●	●	●	○	●
TEE & secure boot iso.	○	○	○	●	●
Exclusive TEE processor	●	●	○	○	○
Exclusive secure storage	○	●	○	●	●
Secure I/O paths	●	●	○	○	○
Crypto. accel.	○	○	○	●	●
SCA resilience	●	●	○	○	○
Hardware cost	●	○	●	○	●
High expressiveness	●	●	○	○	●
Low porting efforts	○	○	○	●	●

- Achieved:
  - Secure boot process with RoT for TEE.
  - Flexible boot flow.
  - Complete isolation between the boot process and the TEE domain.
  - Has exclusive storage for boot program only.
  - Cryptographic accelerators are available.

# Outline

1. Introduction
2. TPM and TEE
3. Why RISC-V?
4. Proposed System
5. Peripherals
6. Result
7. Conclusion

# 7. Conclusion (1/1) Summary

## Key Achievements

1. **TEE-HW with cryptographic accelerations:** using the framework, custom hardware was made for accelerating the TEE boot flow.
2. **TEE-HW with isolated RoT:** the heterogeneous architecture was proposed to isolate the RoT from the TEE side. The manufacturer and root keys are stored at the time manufactured. The bootloader program is flexible and can be updated.
3. **Silicon-proof TEE-HW chips:** ROHM-180nm chips were made for the TEE-HW with isolated RoT; and the measurements and tests were done.
4. **FPGA and VLSI implementations:** the proposed system can work on both FPGA and VLSI. All the cryptographic primitives, such as TRNG and PUF, have their equivalent in FPGA.



国立大学法人

電気通信大学  
The University of Electro-Communications



# THANK YOU

2023/11/10